

nRF24LU1+ OTP

Single Chip 2.4 GHz Transceiver with USB Microcontroller and OTP Memory

Product Specification v1.0

Key Features

- nRF24L01+ compatible RF transceiver
- Worldwide 2.4 GHz ISM band operation
- · Up to 2 Mbps on air data rate
- Enhanced ShockBurst™ hardware link layer
- Air compatible with nRF24LU1, nRF24LU1+, nRF24LE1 OTP, nRF24LE1, nRF24L01+, nRF24L01, nRF2401A, nRF2402, nRF24E1 and nRF24E2
- Low cost external ± 60 ppm 16 MHz crystal
- · Full speed USB 2.0 compliant device controller
- · Up to 12 Mbps USB transfer rate
- 2 control, 10 bulk/interrupt and 2 ISO endpoints
- Dedicated 512 bytes endpoint buffer RAM
- Software controlled pull-up resistor for D+
- PLL for full-speed USB operation
- Voltage regulator, 4.0 to 5.25V supply range
- Enhanced 8-bit 8051 compatible microcontroller
- Drop-in compatibility with nRF24LU1 and nRF24LU1+ except for programming
- Reduced instruction cycle time
- 32-bit multiplication-division unit
- 16 + 1 kbytes of on-chip OTP memory
- 2 kbytes of on-chip SRAM
- 6 general purpose digital input/output pins
- · Hardware SPI slave and master, UART
- 3 16-bit timers/counters
- · AES encryption/decryption co-processor
- Compact 32-pin 5x5mm QFN package

Applications

- Compact USB dongles for wireless peripherals
- USB dongles for mouse, keyboards and remotes
- USB dongle 3-in-1 desktop bundles
- USB dongle for advanced media center remote controls
- USB dongle for game controllers
- Toys



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Preliminary product specification	This product specification contains preliminary data; supplementary data may be published from Nordic Semiconductor ASA later.
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Revision History

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RoHS statement

nRF24LU1+ OTP where explicitly stated in this product specification meets the requirements of Directive 2002/95/EC of the European Parliament and of the Council on the Restriction of Hazardous Substances (RoHS). Complete hazardous substance reports as well as material composition reports for all active Nordic products can be found on our web site www.nordicsemi.com.



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1 Introduction

The nRF24LU1+ OTP is a unique single chip solution for compact USB dongles. The internal nRF24L01+ 2.4 GHz RF transceiver supports a wide range of applications including PC peripherals, sports accessories and game peripherals.

With an air data rate of 2 Mbps combined with full speed USB, supporting up to 12 Mbps, the nRF24LU1+ OTP meets the stringent performance requirements of applications such as wireless mice, game controllers and media center remote controls with displays.

The nRF24LU1+ OTP integrates:

- A nRF24L01+ 2.4 GHz RF transceiver
- A full speed USB 2.0 compliant device controller
- An 8-bit microcontroller
- 17 kbytes of OTP memory

All this is packaged on a compact 5x5mm package, low cost external BOM.

With an internal voltage regulator that enables the chip to be powered directly from the USB bus, it does not require an external voltage regulator, saving cost and board space. With a fully integrated RF synthesizer and PLL for the USB no external loop filters, resonators or VCO varactor diodes are required. All that is needed is a low cost ±60 ppm 16 MHz crystal, matching circuitry and the antenna.

The main benefits of nRF24LU1+ OTP are:

- Very compact USB dongle
- Low cost external BOM
- No need for an external voltage regulator
- Single low cost ±60ppm 16 MHz crystal

1.1 Prerequisites

In order to fully understand the product specification, a good knowledge of electronic and software engineering is necessary.

1.2 Writing conventions

This product specification follows a set of typographic rules that makes the document consistent and easy to read. The following writing conventions are used:

- Commands, bit state conditions, and register names are written in Courier.
- Pin names and pin signal conditions are written in Courier bold.
- Cross references are <u>underlined and highlighted in blue</u>.



1.3 Features

Features of the nRF24LU1+ OTP include:

- Fast 8-bit MCU:
 - ▶ Intel MCS 51 compliant instruction set
 - ▶ Reduced instruction cycle time, up to 12x compared to legacy 8051
 - ▶ 32 bit multiplication division unit
- Memory:
 - ▶ 16 + 1 kbytes of on-chip OTP memory with security features
 - ▶ 2 kbytes of on-chip RAM memory
- 6 programmable digital input/output pins configurable as:
 - ▶ GPIO
 - ▶ SPI master
 - ▶ SPI slave
 - External interrupts
 - ▶ Timer inputs
 - ▶ Full duplex serial port
- · High performance 2.4 GHz RF-transceiver
 - ▶ True single chip GFSK transceiver
 - ▶ Enhanced ShockBurst™ link layer support in HW:
 - ▶ Packet assembly/disassembly
 - ▶ Address and CRC computation
 - ▶ Auto ACK and retransmit
 - ▶ On the air data rate 250 kbps, 1 Mbps or 2 Mbps
 - ▶ Digital interface (SPI) speed 0-8 Mbps
 - ▶ 125 RF channel operation, 79 (2.402-2.81 GHz) channels within 2.400 2.4853 GHz.
 - ▶ Short switching time enable frequency hopping
 - ▶ Fully RF compatible with nRF24LXX
 - ▶ RF compatible with nRF2401A, nRF2402, nRF24E1, nRF24E2 in 250 kbps and 1 Mbps mode
- AES encryption/decryption HW-block with 128 bits key length
 - ▶ ECB Electronic Code Book mode
 - CBC Cipher Block Chaining
 - ▶ CFB Cipher FeedBack mode
 - OFB Output FeedBack mode
 - ▶ CTR Counter mode
- Full speed USB 2.0 compliant device controller supporting:
 - ▶ Data transfer rates up to 12 Mbit/s
 - ► Control, Interrupt, Bulk and ISO data transfer
 - ► Endpoint 0 for control
 - ▶ 5 input and 5 output Bulk/Interrupt endpoints
 - ▶ 1 input and 1 output iso-synchronous endpoints
 - ▶ Total 512 bytes of USB buffer endpoint memory sharable between endpoints
 - ▶ On-chip USB transceiver PHY
 - ▶ On-chip pull-up resistor on D+ line with software controlled disconnect
- Power management function:
 - ▶ Low power design supporting fully static standby/ suspend modes
 - ▶ Programmable MCU clock frequency from 64 kHz to 16 MHz
 - ► On-chip voltage regulators supporting low power mode (supplied from USB power)
 - ▶ Watchdog and wakeup functionality running in low power mode
- On-chip oscillator and PLL to obtain full speed USB operation and to reduce the need for external components
- On-chip power on reset generator and brown-out detector



- Complete firmware platform available:
 - ▶ Hardware abstraction layer (HAL) Functions
 - ▶ USB library Functions
 - ▶ Standard and HID specific USB Requests and Descriptors
 - ▶ nRF24LU1+ OTP Library functions
 - ► AES HAL
 - ► Application examples

1.4 Block diagram

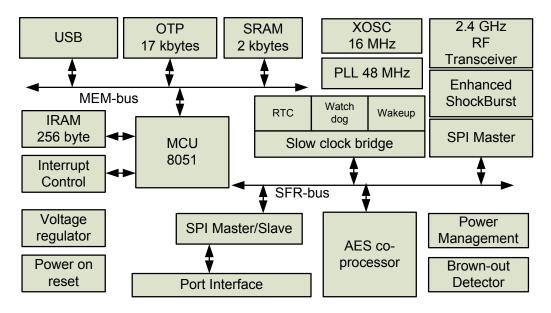


Figure 1. nRF24LU1+ OTP block diagram

To find more information on the block diagram, see <u>Table 1.</u> below:

Name	Reference
USB	chapter 7 on page 63
OTP	chapter 17 on page 135
SRAM	chapter 15 on page 127
2.4 GHz RF transceiver	chapter 6 on page 26
XOSC	section 23.2 on page 168
Enhanced ShockBurst TM	section 6.4 on page 32
IRAM	chapter 16 on page 134
MCU	chapter 14 on page 119
RTC, Watchdog and Wakeup	chapter 19 on page 153
SPI Master	chapter 9 on page 98
Interrupt control	chapter 21 on page 163
SPI master/slave	chapter 9 on page 98 and chapter 10 on page 100
AES co-processor	chapter 8 on page 93
Power management	chapter 20 on page 158
Brown-out detector	section 17.4 on page 139

Table 1. Block diagram cross references



1.5 Typical system usage

<u>Figure 2.</u> shows an nRF24LU1+ OTP device designed for use as a single-chip USB dongle, with optional ESD (electrostatic discharge) protection.

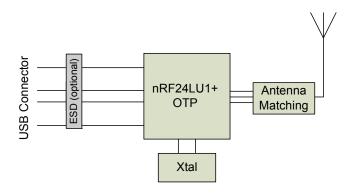


Figure 2. Typical system usage



2 Pin Information

2.1 Pin Assignments

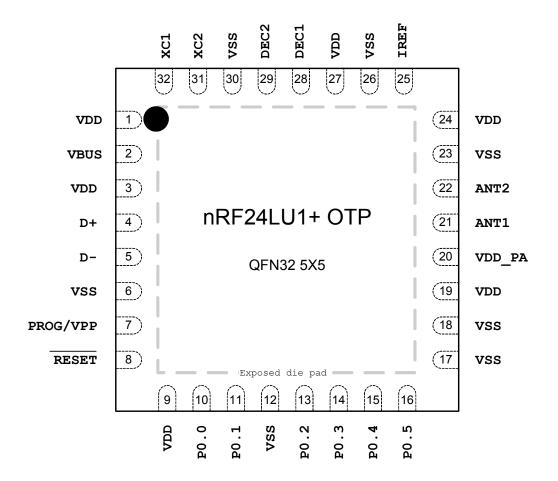


Figure 3. nRF24LU1+ OTP pin assignment (top view) for a QFN32 5x5 mm package.



2.2 Pin Functions

Pin	Name	Type	Description		
21, 22	ANT1, ANT2	RF	Differential antenna connection (TX and RX)		
5, 4	D-, D+	Digital I/O	Differential USB connection. External ESD protection		
			is recommended.		
28, 29	DEC1, DEC2	Power	Power supply outputs for de-coupling purposes		
25	IREF	Analog Input	Device reference current output. To be connected to		
			reference resistor on PCB.		
10, 11, 13, 14,	P0.0 - P0.5	Digital I/O	General purpose data Port 0, bit 0 - 5. See <u>Table 99.</u>		
15, 16			on page 118 for alternative pin functions.		
7	PROG/VPP	Digital Input	Enable SPI OTP interface		
		high voltage			
8	RESET	Digital Input	Reset for microcontroller, active low		
2	VBUS	Power	USB power supply (+4.0V to +5.25V DC)		
1, 3, 9,	VDD	Power	Alternative power supply pins. The VDD pins must		
19, 24, 27			always be connected and de-coupled externally.		
20	VDD_PA	Power Output	Power supply output (+1.8V) for on-chip RF power		
			amplifier		
6, 12, 17, 18,	vss	Power	Ground (0V)		
23, 26, 30					
32, 31	XC1, XC2	Analog Input	Connection for 16 MHz crystal		
	Exposed die	Power/heat	t Not connected		
	pad	relief			

Table 2. nRF24LU1+ OTP pin functions

2.2.1 Power supply pins

VBUS and **VSS** are the power supply and ground pins. The nRF24LU1+ OTP can operate from a single power supply.

The nRF24LU1+ OTP contains an on-chip regulator that produces +3.3V on the VDD pins, from the VBUS supply line (4.0-5.25V). Alternatively, the VBUS pin can be left open and the VDD pins may be fed from an external 3.3V supply. In this case, the on-chip 3.3V regulator is switched off.

2.2.2 PROG/VPP pin

When set high (>3V) this pin enables external SPI access to the OTP memory, and Port 0 is configured as a slave SPI port. With an external pull-down resistor, the chip can be returned to normal operation. For SPI programming of the OTP, the PROG pin is also used as a high voltage supply during programming.

For programming the PROG pin must be raised to VPP (6.75V) before the first SPI command is issued. VPP must be held at that level until 0.1 ms after programming is completed. For another SPI command like READ, no VPP high voltage is needed, 3.3V is sufficient.



3 Absolute Maximum Ratings

Maximum ratings are the extreme limits that you can expose the nRF24LU1+ OTP to without permanently damaging it. Exposure to absolute maximum ratings for prolonged periods of time may affect device reliability.

Operating conditions	Minimum	Maximum	Units
Supply voltages			
VBUS	-0.3	+5.75	V
vss		0	V
VDD	-0.3	+3.6	V
Input voltages			
PROG/VPP	-0.3	+7.0	V
Other pins	-0.3	+3.6	V
Temperatures			
Operating Temperature	-40	+85	°C
Storage Temperature	-40	+125	°C

Table 3. Absolute maximum ratings

Attention!

Observe precaution for handling Electrostatic Sensitive Device.

HBM (Human Body Model): Class 1C





4 Operating Conditions

Symbol	Parameter (condition)	Notes	Min.	Тур.	Max.	Units
VBUS	Supply voltage		4.0	5	5.25	V
VDD	Alternative supply voltage		3.05	3.27	3.5	V
TEMP	Operating Temperature		-40	+27	+85	°C



5 Electrical Specifications

This section contains electrical and timing specifications.

5.1 Power consumption and timing characteristics

Iop Average supply current in operating mode a 22.6 mA	Symbol	Parameter (condition)	Notes	Min.	Тур.	Max.	Units
MCU Running @ 16 MHz, generated from PLL S.7 mA Running @ 12 MHz, generated from PLL S.7 mA Running @ 18 MHz, generated from PLL S.2 mA IMCU4MPLL Running @ 4 MHz, generated from PLL 4.6 mA IMCU4MPLL Running @ 1.6 MHz, generated from PLL 4.2 mA IMCU4MPLL Running @ 1.6 MHz, generated from PLL 4.2 mA IMCU1.6MPLL Running @ 1.6 MHz, generated from XO 4.0 mA IMCU3MMXO Running @ 1.6 MHz, generated from XO 3.7 mA IMCU3MMXO Running @ 0.32 MHz, generated from XO 3.5 mA IMCU64KXO Running @ 0.32 MHz, generated from XO 3.5 mA IMCU64KXO Running @ 0.064 MHz, generated from XO 3.5 mA IMCU64KXO Running @ 0.064 MHz, generated from XO 3.5 mA IMCU64KXO Running @ 0.064 MHz, generated from XO 3.5 mA IMCU64KXO Running @ 0.064 MHz, generated from XO 3.5 mA IMCU64KXO Running @ 0.064 MHz, generated from XO 3.5 mA IMCU64KXO Running @ 0.064 MHz, generated from XO 3.5 mA IMCU64KXO Running @ 0.064 MHz, generated from XO 3.5 mA IMCU64KXO Running @ 0.064 MHz, generated from XO 3.5 mA IMCU64KXO Running @ 0.064 MHz, generated from XO 3.5 mA IMCU64KXO Running @ 0.064 MHz, generated from XO 3.5 mA IMCU64KXO Running @ 0.064 MHz, generated from XO 3.5 mA IMCU64KXO Running @ 0.064 MHz, generated from XO 3.5 mA IMCU64KXO Running @ 0.064 MHz, generated from XO 3.5 mA IMCU64KXO Running @ 0.064 MHz, generated from XO 3.5 mA IMCU64KXO Running @ 0.064 MHz, generated from XO 3.5 mA IMCU64KXO 3.00 µs IMCU64KXO IMCU64KX	I _{OP}	Average supply current in operating mode	а		22.6		mA
MCU Running @ 16 MHz, generated from PLL 5.7	I _{STANDBY}	Supply current in standby mode	b		500		μA
MCU12MPLL Running @ 12 MHz, generated from PLL 5.7 mA		MCU			I		1
McU8MPLL Running @ 8 MHz, generated from PLL S.2 mA	I _{MCU16MPLL}	Running @ 16 MHz, generated from PLL			6.3		mA
ImCU4MPLL Running @ 4 MHz, generated from PLL 4.6 mA ImCU1.6MPLL Running @ 1.6 MHz, generated from PLL 4.2 mA ImCU4MXO Running @ 4 MHz, generated from XO 4.0 mA ImCU4MXO Running @ 1.6 MHz, generated from XO 3.7 mA ImCU3.2MXO Running @ 0.32 MHz, generated from XO 3.5 mA ImCU4.6MXO Running @ 0.32 MHz, generated from XO 3.5 mA ImCU4.6MXO Running @ 0.064 MHz, generated from XO 3.5 mA ImCU6.6MXO Running @ 0.064 MHz, generated from XO 3.5 mA ImCU6.6MXO Running @ 0.064 MHz, generated from XO 3.5 mA ImCU6.6MXO Running @ 0.064 MHz, generated from XO 3.5 mA ImCU6.6MXO Running @ 0.064 MHz, generated from XO 3.5 mA ImCU6.6MXO Running @ 0.064 MHz, generated from XO 3.5 mA ImCU6.6MXO Running @ 0.064 MHz, generated from XO 3.5 mA ImCU6.6MXO Running @ 0.064 MHz, generated from XO 3.5 mA ImCU6.6MXO Running @ 0.064 MHz, generated from XO 3.5 mA ImCU6.6MXO Running @ 0.064 MHz, generated from XO 3.5 mA ImCU6.6MXO Running @ 0.064 MHz, generated from XO 3.5 mA ImCU6.6MXO Running @ 0.32 mA ImCU6.6MXO Running @ 0.32 MHz 4.2 mA ImCU6.6MXO Runnin	I _{MCU12MPLL}	Running @ 12 MHz, generated from PLL			5.7		mA
McU1.6MPLL Running @ 1.6 MHz, generated from PLL 4.2	I _{MCU8MPLL}	Running @ 8 MHz, generated from PLL			5.2		mA
National Reserve	I _{MCU4MPLL}	Running @ 4 MHz, generated from PLL			4.6		mA
McU16MXO	I _{MCU1.6MPLL}	Running @ 1.6 MHz, generated from PLL			4.2		mA
ImcU 32MXO	I _{MCU4MXO}	Running @ 4 MHz, generated from XO			4.0		mA
Image Running Runni	I _{MCU1.6MXO}	Running @ 1.6 MHz, generated from XO			3.7		mA
Trst_act From RESET to MCU active 2 ms Tint_act From INTERRUPT to MCU active 300 µs Tact_stby MCU from active to standby c 32 µs RF Transceiver I_TX RF Transceiver TX current @0dBm output power RF Transceiver RX current @ 2 Mbps 11.1 mA RF Transceiver RX current @ 1 Mbps 12.9 mA I_RX RF Transceiver from standby to active c 130 µs Trst_radio From RESET to RF Transceiver power down 50 ms USB I_USB USB active current 3.0 mA Tusb_wh USB wakeup from host 500 µs Tusb_wmcu USB wakeup from MCU 300 µs Tusbact_susp USB from active to suspend c 32 µs PLL Tplloff_on PLL from off to on time c c d 250 µs	I _{MCU.32MXO}	Running @ 0.32 MHz, generated from XO			3.5		mA
Trst_act From RESET to MCU active		Running @ 0.064 MHz, generated from XO			3.5		mA
Tint_act From INTERRUPT to MCU active 300 µs Tact_stby MCU from active to standby c 32 µs RF Transceiver ITX RF Transceiver TX current @0dBm output power RF Transceiver RX current @ 2 Mbps 13.3 mA IRX RF Transceiver RX current @ 1 Mbps 12.9 mA Tstby2a RF Transceiver from standby to active c 130 µs Trst_radio From RESET to RF Transceiver power down 50 ms USB IUSB USB active current 3.0 mA Tusb_wh USB wakeup from host 500 µs Tusb_wmcu USB wakeup from MCU 300 µs Tusbact_susp USB from active to suspend c 32 µs PLL Tplloff_on PLL from off to on time c c d 250 µs							
Tact_stby MCU from active to standby c RF Transceiver I_TX RF Transceiver TX current @0dBm output power						_	ms
RF Transceiver ITX RF Transceiver TX current @0dBm output power RF Transceiver RX current @ 2 Mbps RF Transceiver RX current @ 1 Mbps Itation RF Transceiver RX current @ 1 Mbps Tstby2a RF Transceiver from standby to active Trst_radio From RESET to RF Transceiver power down USB IUSB USB active current Tusb_wh USB wakeup from host Tusb_wmcu USB wakeup from MCU Tusbact_susp USB from active to suspend PLL Tplloff_on PLL from off to on time							μs
I _{TX} RF Transceiver TX current @0dBm output power RF Transceiver RX current @ 2 Mbps I _{RX} RF Transceiver RX current @ 1 Mbps Tstby2a RF Transceiver from standby to active c 130 μs Trst_radio From RESET to RF Transceiver power down USB I _{USB} USB active current 3.0 mA Tusb_wh USB wakeup from host Tusb_wmcu USB wakeup from MCU Tusbact_susp USB from active to suspend c 32 μs PLL Tplloff_on PLL from off to on time	Tact_stby	· · · · · · · · · · · · · · · · · · ·	С			32	μs
power RF Transceiver RX current @ 2 Mbps							
RF Transceiver RX current @ 2 Mbps	I _{TX}				11.1		mA
I _{RX} RF Transceiver RX current @ 1 Mbps 12.9 mA Tstby2a RF Transceiver from standby to active c 130 μs Trst_radio From RESET to RF Transceiver power down 50 ms USB I _{USB} USB active current 3.0 mA Tusb_wh USB wakeup from host 500 μs Tusb_wmcu USB wakeup from MCU 300 μs Tusbact_susp USB from active to suspend c 32 μs PLL Tplloff_on PLL from off to on time c d							
Tstby2a RF Transceiver from standby to active c 130 µs Trst_radio From RESET to RF Transceiver power down USB USB USB active current 3.0 mA Tusb_wh USB wakeup from host 500 µs Tusb_wmcu USB wakeup from MCU 300 µs Tusbact_susp USB from active to suspend c 32 µs PLL Tplloff_on PLL from off to on time c c d 250 µs							
Trst_radio From RESET to RF Transceiver power down USB I_USB USB active current Tusb_wh USB wakeup from host Tusb_wmcu USB wakeup from MCU Tusbact_susp USB from active to suspend PLL Tplloff_on PLL from off to on time 50 ms 50 ms 50 ms 60 20 20 40 20 40 40 40 40 40 4	I _{RX}	RF Transceiver RX current @ 1 Mbps			12.9		mA
Trst_radio From RESET to RF Transceiver power down USB I _{USB} USB active current 3.0 mA Tusb_wh USB wakeup from host 500 μs Tusb_wmcu USB wakeup from MCU 300 μs Tusbact_susp USB from active to suspend c 32 μs PLL Tplloff_on PLL from off to on time c d 250 μs	Tstby2a	RF Transceiver from standby to active	С			130	μs
USB I_USB USB active current 3.0 mA Tusb_wh USB wakeup from host 500 µs Tusb_wmcu USB wakeup from MCU 300 µs Tusbact_susp USB from active to suspend c 32 µs PLL Tplloff_on PLL from off to on time c d 250 µs	Trst radio	From RESET to RF Transceiver power down				50	
Tusb_wh USB wakeup from host 500 μs Tusb_wmcu USB wakeup from MCU 300 μs Tusbact_susp USB from active to suspend c 32 μs PLL Tplloff_on PLL from off to on time c d 250 μs		•			I		1
Tusb_wmcu USB wakeup from MCU Tusbact_susp USB from active to suspend c 32 µs PLL Tplloff_on PLL from off to on time c d 250 µs	I _{USB}	USB active current			3.0		mA
Tusb_wmcu USB wakeup from MCU Tusbact_susp USB from active to suspend c 32 µs PLL Tplloff_on PLL from off to on time c d 250 µs							
Tusbact_susp USB from active to suspend c 32 µs PLL Tplloff_on PLL from off to on time c d 250 µs							μs
PLL Tplloff_on PLL from off to on time cd 250 μs	_						μs
Tplloff_on PLL from off to on time cd 250 µs	Tusbact_susp	<u> </u>	С			32	μs
· - · · · · · · · · · · · · · · · · · ·							
Tpllon_off PLL from on to off time cd 32 µs	. –		c d				μs
	Tpllon_off	PLL from on to off time	c d			32	μs

a. MCU running radio receive at 2 Mbps and USB transmit

Table 4. Power consumption and timing characteristics

b. When MCU is in standby, USB is suspended and the RF Transceiver is in standby.

c. Measured from start of the software instruction which executes the change of mode, see also <u>Table 14.</u>

d. Only possible when USB is in suspend mode



5.2 RF transceiver characteristics

Symbol	Parameter (condition)	Notes	Min.	Тур.	Max.	Units
	General RF conditions					
f _{OP}	Operating frequency	а	2400		2525	MHz
PLL _{res}	PLL Programming resolution			1		MHz
f _{XTAL}	Crystal frequency			16		MHz
Δf ₂₅₀	Frequency deviation @ 250kbps			±160		kHz
Δf_{1M}	Frequency deviation @ 1Mbps			±160		kHz
Δf_{2M}	Frequency deviation @ 2Mbps			±320		kHz
R _{GFSK}	Air data rate	b	250		2000	kbps
F _{CHANNEL 1M}	250kbps/1 Mbps)	С		1		MHz
	Non-overlapping channel spacing @ 2 Mbps			2		MHz
	Transmitter operation		, ,			
P _{RF}	Maximum output power	d		0	+4	dBm
P _{RFC}	RF power control range		16	18	20	dB
P _{RFCR}	RF power accuracy				±4	dB
P _{BW2}	20dB bandwidth for modulated carrier (2 Mbps)			1800	2000	kHz
P _{BW1}	20dB bandwidth for modulated carrier (1 Mbps)			950	1100	kHz
P _{BW250}	20dB bandwidth for modulated carrier (250 kbps)			700	800	kHz
P _{RF1.2}	1 st Adjacent Channel Transmit Power 2 MHz (2Mbps)				-20	dBc
P _{RF2.2}	2 nd Adjacent Channel Transmit Power 4 MHz (2Mbps)				-45	dBc
P _{RF1.1}	1 st Adjacent Channel Transmit Power 1 MHz (1Mbps)				-20	dBc
P _{RF2.1}	2 nd Adjacent Channel Transmit Power 2 MHz (1Mbps)				-40	dBc
P _{RF1.250}	1 st Adjacent Channel Transmit Power 1 MHz (250kbps)				-25	dBc
P _{RF2.250}	2 nd Adjacent Channel Transmit Power 2 MHz (250kbps)				-40	dBc
	Receiver operation					
RX _{MAX}	Maximum received signal at < 0.1% BER			0		dBm
RX _{SENS}	Sensitivity (0.1% BER) @ 2 Mbps			-82		dBm
RX _{SENS}	Sensitivity (0.1% BER) @ 1 Mbps			-85		dBm
RX _{SENS}	Sensitivity (0.1% BER) @ 250 kbps	е		-94		dBm
	according to ETSI EN 300 440-1 V1.3	.1 (2001-0)9) page 2	7	L	l
C/I _{CO}	C/I co-channel (2 Mbps)	•		7		dBc
C/I _{1ST}	1 st ACS (Adjacent Channel Selectivity), C/I 2 MHz (2 Mbps)			3		dBc
C/I _{2ND}	2 nd ACS, C/I 4MHz (2 Mbps)			-17		dBc
ZIND	- 100, 0/1 TIVILIZ (2 IVIDPS)				1	



Symbol	Parameter (condition)	Notes	Min.	Тур.	Max.	Units
C/I _{3RD}	3 rd ACS, C/I 6 MHz (2 Mbps)			-21		dBc
C/I _{Nth}	N th ACS, C/I f _i > 12 MHz (2 Mbps)	f		-40		dBc
C/I _{Nth}	N th ACS, C/I f _i > 36 MHz (2 Mbps)			-48		dBc
C/I _{CO}	C/I co-channel (1 Mbps)			9		dBc
C/I _{1ST}	1 st ACS, C/I 1 MHz (1 Mbps)			8		dBc
C/I _{2ND}	2 nd ACS, C/I 2 MHz (1 Mbps)			-20		dBc
C/I _{3RD}	3 rd ACS, C/I 3 MHz (1 Mbps)			-30		dBc
C/I _{Nth}	N th ACS, C/I f _i > 6 MHz (1 Mbps)			-40		dBc
C/I _{Nth}	N th ACS, C/I f _i > 25 MHz (1 Mbps)	f		-47		dBc
C/I _{CO}	C/I co-channel (250 kbps)			12		dBc
C/I _{1ST}	1 st ACS, C/I 1 MHz (250 kbps)			-12		dBc
C/I _{2ND}	2 nd ACS, C/I 2 MHz (250 kbps)			-33		dBc
C/I _{3RD}	3 rd ACS, C/I 3 MHz (250 kbps)			-38		dBc
C/I _{Nth}	N th ACS, C/I f _i > 6 MHz (250 kbps)			-50		dBc
C/I _{Nth}	N th ACS, C/I f _i > 25 MHz (250 kbps)	f		-60		dBc
	y with nRF24L01 equal modulation on	interferir	ng signal	(Pin = -67d	Bm for wa	nted
signal)					_	
C/I _{CO}	C/I co-channel (2 Mbps) (modulated carrier)			11		dBc
C/I _{1ST}	1 st ACS (Adjacent Channel Selectivity), C/I 2 MHz (2 Mbps)			4		dBc
C/I _{2ND}	2 nd ACS, C/I 4 MHz (2 Mbps)			-18		dBc
C/I _{3RD}	3 rd ACS, C/I 6 MHz (2 Mbps)			-24		dBc
C/I _{Nth}	N th ACS, C/I f _i > 12 MHz (2 Mbps)			-40		dBc
C/I _{Nth}	N th ACS, C/I f _i > 36 MHz (2 Mbps)			-48		dBc
C/I _{CO}	C/I co-channel (1 Mbps)			12		dBc
C/I _{1ST}	1 st ACS, C/I 1 MHz (1 Mbps)			8		dBc
C/I _{2ND}	2 nd ACS, C/I 2 MHz (1 Mbps)			-21		dBc
C/I _{3RD}	3 rd ACS, C/I 3 MHz (1 Mbps)			-30		dBc
C/I _{Nth}	N th ACS, C/I f _i > 6 MHz (1 Mbps)			-40		dBc
C/I _{Nth}	N th ACS, C/I f _i > 25 MHz (1 Mbps)			-50		dBc
C/I _{CO}	C/I co-channel (250 kbps)			7		dBc
C/I _{1ST}	1st ACS, C/I 1 MHz (250 kbps)			-12		dBc
C/I _{2ND}	2 nd ACS, C/I 2 MHz (250 kbps)			-34		dBc
C/I _{3RD}	3 rd ACS, C/I 3 MHz (250 kbps)			-39		dBc
C/I _{Nth}	N th ACS, C/I f _i > 6 MHz (250 kbps)			-50		dBc
C/I _{Nth}	N th ACS, C/I f _i > 25 MHz (250 kbps)			-60		dBc
	ulation performance according to Blue	etooth sp	ecificatio	n version 2	2.0, 4 th No	vember
P IM(6)	Input power of IM interferers at 6 and	g		-42		dBm
@ 2Mbps	12 MHz distance from wanted signal	J		72		GDIII
P_IM(8)	Input power of IM interferers at 8 and	g		-38		dBm
@ 2Mbps	16 MHz distance from wanted signal					

Symbol	Parameter (condition)	Notes	Min.	Тур.	Max.	Units
P_IM(10)	Input power of IM interferers at 10 and	g		-37		dBm
@ 2Mbps	20 MHz distance from wanted signal					
P_IM(3)	Input power of IM interferers at 3 and	g		-36		dBm
@ 1Mbps	6 MHz distance from wanted signal					
P_IM(4)	Input power of IM interferers at 4 and	g		-36		dBm
@ 1Mbps	8 MHz distance from wanted signal					
P_IM(5)	Input power of IM interferers at 5 and	g		-36		dBm
@ 1Mbps	10 MHz distance from wanted signal					
P_IM(3)	Input power of IM interferers at 3 and	g		-36		dBm
@ 250kbps	6 MHz distance from wanted signal					
P_IM(4)	Input power of IM interferers at 4 and	g		-36		dBm
@ 250kbps	8 MHz distance from wanted signal					
P_IM(5)	Input power of IM interferers at 5 and	g		-36		dBm
@ 250kbps	10 MHz distance from wanted signal					

- a. Usable band is determined by local regulations.
- b. Data rate in each burst on-air.
- c. The minimum channel spacing is 1 MHz.
- d. Antenna load impedance = $15\Omega + j88\Omega$.
- e. For 250 kpbs sensitivity, frequencies which are integer multiples of 16 MHz (2400, 2416 and so on) sensitivity are reduced.
- f. Narrow Band (In Band) Blocking measurements:0 to ±40 MHz; 1 MHz step size
 - For Interferer frequency offsets n*2*fxtal, blocking performance is degraded by approximately 5dB compared to adjacent figures.
- g. Wanted signal level at Pin = -64dBm. Two interferers with equal input power are used. The interferer closest in frequency is unmodulated, the other interferer is modulated equal with the wanted signal. The input power of interferers where the sensitivity equals BER = 0.1% is presented.

Table 5. RF Transceiver specifications



5.3 USB interface

The USB interface electrical performance is compliant with the USB specification 2.0.

Characteristic	Symbol	Conditions	Min.	Тур.	Max	Unit
Electrical characteristics						
Input high voltage	VIH		2.0			V
Input low voltage	VIL				0.8	V
Differential input sensitivity	VDI	(D+) - (D-)	0.2			V
Differential common mode range	VCM	Includes VDI	0.8		2.5	V
		range				
Single ended receiver threshold	VSE		0.8		2.0	V
Single ended receiver hysteresis	VSEH			200		mV
Output low voltage	VOL		0		0.3	V
Output high voltage	VOH		2.8		3.6	V
Differential output signal cross-point	VCRS		1.3		2.0	V
voltage						
Internal pull-up resistor (Standby	R _{PU1}		900	1100	1575	Ω
mode)						
Internal pull-up resistor (Active mode)	R _{PU2}		1425	2100	3090	Ω
Termination voltage connected to R _{PU}	VTRM		3.05		3.5	V
Output driver resistance (does not	ZDRV	Steady state		15		Ω
include the series resistance)		drive				
Timing characteristics		•		•		
Driver rise time	TFR	CL=50pF	4		20	ns
Driver fall time	TFF	CL=50pF	4		20	ns
Rise/fall time matching	TFRFF	TRF / TFF	90	_	111	%
Transceiver pad capacitance	CIN	Pad to ground			20	pF

Table 6. USB interface characteristics

5.4 OTP memory

Characteristic	Symbol	Conditions	Min.	Тур.	Max	Unit
Programming voltage	VPP	-40 to +85°C	6.6	6.75	7.0	V
Data retention	Tret	85°C	>10			years

Table 7. OTP memory characteristics

Name	Size	Unit
OTP memory MainBlock	17408	bytes
OTP InfoPage	512	bytes

Table 8. OTP memory size



5.5 Crystal specifications

Symbol	Parameter (condition)	Notes	Min.	Тур.	Max.	Units
f _{NOM}	Nominal frequency (parallel resonant)			16.000		MHz
f _{TOL}	Frequency tolerance	a b			±60	ppm
C_L	Load capacitance			9	16	pF
C ₀	Shunt capacitance			3	7	pF
ESR	Equivalent series resistance			50	100	Ω
P_{D}	Drive level		·		100	μW

- a. Includes initial accuracy, stability over temperature, aging and frequency pulling due to incorrect load capacitance
- b. Frequency regulations in certain regions set tighter requirements on frequency tolerance (e.g. Japan and South Korea max ± 50 ppm).

Table 9. Crystal specifications

5.6 DC Electrical Characteristics

Symbol	Parameter (condition)	Notes	Min.	Тур.	Max.	Units
	Operating conditions					
VBUS	Supply voltage		4.0	5.0	5.25	V
TEMP	Operating Temperature		-40	+27	+85	°C
	On-chip voltage regulators					
VDD	Output voltage	а	3.05	3.27	3.5	V
IVDD	External load current	b			2	mA

- a. Also valid for VDD input voltage
- b. Total current load from external circuitry on VDD pins

Table 10. DC characteristics

Symbol	Parameter (condition)	Notes	Min.	Тур.	Max.	Units
VIH	HIGH level input voltage		0.7 VDD		VDD	V
VIL	LOW level input voltage		vss		0.3 VDD	V

Table 11. Digital input pin



Symbol	Parameter (condition)	Notes	Min.	Тур.	Max.	Units
VOH	HIGH level output voltage (IOH= -1.0mA)	а	VDD-0.3		VDD	V
VOL	LOW level output voltage (IOL= 1.0mA))		vss		0.3	V

a. When the nRF24LU1+ OTP is supplied from VBUS, there is a limit (IVDD) on the current that can be drawn from VDD by external devices. Current sourced by high outputs are supplied to external devices for this purpose.

Table 12. Digital output pin



6 RF Transceiver

The nRF24LU1+ OTP uses the same 2.4 GHz GFSK RF transceiver with embedded protocol engine (Enhanced ShockBurst™) that is found in the nRF24L01+ single chip RF Transceiver and in the nRF24LU1+, the nRF24LE1 and nRF24LE1 OTP. The RF Transceiver is designed for operation in the world wide ISM frequency band at 2.400 - 2.4835 GHz and is very well suited for ultra low power wireless applications.

The RF Transceiver module is configured and operated through the RF transceiver map. This register map is accessed by the MCU through a dedicated on-chip Serial Peripheral interface (SPI) and is available in all power modes of the RF Transceiver module.

The embedded protocol engine (Enhanced ShockBurst™) enables data packet communication and supports various modes from manual operation to advanced autonomous protocol operation. Data FIFOs in the RF Transceiver module ensure a smooth data flow between the RF Transceiver module and the nRF24LU1+ OTP MCU.

The rest of this chapter is written in the context of the RF Transceiver module as the core and the rest of the nRF24LU1+ OTP as external circuitry to this module.

6.1 Features

Features of the RF Transceiver include:

- General
 - ▶ Worldwide 2.4 GHz ISM band operation
 - ▶ Common antenna interface in transmit and receive
 - ▶ GFSK modulation
 - ▶ 250 kbps, 1 and 2 Mbps on air data rate
- Transmitter
 - ▶ Programmable output power: 0, -6, -12 or -18dBm
 - ▶ 11.1mA at 0dBm output power
- Receiver
 - ▶ Integrated channel filters
 - ▶ 13.3mA at 2 Mbps
 - ▶ -82dBm sensitivity at 2 Mbps
 - ▶ -85dBm sensitivity at 1 Mbps
 - ▶ -94dBm sensitivity at 250 kbps
- RF Synthesizer
 - ► Fully integrated synthesizer
 - ▶ 1 MHz frequency programming resolution
 - ► Accepts low cost ±60 ppm 16 MHz crystal
 - ▶ 1 MHz non-overlapping channel spacing at 1 Mbps
 - ▶ 2 MHz non-overlapping channel spacing at 2 Mbps
- Enhanced ShockBurst™
 - ▶ 1 to 32 bytes dynamic payload length
 - Automatic packet handling (assembly/disassembly)
 - ▶ Automatic packet transaction handling (auto ACK, auto retransmit)
- 6 data pipe MultiCeiver™ for 6:1 star networks



6.2 Block diagram

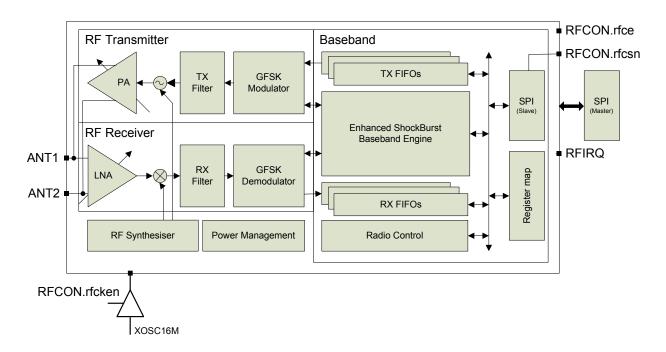


Figure 4. RF Transceiver block diagram

6.3 Functional description

This section describes the different operating modes of the RF Transceiver and the parameters used to control it.

6.3.1 Operational Modes

You can configure the RF Transceiver to power down, standby, RX and TX mode. This section describes these modes in detail.

6.3.1.1 State diagram

The state diagram (<u>Figure 5. on page 28</u>) shows the operating modes of the RF Transceiver and how they function. At the end of the reset sequence the RF Transceiver enters Power Down mode. When the RF Transceiver enters Power Down mode the MCU can still control the module through the SPI and the rfcsn bit in the RFCON register.

There are three types of distinct states highlighted in the state diagram:

- Recommended operating mode: is a recommended state used during normal operation.
- Possible operating mode: is a possible operating state, but is not used during normal operation.
- Transition state: is a time limited state used during start up of the oscillator and settling of the PLL.



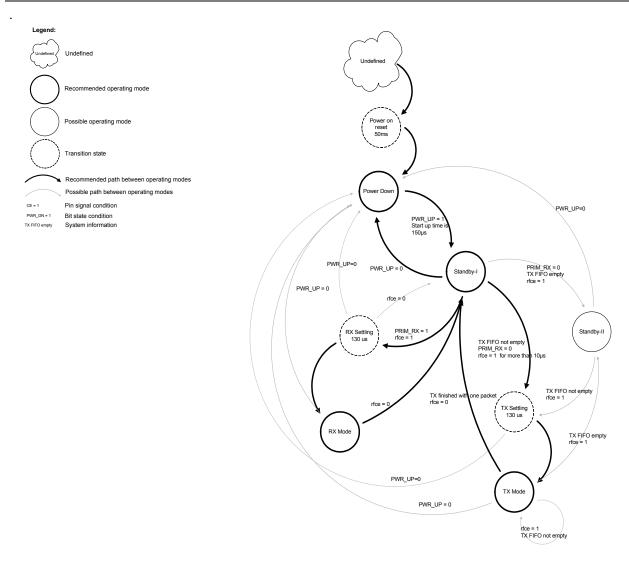


Figure 5. Radio control state diagram

6.3.1.2 Power down mode

In power down mode the RF Transceiver is disabled with minimal current consumption. All the register values available from the SPI are maintained and the SPI can be activated. For start up times see <u>Table 14.</u> on page 30 Power down mode is entered by setting the PWR_UP bit in the CONFIG register low.

6.3.1.3 Standby modes

Standby-I mode

By setting the PWR_UP bit in the CONFIG register to 1, the RF Transceiver enters standby-I mode. Standby-I mode is used to minimize average current consumption while maintaining short start up times. Change to the active mode only happens if the rfce bit is enabled and when it is not enabled, the RF Transceiver returns to standby-I mode from both the TX and RX modes.



Standby-II mode

In standby-II mode extra clock buffers are active and more current is used compared to standby-I mode. The RF Transceiver enters standby-II mode if the rfce bit is held high on a PTX operation with an empty TX FIFO. If a new packet is downloaded to the TX FIFO, the PLL immediately starts and the packet is transmitted after the normal PLL settling delay (130 μ s).

The register values are maintained and the SPI can be activated during both standby modes. For start up times see Table 14. on page 30

6.3.1.4 RX mode

The RX mode is an active mode where the RF Transceiver is used as a receiver. To enter this mode, the RF Transceiver must have the PWR UP bit, PRIM RX bit and the rfce bit is set high.

In RX mode the receiver demodulates the signals from the RF channel, constantly presenting the demodulated data to the baseband protocol engine. The baseband protocol engine constantly searches for a valid packet. If a valid packet is found (by a matching address and a valid CRC) the payload of the packet is presented in a vacant slot in the RX FIFOs. If the RX FIFOs are full, the received packet is discarded.

The RF Transceiver remains in RX mode until the MCU configures it to standby-I mode or power down mode. However, if the automatic protocol features (Enhanced ShockBurst™) in the baseband protocol engine are enabled, the RF Transceiver can enter other modes in order to execute the protocol.

In RX mode a Received Power Detector (RPD) signal is available. The RPD is a signal that is set high when a RF signal higher than -64 dBm is detected inside the receiving frequency channel. The internal RPD signal is filtered before presented to the RPD register. The RF signal must be present for at least 40µs before the RPD is set high. How to use the RPD is described in Section 6.3.4 on page 31.

6.3.1.5 TX mode

The TX mode is an active mode for transmitting packets. To enter this mode, the RF Transceiver must have the PWR_UP bit set high, PRIM_RX bit set low, a payload in the TX FIFO and a high pulse on the rfce bit for more than 10μ s.

The RF Transceiver stays in TX mode until it finishes transmitting a packet. If rfce = 0, RF Transceiver returns to standby-I mode. If rfce = 1, the status of the TX FIFO determines the next action. If the TX FIFO is not empty the RF Transceiver remains in TX mode and transmits the next packet. If the TX FIFO is empty the RF Transceiver goes into standby-II mode. The RF Transceiver transmitter PLL operates in open loop when in TX mode. It is important never to keep the RF Transceiver in TX mode for more than 4ms at a time. If the Enhanced ShockBurstTM features are enabled, RF Transceiver is never in TX mode longer than 4ms.



6.3.1.6 Operational modes configuration

The following table (Table 13.) describes how to configure the operational modes.

Mode	PWR_UP register	PRIM_RX register	rfce	FIFO state
RX mode	1	1	1	-
TX mode	1	0	1	Data in TX FIFO. Will empty all lev-
				els in TX FIFO ^a .
TX mode	1	0	Minimum 10µs	Data in TX FIFO.Will empty one
			high pulse	level in TX FIFO ^b .
Standby-II	1	0	1	TX FIFO empty
Standby-I	1	-	0	No ongoing packet transmission
Power Down	0	=	-	-

- a. If the rfce bit is held high the TX FIFO is emptied and all necessary ACK and possible retransmits are carried out. The transmission continues as long as the TX FIFO is refilled. If the TX FIFO is empty when the rfce bit is still high, the RF Transceiver enters standby-II mode. In this mode the transmission of a packet is started as soon as the rfcsn is set high after an upload (UL) of a packet to TX FIFO.
- b. This operating mode pulses the rfce bit high for at least 10µs. This allows one packet to transmit. This is the normal operating mode. After the packet is transmitted, the RF Transceiver enters standby-I mode.

Table 13. RF Transceiver main modes

6.3.1.7 Timing information

The timing information in this section relates to the transitions between modes and the timing for the rfce bit. The transition from TX mode to RX mode or vice versa is the same as the transition from the standby modes to TX mode or RX mode (130µs), as described in Table 14.

Name	RF Transceiver	Max.	Min.	Comments
Tpd2stby	Power Down → Standby mode	150µs		
Tstby2a	Standby modes → TX/RX mode	130µs		
Thce	Minimum rfce high		10µs	
Tpece2csn	Delay from rfce pos. edge to		4µs	
	rfcsn low			

Table 14. Operational timing of RF Transceiver

Note: If VDD is turned off, the register values are lost and you must reconfigure the RF Transceiver before entering the TX or RX modes.



6.3.2 Air data rate

The air data rate is the modulated signaling rate the RF Transceiver uses when transmitting and receiving data. It can be 250 kbps, 1 Mbps or 2 Mbps. Using lower air data rate gives better receiver sensitivity than higher air data rate. But, high air data rate gives lower average current consumption and reduced probability of on-air collisions.

The air data rate is set by the RF_DR bit in the RF_SETUP register. A transmitter and a receiver must be programmed with the same air data rate to communicate with each other.

The RF Transceiver is fully compatible with nRF24L01. For compatibility with nRF2401A, nRF2402, nRF24E1, and nRF24E2 the air data rate must be set to 250 kbps or 1 Mbps.

6.3.3 RF channel frequency

The RF channel frequency determines the center of the channel used by the RF Transceiver. The channel occupies a bandwidth of less than 1 MHz at 250kbps and 1Mbps and a bandwidth of less than 2 MHz at 2Mbps. The RF Transceiver can operate on frequencies from 2.400 GHz to 2.525 GHz. The programming resolution of the RF channel frequency setting is 1 MHz.

At 2Mbps the channel occupies a bandwidth wider than the resolution of the RF channel frequency setting. To ensure non-overlapping channels in 2Mbps mode, the channel spacing must be 2 MHz or more. At 1 Mbps and 250 kbps the channel bandwidth is the same or lower than the resolution of the RF frequency.

The RF channel frequency is set by the RF CH register according to the following formula:

$$F_0$$
= 2400 + RF CH MHz

You must program a transmitter and a receiver with the same RF channel frequency to communicate with each other.

6.3.4 Received Power Detector measurements

Received Power Detector (RPD), located in register 09, bit 0, triggers at received power levels above -64 dBm that are present in the RF channel you receive on. If the received power is less than -64 dBm, RDP = 0.

The RPD can be read out at any time while the RF Transceiver is in receive mode. This offers a snapshot of the current received power level in the channel. The RPD is latched whenever a packet is received or when the MCU sets rfce low

The status of RPD is correct when RX mode is enabled and after a wait time of Tstby2a +Tdelay_AGC= $130 \, \mu s + 40 \, \mu s$. The RX gain varies over temperature which means that the RPD threshold also varies over temperature. The RPD threshold value is reduced by - 5dB at T = -40°C and increased by + 5dB at 85° C.

6.3.5 PA control

The PA (Power Amplifier) control is used to set the output power from the RF Transceiver power amplifier. In TX mode PA control has four programmable steps, see <u>Table 15. on page 32.</u>



The PA control is set by the RF_PWR bits in the RF_SETUP register.

SPI RF-SETUP (RF_PWR)	RF output power	DC current consumption
11	0dBm	11.1mA
10	-6dBm	8.8mA
01	-12dBm	7.3
00	-18dBm	6.8mA

Conditions: VDD = 3.0V, VSS = 0V, $T_A = 27$ °C, Load impedance = $15\Omega + j88\Omega$.

Table 15. RF output power setting for the RF Transceiver

6.3.6 RX/TX control

The RX/TX control is set by PRIM_RX bit in the CONFIG register and sets the RF Transceiver in transmit/receive.

6.4 Enhanced ShockBurst™

Enhanced ShockBurst™ is a packet based data link layer that features automatic packet assembly and timing, automatic acknowledgement and retransmissions of packets. Enhanced ShockBurst™ enables the implementation of ultra low power and high performance communication. The Enhanced ShockBurst™ features enable significant improvements of power efficiency for bi-directional and uni-directional systems, without adding complexity on the host controller side.

6.4.1 Features

The main features of Enhanced ShockBurst™ are:

- 1 to 32 bytes dynamic payload length
- · Automatic packet handling
- Auto packet transaction handling
 - ► Auto Acknowledgement
 - ▶ Auto retransmit
- 6 data pipe MultiCeiver™ for 1:6 star networks

6.4.2 Enhanced ShockBurst™ overview

Enhanced ShockBurst™ uses ShockBurst™ for automatic packet handling and timing. During transmit, ShockBurst™ assembles the packet and clocks the bits in the data packet for transmission. During receive, ShockBurst™ constantly searches for a valid address in the demodulated signal. When ShockBurst™ finds a valid address, it processes the rest of the packet and validates it by CRC. If the packet is valid the payload is moved into a vacant slot in the RX FIFOs. All high speed bit handling and timing is controlled by ShockBurst™.

Enhanced ShockBurst™ features automatic packet transaction handling for the easy implementation of a reliable bi-directional data link. An Enhanced ShockBurst™ packet transaction is a packet exchange between two transceivers, with one transceiver acting as the Primary Receiver (PRX) and the other transceiver acting as the Primary Transmitter (PTX). An Enhanced ShockBurst™ packet transaction is always initiated by a packet transmission from the PTX, the transaction is complete when the PTX has received an



acknowledgment packet (ACK packet) from the PRX. The PRX can attach user data to the ACK packet enabling a bi-directional data link.

The automatic packet transaction handling works as follows:

- 1. You begin the transaction by transmitting a data packet from the PTX to the PRX. Enhanced ShockBurst™ automatically sets the PTX in receive mode to wait for the ACK packet.
- 2. If the packet is received by the PRX, Enhanced ShockBurst™ automatically assembles and transmits an acknowledgment packet (ACK packet) to the PTX before returning to receive mode.
- 3. If the PTX does not receive the ACK packet immediately, Enhanced ShockBurst™ automatically retransmits the original data packet after a programmable delay and sets the PTX in receive mode to wait for the ACK packet.

In Enhanced ShockBurst™ it is possible to configure parameters such as the maximum number of retransmits and the delay from one transmission to the next retransmission. All automatic handling is done without the involvement of the MCU.

6.4.3 Enhanced Shockburst™ packet format

The format of the Enhanced ShockBurst™ packet is described in this section. The Enhanced ShockBurst™ packet contains a preamble field, address field, packet control field, payload field and a CRC field. Figure 6. shows the packet format with MSB to the left.

Preamble 1 by	e Address 3-5 byte	Packet Control Field 9 bit	Payload 0 - 32 byte	CRC 1-2 byte	
---------------	--------------------	----------------------------	---------------------	-----------------	--

Figure 6. An Enhanced ShockBurst™ packet with payload (0-32 bytes)

6.4.3.1 Preamble

The preamble is a bit sequence used to synchronize the receivers demodulator to the incoming bit stream. The preamble is one byte long and is either 01010101 or 10101010. If the first bit in the address is 1 the preamble is automatically set to 10101010 and if the first bit is 0 the preamble is automatically set to 01010101. This is done to ensure there are enough transitions in the preamble to stabilize the receiver.

6.4.3.2 Address

This is the address for the receiver. An address ensures that the correct packet is detected by the receiver. The address field can be configured to be 3, 4 or, 5 bytes long with the AW register.

Note: Addresses where the level shifts only one time (that is, 000FFFFFFF) can often be detected in noise and can give a false detection, which may give a raised Packet-Error-Rate. Addresses as a continuation of the preamble (hi-low toggling) raise the Packet-Error-Rate.



6.4.3.3 Packet Control Field (PCF)

<u>Figure 7.</u> shows the format of the 9 bit packet control field, MSB to the left.



Figure 7. Packet control field (PCF)

The packet control field contains a 6 bit payload length field, a 2 bit PID (Packet Identity) field and a 1 bit NO ACK flag.

Payload length

This 6 bit field specifies the length of the payload in bytes. The length of the payload can be from 0 to 32 bytes.

Coding: 000000 = 0 byte (only used in empty ACK packets.) 100000 = 32 byte, 100001 = Don't care.

This field is only used if the Dynamic Payload Length function is enabled.

PID (Packet identification)

The 2 bit PID field is used to detect if the received packet is new or retransmitted. PID prevents the PRX operation from presenting the same payload more than once to the MCU. The PID field is incremented at the TX side for each new packet received through the SPI. The PID and CRC fields (see section 6.4.3.5 on page 35) are used by the PRX operation to determine if a packet is retransmitted or new. When several data packets are lost on the link, the PID fields may become equal to the last received PID. If a packet has the same PID as the previous packet, the RF Transceiver compares the CRC sums from both packets. If the CRC sums are also equal, the last received packet is considered a copy of the previously received packet and discarded.

No Acknowledgment flag (NO ACK)

The Selective Auto Acknowledgement feature controls the NO ACK flag.

This flag is only used when the auto acknowledgement feature is used. Setting the flag high, tells the receiver that the packet is not to be auto acknowledged.

6.4.3.4 Payload

The payload is the user defined content of the packet. It can be 0 to 32 bytes wide and is transmitted on-air when it is uploaded (unmodified) to the device.

Enhanced ShockBurst™ provides two alternatives for handling payload lengths; static and dynamic.

The default is static payload length. With static payload length all packets between a transmitter and a receiver have the same length. Static payload length is set by the RX_PW_Px registers on the receiver side. The payload length on the transmitter side is set by the number of bytes clocked into the TX_FIFO and must equal the value in the RX_PW_Px register on the receiver side.



Dynamic Payload Length (DPL) is an alternative to static payload length. DPL enables the transmitter to send packets with variable payload length to the receiver. This means that for a system with different payload lengths it is not necessary to scale the packet length to the longest payload.

With the DPL feature the nRF24L01+ can decode the payload length of the received packet automatically instead of using the RX_PW_Px registers. The MCU can read the length of the received payload by using the R RX PL WID command.

Note: Always check if the packet width reported is 32 bytes or shorter when using the R_RX_PL_WID command. If its width is longer than 32 bytes then the packet contains errors and must be discarded. Discard the packet by using the Flush RX command.

In order to enable DPL the <code>EN_DPL</code> bit in the <code>FEATURE</code> register must be enabled. In RX mode the <code>DYNPD</code> register must be set. A PTX that transmits to a PRX with DPL enabled must have the <code>DPL_PO</code> bit in <code>DYNPD</code> set.

6.4.3.5 CRC (Cyclic Redundancy Check)

The CRC is the error detection mechanism in the packet. It may either be 1 or 2 bytes and is calculated over the address, Packet Control Field and Payload.

The polynomial for 1 byte CRC is $X^8 + X^2 + X + 1$. Initial value 0xFF.

The polynomial for 2 byte CRC is $X^{16} + X^{12} + X^5 + 1$. Initial value 0xFFFF.

No packet is accepted by Enhanced ShockBurst™ if the CRC fails.



6.4.4 Automatic packet assembly

The automatic packet assembly assembles the preamble, address, packet control field, payload and CRC to make a complete packet before it is transmitted.

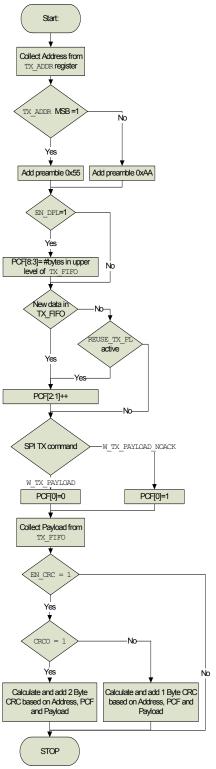


Figure 8. Automatic packet assembly



6.4.5 Automatic packet disassembly

After the packet is validated, Enhanced ShockBurstTM disassembles the packet and loads the payload into the RX FIFO, and asserts the RX DR IRQ.

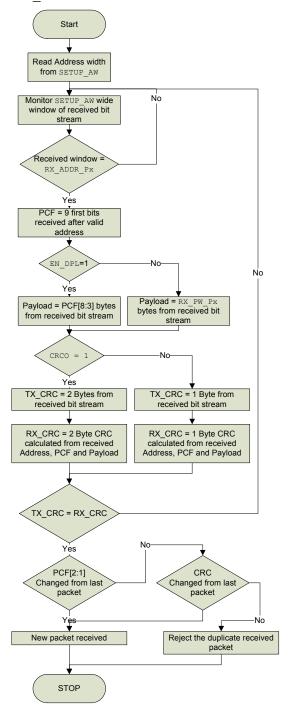


Figure 9. Automatic packet disassembly



6.4.6 Automatic packet transaction handling

Enhanced ShockBurst™ features two functions for automatic packet transaction handling; auto acknowledgement and auto re-transmit.

6.4.6.1 Auto Acknowledgement

Auto acknowledgment is a function that automatically transmits an ACK packet to the PTX after it has received and validated a packet. The auto acknowledgement function reduces the load of the system MCU and reduces average current consumption. The Auto Acknowledgement feature is enabled by setting the EN AA register.

Note: If the received packet has the NO ACK flag set, auto acknowledgement is not executed.

An ACK packet can contain an optional payload from PRX to PTX. In order to use this feature, the Dynamic Payload Length (DPL) feature must be enabled. The MCU on the PRX side has to upload the payload by clocking it into the TX FIFO by using the W_ACK_PAYLOAD command. The payload is pending in the TX FIFO (PRX) until a new packet is received from the PTX. The RF Transceiver can have three ACK packet payloads pending in the TX FIFO (PRX) at the same time.

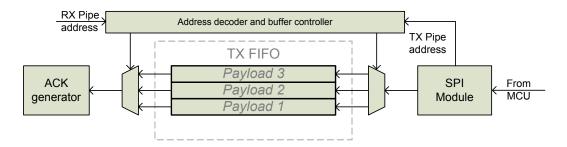


Figure 10. TX FIFO (PRX) with pending payloads

Figure 10. shows how the TX FIFO (PRX) is operated when handling pending ACK packet payloads. From the MCU the payload is clocked in with the W_ACK_PAYLOAD command. The address decoder and buffer controller ensure that the payload is stored in a vacant slot in the TX FIFO (PRX). When a packet is received, the address decoder and buffer controller are notified with the PTX address. This ensures that the right payload is presented to the ACK generator.

If the TX FIFO (PRX) contains more than one payload to a PTX, payloads are handled using the first in – first out principle. The TX FIFO (PRX) is blocked if all pending payloads are addressed to a PTX where the link is lost. In this case, the MCU can flush the TX FIFO (PRX) by using the FLUSH_TX command.

In order to enable Auto Acknowledgement with payload the <code>EN_ACK_PAY</code> bit in the <code>FEATURE</code> register must be set.

6.4.6.2 Auto Retransmission (ART)

The auto retransmission is a function that retransmits a packet if an ACK packet is not received. It is used in an auto acknowledgement system on the PTX. When a packet is not acknowledged, you can set the number of times it is allowed to retransmit by setting the ARC bits in the SETUP_RETR register. PTX enters RX mode and waits a time period for an ACK packet each time a packet is transmitted. The amount of time the PTX is in RX mode is based on the following conditions:

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- Auto Retransmit Delay (ARD) elapsed.
- No address match within 250 μs.
- After received packet (CRC correct or not) if address match within 250 μs.

The RF Transceiver asserts the TX DS IRQ when the ACK packet is received.

The RF Transceiver enters standby-I mode if there is no more untransmitted data in the TX FIFO and the rfce bit in the RFCON register is low. If the ACK packet is not received, the RF Transceiver goes back to TX mode after a delay defined by ARD and retransmits the data. This continues until acknowledgment is received, or the maximum number of retransmits is reached.

Two packet loss counters are incremented each time a packet is lost, ARC_CNT and PLOS_CNT in the OBSERVE_TX register. The ARC_CNT counts the number of retransmissions for the current transaction. You reset ARC_CNT by initiating a new transaction. The PLOS_CNT counts the total number of retransmissions since the last channel change. You reset PLOS_CNT by writing to the RF_CH register. It is possible to use the information in the OBSERVE_TX register to make an overall assessment of the channel quality.

The ARD defines the time from the end of a transmitted packet to when a retransmit starts on the PTX. ARD is set in SETUP_RETR register in steps of 250µs. A retransmit is made if no ACK packet is received by the PTX.

There is a restriction on the length of ARD when using ACK packets with payload. The ARD time must never be shorter than the sum of the startup time and the time on-air for the ACK packet.

- For 2Mbps data rate and 5 byte address; 15 byte is maximum ACK packet payload length for ARD=250 µs (reset value).
- For 1Mbps data rate and 5 byte address; 5 byte is maximum ACK packet payload length for ARD=250 µs (reset value).

ARD=500µs is long enough for any ACK payload length in 1 or 2 Mbps mode.

• For 250 kbps data rate and 5byte address the following values apply:

ARD	ACK packet size (in bytes)
1500µs	All ACK payload sizes
1250µs	<u><</u> 24
1000µs	<u><</u> 16
750µs	≤8
500µs	Empty ACK with no payload

Table 16. Maximum ACK payload length for different retransmit delays at 250 kbps

As an alternative to Auto Retransmit it is possible to manually set the RF Transceiver to retransmit a packet a number of times. This is done by the REUSE_TX_PL command. The MCU must initiate each transmission of the packet with a pulse on the CE pin when this command is used.

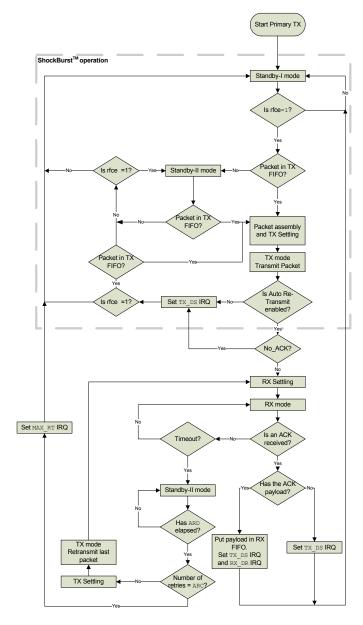


6.4.7 Enhanced ShockBurst™ flowcharts

This section contains flowcharts outlining PTX and PRX operation in Enhanced ShockBurst™.

6.4.7.1 PTX operation

The flowchart in <u>Figure 11.</u> outlines how a RF Transceiver configured as a PTX behaves after entering standby-I mode.



Note: ShockBurst[™] operation is outlined with a dashed square.

Figure 11. PTX operations in Enhanced ShockBurst™

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Activate PTX mode by setting the rfce bit in the RFCON register high. If there is a packet present in the TX FIFO the RF Transceiver enters TX mode and transmits the packet. If Auto Retransmit is enabled, the state machine checks if the NO_ACK flag is set. If it is not set, the RF Transceiver enters RX mode to receive an ACK packet. If the received ACK packet is empty, only the TX_DS IRQ is asserted. If the ACK packet contains a payload, both TX_DS IRQ and RX_DR IRQ are asserted simultaneously before the RF Transceiver returns to standby-I mode.

If the ACK packet is not received before timeout occurs, the RF Transceiver returns to standby-II mode. It stays in standby-II mode until the ARD has elapsed. If the number of retransmits has not reached the ARC, the RF Transceiver enters TX mode and transmits the last packet once more.

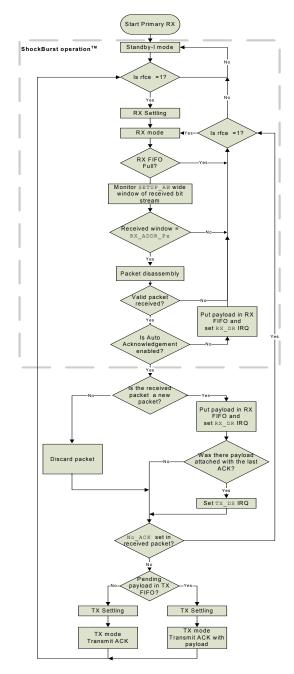
While executing the Auto Retransmit feature, the number of retransmits can reach the maximum number defined in ARC. If this happens, the RF Transceiver asserts the MAX_RT IRQ and returns to standby-I mode.

If the rfce bit in the RFCON register is high and the TX FIFO is empty, the RF Transceiver enters Standby-II mode.



6.4.7.2 PRX operation

The flowchart in <u>Figure 12.</u> outlines how a RF Transceiver configured as a PRX behaves after entering standby-I mode.



Note: ShockBurst™ operation is outlined with a dashed square.

Figure 12. PRX operations in Enhanced ShockBurst™

Activate PRX mode by setting the rfce bit in the RFCON register high. The RF Transceiver enters RX mode and starts searching for packets. If a packet is received and Auto Acknowledgement is enabled, the RF Transceiver decides if the packet is new or a copy of a previously received packet. If the packet is new



the payload is made available in the RX FIFO and the RX_DR IRQ is asserted. If the last received packet from the transmitter is acknowledged with an ACK packet with payload, the TX_DS IRQ indicates that the PTX received the ACK packet with payload. If the NO_ACK flag is not set in the received packet, the PRX enters TX mode. If there is a pending payload in the TX FIFO it is attached to the ACK packet. After the ACK packet is transmitted, the RF Transceiver returns to RX mode.

A copy of a previously received packet might be received if the ACK packet is lost. In this case, the PRX discards the received packet and transmits an ACK packet before it returns to RX mode.

6.4.8 MultiCeiver™

MultiCeiver™ is a feature used in RX mode that contains a set of six parallel data pipes with unique addresses. A data pipe is a logical channel in the physical RF channel. Each data pipe has its own physical address (data pipe address) decoding in the RF Transceiver.

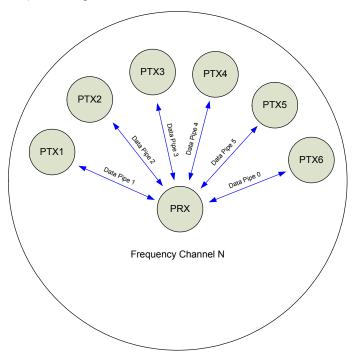


Figure 13. PRX using MultiCeiver™

The RF Transceiver configured as PRX (primary receiver) can receive data addressed to six different data pipes in one frequency channel as shown in <u>Figure 13</u>. Each data pipe has its own unique address and can be configured for individual behavior.

Up to six RF Transceivers configured as PTX can communicate with one RF Transceiver configured as PRX. All data pipe addresses are searched for simultaneously. Only one data pipe can receive a packet at a time. All data pipes can perform Enhanced ShockBurst™ functionality.



The following settings are common to all data pipes:

- CRC enabled/disabled (CRC always enabled when Enhanced ShockBurst™ is enabled)
- CRC encoding scheme
- RX address width
- Frequency channel
- Air data rate
- LNA gain

The data pipes are enabled with the bits in the EN_RXADDR register. By default only data pipe 0 and 1 are enabled. Each data pipe address is configured in the RX_ADDR_PX registers.

Note: Always ensure that none of the data pipes have the same address.

Each pipe can have up to a 5 byte configurable address. Data pipe 0 has a unique 5 byte address. Data pipes 1-5 share the four most significant address bytes. The LSByte must be unique for all six pipes. Figure 14. is an example of how data pipes 0-5 are addressed.

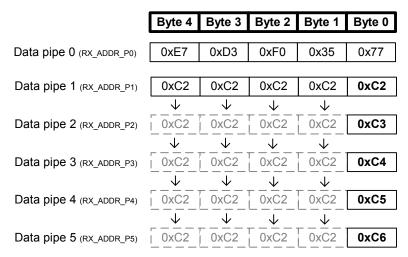


Figure 14. Addressing data pipes 0-5



The PRX, using MultiCeiver™ and Enhanced ShockBurst™, receives packets from more than one PTX. To ensure that the ACK packet from the PRX is transmitted to the correct PTX, the PRX takes the data pipe address where it received the packet and uses it as the TX address when transmitting the ACK packet. Figure 15. is an example of an address configuration for the PRX and PTX. On the PRX the RX_ADDR_Pn, defined as the pipe address, must be unique. On the PTX the TX_ADDR must be the same as the RX_ADDR_P0 and as the pipe address for the designated pipe.

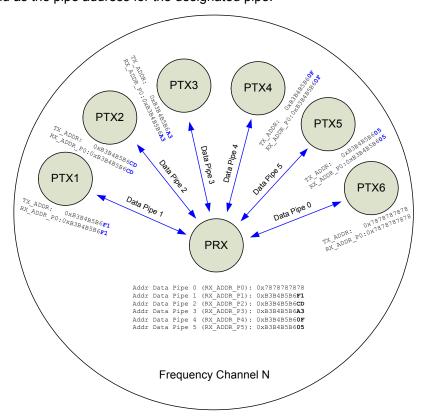


Figure 15. Example of data pipe addressing in MultiCeiver™

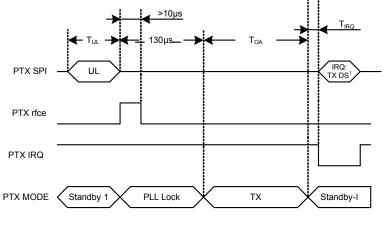
Only when a data pipe receives a complete packet can other data pipes begin to receive data. When multiple PTXs are transmitting to a PRX, the ARD can be used to skew the auto retransmission so that they only block each other once.

6.4.9 Enhanced ShockBurst™ timing

This section describes the timing sequence of Enhanced ShockBurst™ and how all modes are initiated and operated. The Enhanced ShockBurst™ timing is controlled through the Data and Control interface. The RF Transceiver can be set to static modes or autonomous modes where the internal state machine



controls the events. Each autonomous mode/sequence ends with a RFIRQ interrupt. All the interrupts are indicated as IRQ events in the timing diagrams.



1 IRQ if No Ack is on.

 T_{IRQ} = 8.2us @ 1Mbps, T_{IRQ} = 6.0us @ 2Mbps

Figure 16. Transmitting one packet with NO_ACK on

The following equations calculate various timing measurements:

Symbol	Description	Equation
T _{OA}	Time on-air	
		$T_{OA} = \frac{packet length}{air data rate} = \frac{8 \begin{bmatrix} bit/byte \end{bmatrix} \cdot \begin{pmatrix} 1[byte] + 3,4 or 5[bytes] + N[bytes] + N[bytes] + 1 or 2[bytes] \end{pmatrix} + \underbrace{9[bit]}_{packet comtrol field}}_{air data rate} \begin{bmatrix} bit/s \end{bmatrix}}$
T _{ACK}	Time on-air Ack	
		$T_{ACK} = \frac{packet length}{air data rate} = \frac{8 \begin{bmatrix} bit/byte \end{bmatrix} \cdot \left(1 \begin{bmatrix} byte \end{bmatrix} + 3,4 or 5 \begin{bmatrix} bytes \end{bmatrix} + N \begin{bmatrix} bytes \end{bmatrix} + N \begin{bmatrix} bytes \end{bmatrix} + 1 or 2 \begin{bmatrix} bytes \end{bmatrix} \right) + 9 \begin{bmatrix} bit \\ packet control field \end{bmatrix}}{air data rate} \begin{bmatrix} bit/s \end{bmatrix}}$
T _{UL}	Time Upload	
		$T_{UL} = \frac{payload\ length}{SPI\ data\ rate} = \frac{8 \left\lfloor \frac{bit}{byte} \right\rfloor \cdot N \left\lfloor \frac{bytes}{payload} \right\rfloor}{SPI\ data\ rate} \left\lfloor \frac{bit}{s} \right\rfloor$
T _{ESB}	Time Enhanced Shock- Burst™ cycle	$T_{ESB} = T_{UL} + 2 \cdot T_{stby2a} + T_{OA} + T_{ACK} + T_{IRQ}$

Table 17. Timing equations



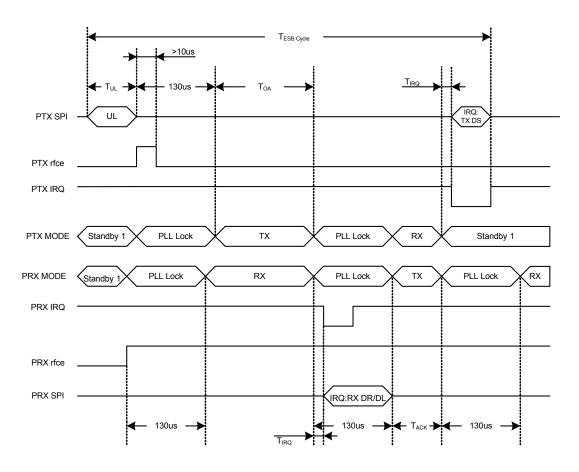


Figure 17. Timing of Enhanced ShockBurst™ for one packet upload (2Mbps)

In <u>Figure 17.</u> the transmission and acknowledgement of a packet is shown. The PRX operation activates RX mode (rfce=1), and the PTX operation is activated in TX mode (rfce=1 for minimum 10 μ s). After 130 μ s the transmission starts and finishes after the elapse of T_{OA} .

When the transmission ends the PTX operation automatically switches to RX mode to wait for the ACK packet from the PRX operation. When the PRX operation receives the packet it sets the interrupt for the host MCU and switches to TX mode to send an ACK. After the PTX operation receives the ACK packet it sets the interrupt to the MCU and clears the packet from the TX FIFO.



In <u>Figure 18.</u> the PTX timing of a packet transmission is shown when the first ACK packet is lost. To see the complete transmission when the ACK packet fails see <u>Figure 21.</u>

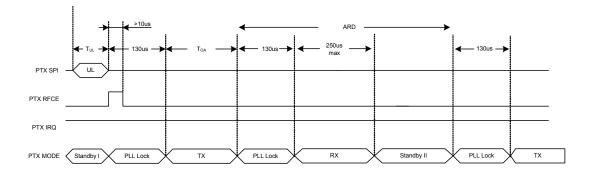


Figure 18. Timing of Enhanced ShockBurst™ when the first ACK packet is lost (2Mbps)

6.4.10 Enhanced ShockBurst™ transaction diagram

This section describes several scenarios for the Enhanced ShockBurst™ automatic transaction handling. The call outs in this section's figures indicate the IRQs and other events. For MCU activity the event may be placed at a different timeframe.

Note: The figures in this section indicate the earliest possible download (DL) of the packet to the MCU and the latest possible upload (UL) of payload to the transmitter.



6.4.10.1 Single transaction with ACK packet and interrupts

In <u>Figure 19.</u> the basic auto acknowledgement is shown. After the packet is transmitted by the PTX and received by the PRX the ACK packet is transmitted from the PRX to the PTX. The RX_DR IRQ is asserted after the packet is received by the PRX, whereas the TX_DS IRQ is asserted when the packet is acknowledged and the ACK packet is received by the PTX.

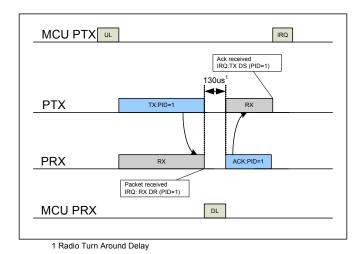


Figure 19. TX/RX cycles with ACK and the according interrupts

6.4.10.2 Single transaction with a lost packet

<u>Figure 20.</u> is a scenario where a retransmission is needed due to loss of the first packet transmit. After the packet is transmitted, the PTX enters RX mode to receive the ACK packet. After the first transmission, the PTX waits a specified time for the ACK packet, if it is not in the specific time slot the PTX retransmits the packet as shown in <u>Figure 20.</u>

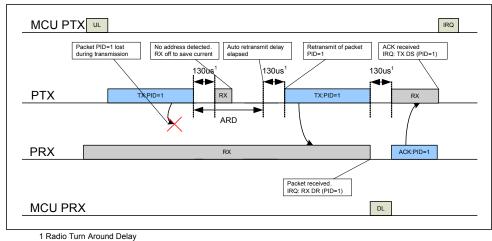


Figure 20. TX/RX cycles with ACK and the according interrupts when the first packet transmit fails



When an address is detected the PTX stays in RX mode until the packet is received. When the retransmitted packet is received by the PRX (see Figure 20.), the RX DR IRQ is asserted and an ACK is transmitted back to the PTX. When the ACK is received by the PTX, the TX DS IRQ is asserted.

6.4.10.3 Single transaction with a lost ACK packet

Figure 21. is a scenario where a retransmission is needed after a loss of the ACK packet. The corresponding interrupts are also indicated.

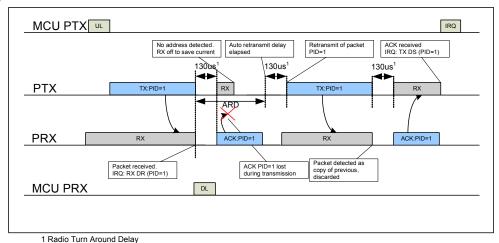
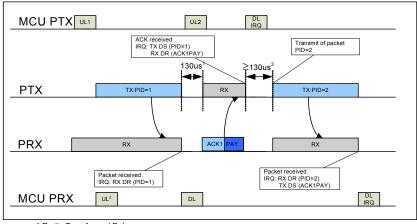


Figure 21. TX/RX cycles with ACK and the according interrupts when the ACK packet fails

6.4.10.4 Single transaction with ACK payload packet

Figure 22. is a scenario of the basic auto acknowledgement with payload. After the packet is transmitted by the PTX and received by the PRX the ACK packet with payload is transmitted from the PRX to the PTX. The RX DR IRQ is asserted after the packet is received by the PRX, whereas on the PTX side the TX DS IRQ is asserted when the ACK packet is received by the PTX. On the PRX side, the TX DS IRQ for the ACK packet payload is asserted after a new packet from PTX is received. The position of the IRQ in Figure 22. shows where the MCU can respond to the interrupt.



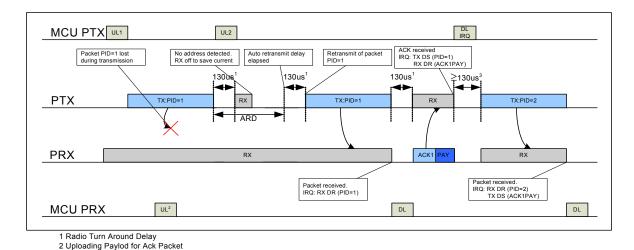
- 1 Radio Turn Around Delay
- 2 Uploading Payload for Ack Packet 3 Delay defined by MCU on PTX side, ≥ 130us

Figure 22. TX/RX cycles with ACK Payload and the according interrupts



6.4.10.5 Single transaction with ACK payload packet and lost packet

<u>Figure 23.</u> is a scenario where the first packet is lost and a retransmission is needed before the RX_DR IRQ on the PRX side is asserted. For the PTX both the TX_DS and RX_DR IRQ are asserted after the ACK packet is received. After the second packet (PID=2) is received on the PRX side both the RX_DR (PID=2) and TX_DS (ACK packet payload) IRQ are asserted.



3 Delay defined by MCU on PTX side, ≥ 130us

6.4.10.6 Two transactions with ACK payload packet and the first ACK packet lost

Figure 23. TX/RX cycles and the according interrupts when the packet transmission fails

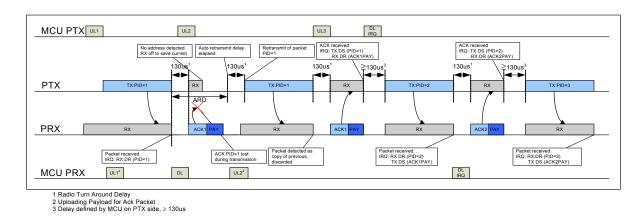
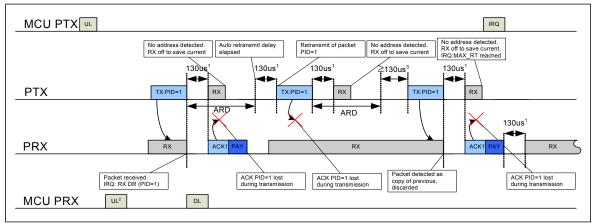


Figure 24. TX/RX cycles with ACK Payload and the according interrupts when the ACK packet fails

In Figure 24. the ACK packet is lost and a retransmission is needed before the TX_DS IRQ is asserted, but the RX_DR IRQ is asserted immediately. The retransmission of the packet (PID=1) results in a discarded packet. For the PTX both the TX_DS and RX_DR IRQ are asserted after the second transmission of ACK, which is received. After the second packet (PID=2) is received on the PRX both the RX_DR (PID=2) and TX_DS (ACK1PAY) IRQ is asserted. The callouts explains the different events and interrupts.



6.4.10.7 Two transactions where max retransmissions is reached



- 1 Radio Turn Around Delay 2 Uploading Paylod for Ack Packet
- 3 Delay defined by MCU on PTX side, ≥ 130us

Figure 25. TX/RX cycles with ACK Payload and the according interrupts when the transmission fails. ARC is set to 2.

MAX RT IRQ is asserted if the auto retransmit counter (ARC CNT) exceeds the programmed maximum limit (ARC). In Figure 25. the packet transmission ends with a MAX RT IRQ. The payload in TX FIFO is NOT removed and the MCU decides the next step in the protocol. A toggle of the rfce bit in the RFCON register starts a new transmitting sequence of the same packet. The payload can be removed from the TX FIFO using the FLUSH TX command.

Compatibility with ShockBurst™ 6.4.11

You must disable Enhanced ShockBurst™ for backward compatibility with the nRF2401A, nRF2402, nRF24E1 and, nRF24E2. Set the register EN AA = 0x00 and ARC = 0 to disable Enhanced ShockBurst™. In addition, the RF Transceiver air data rate must be set to 1Mbps or 250kbps.

6.4.11.1 ShockBurst™ packet format

The ShockBurst™ packet format is described in this chapter. Figure 26, shows the packet format with MSB to the left.



Figure 26. A ShockBurst™ packet compatible with nRF2401/nRF2402/nRF24E1/nRF24E2 devices.

The ShockBurst™ packet format has a preamble, address, payload and CRC field that are the same as the Enhanced ShockBurst™ packet format described in section 6.4.3 on page 33.



The differences between the ShockBurst™ packet and the Enhanced ShockBurst™ packet are:

- The 9 bit Packet Control Field is not present in the ShockBurst™ packet format.
- The CRC is optional in the ShockBurst™ packet format and is controlled by the EN_CRC bit in the CONFIG register.

6.5 Data and control interface

The data and control interface gives you access to all the features in the RF Transceiver. Compared to the standalone nRF24L01+ chip, SFR registers are used instead of port pins, so that the SFR RCON bits rfcsn, rfce and rfcken control the CSN, CE and CKEN pins of the standalone component.

6.5.1 SFR registers

The MCU uses an internal SPI to communicate with the RF Transceiver. This SPI is controlled by the SFR registers shown in the tables below.

Address	Reset value	Bit	Name	R/W	Function
0xE5	0x00		data	RW	SPI data input/output

Table 18. RFDAT register

Address	Reset value	Bit	Name	R/W	Function
0xE6	0x00	7:5	-		Must be zero
		4	SS	RW	SPI enable:
					0: disable, 1: enable
		3:0	rfctl	RW	Divider factor from MCU clock (Cclk) to
					SPI clock frequency
					000X: 1/2 of Cclk frequency
					0010: 1/4 of Cclk frequency
					0011: 1/8 of Cclk frequency
					0100: 1/16 of Cclk frequency
					0101: 1/32 of Cclk frequency
					other: 1/64 of Cclk frequency

Table 19. RFCTL register

Address	Reset value	Bit	Name	R/W	Function
0x90	0x02	7:3	-		Reserved
		2	rfcken	RW	RF Clock Enable (16 MHz)
		1	rfcsn	RW	RF SPI CSN 0: enabled 1: disabled
		0	rfce	RW	RF CE 1: enabled 0: disabled

Table 20. RFCON register



6.5.2 SPI operation

This section describes the SPI commands and timing.

6.5.2.1 SPI commands

The SPI commands are shown in <u>Table 21</u>. Every new command must be started by writing 0 to rfcsn in the RFCON register.

The SPI command is transferred to RF Transceiver by writing the command to the RFDAT register. After the first transfer the RF Transceiver's STATUS register can be read from RFDAT when the transfer is completed.

The serial shifting SPI commands is in the following format:

< Command word: MSBit to LSBit (one byte)>

<Data bytes: LSByte to MSByte, MSBit in each byte first>

Command name	Command word (binary)	# Data bytes	Operation
R_REGISTER	000A AAAA	1 to 5	Read command and status registers. AAAAA =
		LSByte first	5 bit Register Map Address
W_REGISTER	001A AAAA	1 to 5	Write command and status registers. AAAAA = 5
		LSByte first	bit Register Map Address
			Executable in power down or standby modes only.
R_RX_PAYLOAD	0110 0001	1 to 32	Read RX-payload: 1 – 32 bytes. A read operation
		LSByte first	always starts at byte 0. Payload is deleted from FIFO after it is read. Used in RX mode.
W_TX_PAYLOAD	1010 0000	1 to 32	Write TX-payload: 1 – 32 bytes. A write operation
		LSByte first	always starts at byte 0 used in TX payload.
FLUSH_TX	1110 0001	0	Flush TX FIFO, used in TX mode
FLUSH_RX	1110 0010	0	Flush RX FIFO, used in RX mode
			Should not be executed during transmission of
			acknowledge, that is, acknowledge package will
DELIGE EX DI	1110 0011	0	not be completed.
REUSE_TX_PL	1110 0011	U	Used for a PTX operation Reuse last transmitted payload.
			TX payload reuse is active until
			W_TX_PAYLOAD or FLUSH TX is executed. TX
			payload reuse must not be activated or deacti-
			vated during package transmission.
D DV DI MIDA	0110 0000	1	Read RX payload width for the top
R_RX_PL_WID ^a			R_RX_PAYLOAD in the RX FIFO.
			Note: Flush RX FIFO if the read value is larger than 32 bytes.



Command name	Command word (binary)	# Data bytes	Operation
W_ACK_PAYLOAD ^a	1010 1PPP	1 to 32 LSByte first	Used in RX mode. Write Payload to be transmitted together with ACK packet on PIPE PPP. (PPP valid in the range from 000 to 101). Maximum three ACK packet payloads can be pending. Payloads with same PPP are handled using first in - first out principle. Write payload: 1– 32 bytes. A write operation always starts at byte 0.
W_TX_PAYLOAD_NO ACK	1011 0000	1 to 32 LSByte first	Used in TX mode. Disables AUTOACK on this specific packet.
NOP	1111 1111	0	No Operation. Might be used to read the STATUS register

a. The bits in the FEATURE register shown in <u>Table 22.</u> have to be set.

Table 21. Command set for the RF Transceiver SPI

The <code>W_REGISTER</code> and <code>R_REGISTER</code> commands operate on single or multi-byte registers. When accessing multi-byte registers read or write to the MSBit of LSByte first. You can terminate the writing before all bytes in a multi-byte register are written, leaving the unwritten MSByte(s) unchanged. For example, the LSByte of <code>RX_ADDR_PO</code> can be modified by writing only one byte to the <code>RX_ADDR_PO</code> register. The content of the <code>status</code> register is always read to <code>MISO</code> after a high to low transition on <code>CSN</code>.

Note: The 3 bit pipe information in the STATUS register is updated during the RFIRQ high to low transition. The pipe information is unreliable if the STATUS register is read during an RFIRQ high to low transition.

6.5.3 Data FIFO

The data FIFOs store transmitted payloads (TX FIFO) or received payloads that are ready to be clocked out (RX FIFO). The FIFOs are accessible in both PTX mode and PRX mode.

The following FIFOs are present in the RF Transceiver:

- TX three level, 32 byte FIFO
- · RX three level, 32 byte FIFO

Both FIFOs have a controller and are accessible through the SPI by using dedicated SPI commands. A TX FIFO in PRX can store payloads for ACK packets to three different PTX operations. If the TX FIFO contains more than one payload to a pipe, payloads are handled using the first in - first out principle. The TX FIFO in a PRX is blocked if all pending payloads are addressed to pipes where the link to the PTX is lost. In this case, the MCU can flush the TX FIFO using the FLUSH TX command.

The RX FIFO in PRX can contain payloads from up to three different PTX operations and a TX FIFO in PTX can have up to three payloads stored.

You can write to the TX FIFO using these three commands; <code>W_TX_PAYLOAD</code> and <code>W_TX_PAYLOAD_NO_ACK</code> in PTX mode and <code>W_ACK_PAYLOAD</code> in PRX mode. All three commands provide access to the <code>TX_PLD</code> register.

The RX FIFO can be read by the command $R_RX_PAYLOAD$ in PTX and PRX mode. This command provides access to the RX_PLD register.



The payload in TX FIFO in a PTX is not removed if the MAX RT IRQ is asserted.

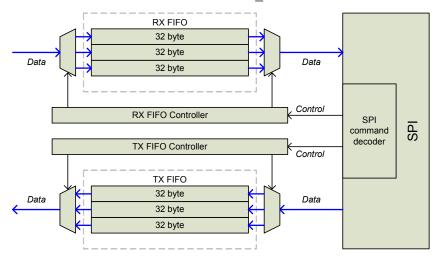


Figure 27. FIFO (RX and TX) block diagram

You can read if the TX and RX FIFO are full or empty in the FIFO_STATUS register. TX_REUSE (also available in the FIFO_STATUS register) is set by the SPI command REUSE_TX_PL, and is reset by the SPI commands w TX PAYLOAD or FLUSH TX.

6.5.4 Interrupt

The RF Transceiver can send interrupts to the MCU. The interrupt (RFIRQ) is activated when TX_DS, RX_DR or MAX_RT are set high by the state machine in the STATUS register. RFIRQ is deactivated when the MCU writes '1' to the interrupt source bit in the STATUS register. The interrupt mask in the CONFIG register is used to select the IRQ sources that are allowed to activate RFIRQ. By setting one of the mask bits high, the corresponding interrupt source is disabled. By default all interrupt sources are enabled.

Note: The 3 bit pipe information in the STATUS register is updated during the RFIRQ high to low transition. The pipe information is unreliable if the STATUS register is read during a RFIRQ high to low transition.



6.6 Register map

You can configure and control the radio (using read and write commands) by accessing the register map through the SPI.

6.6.1 Register map table

All undefined bits in the table below are redundant. They are read out as '0'.

Note: Addresses 18 to 1B are reserved for test purposes, altering them makes the chip malfunction.

Address (Hex)	Mnemonic	Bit	Reset Value	Туре	Description
00	CONFIG				Configuration Register
00	Reserved	7	0	R/W	
	MASK RX DR	6	0	R/W	
	111511_141_BI	ŭ	Ü	1000	1: Interrupt not reflected on the RFIRQ
					0: Reflect RX DR as active low on RFIRQ
	MASK TX DS	5	0	R/W	Mask interrupt caused by TX DS
					1: Interrupt not reflected on the RFIRQ
					0: Reflect TX DS as active low interrupt on RFIRQ
	MASK MAX RT	4	0	R/W	Mask interrupt caused by MAX RT
					1: Interrupt not reflected on RFIRQ
					0: Reflect MAX RT as active low on RFIRQ
	EN CRC	3	1	R/W	Enable CRC. Forced high if one of the bits in the
	_				EN AA is high
	CRCO	2	0	R/W	CRC encoding scheme
					'0' - 1 byte
					'1' – 2 bytes
	PWR_UP	1	0		1: POWER UP, 0:POWER DOWN
	PRIM_RX	0	0	R/W	RX/TX control
					1: PRX, 0: PTX
01	_EN_AA				Enable 'Auto Acknowledgment' Function Disable
	Enhanced				this functionality to be compatible with nRF2401.
	ShockBurst™			5.44	
	Reserved	7:6	00		Only '00' allowed
	ENAA_P5	5	1		Enable auto acknowledgement data pipe 5
	ENAA_P4	4	1		Enable auto acknowledgement data pipe 4
	ENAA_P3	3	1		Enable auto acknowledgement data pipe 3
	ENAA_P2	2	1		Enable auto acknowledgement data pipe 2
	ENAA_P1	1	1	R/W	Enable auto acknowledgement data pipe 1
	ENAA_P0	0	1	R/VV	Enable auto acknowledgement data pipe 0
02	EN RXADDR				Enabled RX Addresses
	Reserved	7:6	00	R/W	Only '00' allowed
	ERX P5	5	0		Enable data pipe 5.
	ERX P4	4	0		Enable data pipe 4.
	ERX P3	3	0		Enable data pipe 3.
	ERX P2	2	0		Enable data pipe 2.
	ERX P1	1	1		Enable data pipe 1.
	ERX_P0	0	1	R/W	Enable data pipe 0.

Address	Mnemonic	Bit	Reset	Туре	Description
(Hex)	Willemonic	Dit	Value	туре	Description
03	SETUP AW				Setup of Address Widths
00	DEIOF_AW				(common for all data pipes)
	Reserved	7:2	000000	R/W	Only '000000' allowed
	AW	1:0	11	R/W	RX/TX Address field width
					'00' - Illegal
					'01' - 3 bytes
					'10' - 4 bytes
					'11' – 5 bytes
					LSByte is used if address width is below 5 bytes
04	SETUP RETR				Setup of Automatic Retransmission
0.1	ARD ^a	7:4	0000	R/W	Auto Retransmit Delay
	ARD				'0000' – Wait 250µS
					'0001' – Wait 500μS
					'0010' – Wait 750µS
					'1111' – Wait 4000μS
					(Delay defined from end of transmission to start of
					next transmission) ^b
	ARC	3:0	0011	R/W	Auto Retransmit Count
	ARC	3.0	0011	FC/ V V	'0000' –Re-Transmit disabled
					'0001' – Up to 1 Re-Transmit on fail of AA
					'1111' – Up to 15 Re-Transmit on fail of AA
05	RF_CH	_			RF Channel
	Reserved	7	0		Only '0' allowed
	RF_CH	6:0	0000010	R/W	Sets the frequency channel the RF Transceiver
					operates on
06	RF SETUP				RF Setup Register
	CONT_WAVE	7	0	R/W	Enables continuous carrier transmit when high.
	Reserved	6	0	R/W	Only '0' allowed
	RF_DR_LOW	5	0	R/W	Set RF Data Rate to 250kbps. See RF_DR_HIGH
				D 2	for encoding.
	PLL_LOCK	4	0		Force PLL lock signal. Only used in test
	RF_DR_HIGH	3	1	R/W	J 1
					is don't care if RF_DR_LOW is set. Encoding:
					RF_DR_LOW, RF_DR_HIGH:
					'00' – 1Mbps
					'01' – 2Mbps
					'10' – 250kbps
					'11' – Reserved
	RF_PWR	2:1	11	R/W	Set RF output power in TX mode
	-				'00' – -18dBm
					'01' – -12dBm
					'10' – -6dBm
					'11' – 0dBm



Address	Mnemonic	Bit	Reset	Туре	Description
(Hex)			Value	туре	
	Obsolete	0			Don't care
07	STATUS				Status Register (In parallel to the SPI command word applied on the Mosi pin, the STATUS register is shifted serially out on the MISO pin)
	Reserved	7	0		Only '0' allowed
	RX_DR	6	0	R/W	Data Ready RX FIFO interrupt. Asserted when new data arrives RX FIFO ^c . Write 1 to clear bit.
	TX_DS	5	0	R/W	Data Sent TX FIFO interrupt. Asserted when packet transmitted on TX. If AUTO_ACK is activated, this bit is set high only when ACK is received. Write 1 to clear bit.
	MAX_RT	4	0	R/W	Maximum number of TX retransmits interrupt Write 1 to clear bit. If MAX_RT is asserted it must be cleared to enable further communication.
	RX_P_NO	3:1	111	R	Data pipe number for the payload available for reading from RX_FIFO 000-101: Data Pipe Number 110: Not Used 111: RX FIFO Empty
	TX_FULL	0	0	R	TX FIFO full flag. 1: TX FIFO full. 0: Available locations in TX FIFO.
08	OBSERVE TX				Transmit observe register
00	PLOS_CNT	7:4	0	R	Count lost packets. The counter is overflow protected to 15, and discontinues at max until reset. The counter is reset by writing to RF_CH.
	ARC_CNT	3:0	0	R	Count retransmitted packets. The counter is reset when transmission of a new packet starts.
09	RPD				
- 55	Reserved	7:1	000000	R	
	RPD	0	0	R	Received Power Detector. This register is called CD (Carrier Detect) in the nRF24L01. The name is different in the RF Transceiver due to the different input power level threshold for this bit. See section 6.3.4 on page 31.
0A	RX_ADDR_P0	39:0	0xE7E7E 7E7E7	R/W	Receive address data pipe 0. 5 Bytes maximum length. (LSByte is written first. Write the number of bytes defined by SETUP_AW)
0B	RX_ADDR_P1	39:0	0xC2C2C 2C2C2	R/W	Receive address data pipe 1. 5 Bytes maximum length. (LSByte is written first. Write the number of bytes defined by SETUP_AW)
0C	RX_ADDR_P2	7:0	0xC3	R/W	Receive address data pipe 2. Only LSB. MSBytes are equal to RX_ADDR_P1 39:8
0D	RX_ADDR_P3	7:0	0xC4	R/W	Receive address data pipe 3. Only LSB. MSBytes are equal to RX_ADDR_P139:8

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Address (Hex)	Mnemonic	Bit	Reset Value	Туре	Description
0E	RX ADDR P4	7:0	0xC5	R/W	Receive address data pipe 4. Only LSB. MSBytes
OL	KA_ADDK_F4	7.0	0.00	1 1/ 1/ 1/	are equal to RX_ADDR_P139:8
0F	RX_ADDR_P5	7:0	0xC6	R/W	Receive address data pipe 5. Only LSB. MSBytes
					are equal to RX_ADDR_P139:8
4.0		20.0	0 5555	5.044	
10	TX_ADDR	39:0	0xE7E7E 7E7E7	R/W	Transmit address. Used for a PTX operation only. (LSByte is written first)
			16161		Set RX_ADDR_P0 equal to this address to handle
					automatic acknowledge if this is a PTX operation
					with Enhanced ShockBurst™ enabled.
11	RX_PW_P0 Reserved	7:6	00	R/W	Only 100' allowed
	RX PW P0	5:0	00	R/W	Only '00' allowed Number of bytes in RX payload in data pipe 0 (1 to
	KX_1 W_1 0	0.0		1000	32 bytes).
					0 Pipe not used
					1 = 1 byte
					32 = 32 bytes
12	RX PW P1				
	Reserved	7:6	00	R/W	Only '00' allowed
	RX_PW_P1	5:0	0	R/W	Number of bytes in RX payload in data pipe 1 (1 to
					32 bytes).
					0 Pipe not used 1 = 1 byte
					1 - 1 byte
					32 = 32 bytes
					,
13	RX_PW_P2				
	Reserved	7:6	00	R/W	Only '00' allowed
	RX_PW_P2	5:0	0	R/W	Number of bytes in RX payload in data pipe 2 (1 to 32 bytes).
					0 Pipe not used
					1 = 1 byte
					32 = 32 bytes
14	RX PW P3				
14	Rx_Pw_P3 Reserved	7:6	00	R/W	Only '00' allowed
	RX PW P3	5:0	0		Number of bytes in RX payload in data pipe 3 (1 to
					32 bytes).
					0 Pipe not used
					1 = 1 byte
					 32 = 32 bytes
					02 02 bytes
15	RX_PW_P4				
	Reserved	7:6	00	R/W	Only '00' allowed



Address (Hex)	Mnemonic	Bit	Reset Value	Туре	Description
	RX_PW_P4	5:0	0	R/W	Number of bytes in RX payload in data pipe 4 (1 to 32 bytes). 0 Pipe not used 1 = 1 byte
					32 = 32 bytes
16	RX PW P5				
	Reserved	7:6	00	R/W	Only '00' allowed
	RX_PW_P5	5:0	0	R/W	Number of bytes in RX payload in data pipe 5 (1 to 32 bytes). 0 Pipe not used 1 = 1 byte 32 = 32 bytes
					on the same of the
17	FIFO STATUS				FIFO Status Register
	Reserved	7	0	R/W	Only '0' allowed
	TX_REUSE	6	0	R	Used for a PTX operation Pulse the rfce high for at least 10µs to Reuse last transmitted payload. TX payload reuse is active until W_TX_PAYLOAD or FLUSH TX is executed. TX_REUSE is set by the SPI command REUSE_TX_PL, and is reset by the SPI commands W TX_PAYLOAD or FLUSH TX
	TX_FULL	5	0	R	TX FIFO full flag. 1: TX FIFO full. 0: Available locations in TX FIFO.
	TX_EMPTY	4	1	R	TX FIFO empty flag. 1: TX FIFO empty. 0: Data in TX FIFO.
	Reserved	3:2	00	R/W	•
	RX_FULL	1	0	R	RX FIFO full flag. 1: RX FIFO full. 0: Available locations in RX FIFO.
	RX_EMPTY	0	1	R	RX FIFO empty flag. 1: RX FIFO empty. 0: Data in RX FIFO.
N/A	ACK_PLD	255:0	Х	W	Written by separate SPI command ACK packet payload to data pipe number PPP given in SPI command. Used in RX mode only. Maximum three ACK packet payloads can be pending. Payloads with same PPP are handled first in first out.
N/A	TX_PLD	255:0	Х	W	Written by separate SPI command TX data payload register 1 - 32 bytes. This register is implemented as a FIFO with three levels. Used in TX mode only.

Address (Hex)	Mnemonic	Bit	Reset Value	Туре	Description
N/A	RX_PLD	255:0	X	R	Read by separate SPI command. RX data payload register. 1 - 32 bytes. This register is implemented as a FIFO with three levels. All RX channels share the same FIFO.
1C	DYNPD				Enable dynamic payload length
	Reserved	7:6	0	R/W	Only '00' allowed
	DPL_P5	5	0	R/W	Enable dynamic payload length data pipe 5. (Requires EN DPL and ENAA P5)
	DPL_P4	4	0	R/W	Enable dynamic payload length data pipe 4. (Requires EN DPL and ENAA P4)
	DPL_P3	3	0	R/W	Enable dynamic payload length data pipe 3. (Requires EN DPL and ENAA P3)
	DPL_P2	2	0	R/W	Enable dynamic payload length data pipe 2. (Requires EN DPL and ENAA P2)
	DPL_P1	1	0	R/W	Enable dynamic payload length data pipe 1. (Requires EN DPL and ENAA P1)
	DPL_P0	0	0	R/W	Enable dynamic payload length data pipe 0. (Requires EN_DPL and ENAA_P0)
1D	FEATURE				Feature Register
	Reserved	7:3	0	R/W	Only '00000' allowed
	EN_DPL	2	0	R/W	Enables Dynamic Payload Length
	EN_ACK_PAY ^d	1	0	R/W	Enables Payload with ACK
	EN_DYN_ACK	0	0	R/W	Enables the W_TX_PAYLOAD_NOACK command

- a. Please take care when setting this parameter. If the ACK payload is more than 15 byte in 2 Mbps mode the ARD must be 500 μ S or more, if the ACK payload is more than 5 byte in 1Mbps mode the ARD must be 500 μ S or more. In 250 kbps mode (even when the payload is not in ACK) the ARD must be 500 μ S or more
- b. This is the time the PTX is waiting for an ACK packet before a retransmit is made. The PTX is in RX mode for a minimum of 250 μ S, but it stays in RX mode to the end of the packet if that is longer than 250 μ S. Then it goes to standby-I mode for the rest of the specified ARD. After the ARD it goes to TX mode and then retransmits the packet.
- c. The RX_DR IRQ is asserted by a new packet arrival event. The procedure for handling this interrupt should be: 1) read payload through SPI, 2) clear RX_DR IRQ, 3) read FIFO_STATUS to check if there are more payloads available in RX FIFO, 4) if there are more data in RX FIFO, repeat from step 1).
- d. If ACK packet payload is activated, ACK packets have dynamic payload lengths and the Dynamic Payload Length feature should be enabled for pipe 0 on the PTX and PRX. This is to ensure that they receive the ACK packets with payloads. If the ACK payload is more than 15 byte in 2 Mbps mode the ARD must be 500 μS or more, and if the ACK payload is more than 5 byte in 1Mbps mode the ARD must be 500 μS or more. In 250 kbps mode (even when the payload is not in ACK) the ARD must be 500 μS or more.

Table 22. Register map of the RF Transceiver



7 USB Interface

The USB device controller provides a full speed USB function interface that meets the 1.1 and 2.0 revision of the USB specification. It handles byte transfers autonomously and bridges the USB interface to a simple read/write parallel interface.

7.1 Features

- Serial Interface Engine
 - ▶ Supports full speed devices
 - Extraction of clock and data signals in internal DPLL
 - ▶ NRZI decoding/encoding
 - ▶ Bit stuffing/stripping
 - ▶ CRC checking/generation
 - ▶ On-chip transceiver
 - ▶ On-chip pull-up resistor on D+ with software controlled disconnect
- · 2 control, 10 bulk/interrupt and 2 ISO endpoints
 - ▶ Supports control transfers by endpoint #0
 - ► Supports bulk, interrupt on endpoint #1 #5 (in/out)
 - ► Support double buffering for isochronous endpoint #8 (in/out)
 - ▶ Programmable double buffering for bulk and interrupt endpoints
- Automatic data retry mechanism
- · Data toggle synchronization mechanism
- Suspend and resume power management functions
- · Remote Wakeup function
- · Flexible endpoint buffers RAM
 - ▶ 512 bytes buffer total
 - ▶ Up to 64 bytes buffer size for endpoint 0-5
 - ▶ Up to 128bytes buffer size for endpoint 8

The endpoint set up allows for five different applications (for example, Mouse, Keyboard, Remote Control, Gamepad and Joystick) to use both input and output data transfer on separate endpoints.

The nRF24LU1+ OTP supports a total of 14 endpoints. EP0 IN/OUT supports input and output control data transfer, EP1-5 IN/OUT supports input and output bulk and interrupt data transfer. In addition, EP8 IN/OUT can be configured for input and output isynchronous data transfer. These two endpoints share memory buffer area with EP0-5. This sharing is controlled by nRF24LU1+ OTP firmware.



7.2 Block diagram

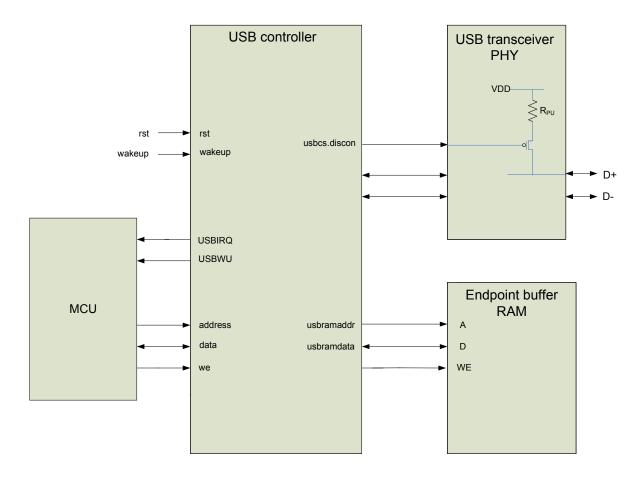


Figure 28. USB block diagram



7.3 Functional description

The USB module is designed to serve as a Full Speed (FS) USB device as defined in the Universal Serial Bus Specification Rev 2.0. It is controlled both with SFR registers and XDATA mapped registers. There are two SFR registers, USBCON and USBSLP, and the rest of the registers are XDATA mapped registers.

Address	Reset value	Bit	Name	R/W	Description
0xA0	0x00	7	swrst	RW	1: reset USB
		6	wu	RW	1: wakeup USB, must be cleared before setting USBSLP.
		5	suspend	R	1: USB is suspended. This bit acknowledges USBSLP=1, after a delay of up to 32µs.
		4-0	iv4-0	R	Interrupt vector ivec, see Table 33. on page 83

Table 23. USBCON register

Address	Reset value	Bit	Name	R/W	Description
0xD9	0x00	7:1	-	-	Not used
		0	Sleep	WO	1: Disable USB clock, bit automatically cleared.

Set wu=1 in USBCON to enable USB clock

Table 24. USBSLP register

The other USB registers and buffer RAM are accessible through a 2k "window" in XDATA space using the MOVX instruction.

Note: Undefined addresses should not be written or read.

Note: Key to abbreviations used in <u>Table 25. on page 69</u>:

▶u - unchanged value after reset

▶x - unknown

Hex address	Name	Hex hard reset	USB reset	bit7	bit6	bit 5	bit 4	bit 3	bit 2	bit 1	bit 0
C440-	out5buf	Х	Х	d7	d6	d5	d4	d3	d2	d1	d0
C47F ^a											
C480-	in5buf	Х	Х	d7	d6	d5	d4	d3	d2	d1	d0
C4BF											
C4C0-	out4buf	Х	Х	d7	d6	d5	d4	d3	d2	d1	d0
C4FF											
C500-	in4buf	Х	Х	d7	d6	d5	d4	d3	d2	d1	d0
C53F											
C540-	out3buf	Х	Х	d7	d6	d5	d4	d3	d2	d1	d0
C57F											
C580-	in3buf	Х	Х	d7	d6	d5	d4	d3	d2	d1	d0
C5BF											
C5C0-	out2buf	Х	Х	d7	d6	d5	d4	d3	d2	d1	d0
C5FF											



Hex		Hex	USB								
address	Name	hard reset	reset	bit7	bit6	bit 5	bit 4	bit 3	bit 2	bit 1	bit 0
C600- C63F	in2buf	Х	Х	d7	d6	d5	d4	d3	d2	d1	d0
C640- C67F	out1buf	Х	х	d7	d6	d5	d4	d3	d2	d1	d0
C680-	in1buf	Х	х	d7	d6	d5	d4	d3	d2	d1	d0
C6BF C6C0-	out0buf	Х	х	d7	d6	d5	d4	d3	d2	d1	d0
C6FF C700-	in0buf	Х	х	d7	d6	d5	d4	d3	d2	d1	d0
C73F C760	out8data	Х	uuuuu	d7	d6	d5	d4	d3	d2	d1	d0
C768	in8data	Х	uuuu	d7	d6	d5	d4	d3	d2	d1	d0
C770	out8bch	00	uuu uuuuu uuu	0	0	0	0	0	0	bc9	bc8
C771	out8bcl	00	uuuuu uuu	bc7	bc6	bc5	bc4	bc3	bc2	bc1	bc0
C781	bout1addr	00	uuuuu uuu	addr8	addr7	addr6	addr5	addr4	addr3	addr2	addr1
C782	bout2addr	00	uuuuu uuu	addr8	addr7	addr6	addr5	addr4	addr3	addr2	addr1
C783	bout3addr	00	uuuuu uuu	addr8	addr7	addr6	addr5	addr4	addr3	addr2	addr1
C784	bout4addr	00	uuuuu uuu	addr8	addr7	addr6	addr5	addr4	addr3	addr2	addr1
C785	bout5addr	00	uuuuu uuu	addr8	addr7	addr6	addr5	addr4	addr3	addr2	addr1
C788	binstaddr	00	uuuuu uuu	addr9	addr8	addr7	addr6	addr5	addr4	addr3	addr2
C789	bin1addr	00	uuuuu uuu	addr8	addr7	addr6	addr5	addr4	addr3	addr2	addr1
C78A	bin2addr	00	uuuuu uuu	addr8	addr7	addr6	addr5	addr4	addr3	addr2	addr1
C78B	bin3addr	00	uuuuu uuu	addr8	addr7	addr6	addr5	addr4	addr3	addr2	addr1
C78C	bin4addr	00	uuuuu uuu	addr8	addr7	addr6	addr5	addr4	addr3	addr2	addr1
C78D	bin5addr	00	uuuuu uuu	addr8	addr7	addr6	addr5	addr4	addr3	addr2	addr1
C7A0	isoerr	00	uuuuu uuu	0	0	0	0	0	0	0	iso8err
C7A2	zbcout	00	uuuuu uuu	0	0	0	0	0	0	0	ep8
C7A8	ivec	00	uuuuu uuu	0	iv4	iv3	iv2	iv1	iv0	0	0
C7A9	in_irq	00	uuuuu uuu	0	0	in5ir	in4ir	in3ir	in2ir	in1ir	in0ir
C7AA	out_irq	00	uuuuu uuu	0	0	out5ir	out4ir	out3ir	out2ir	out1ir	out0ir



Hex address Name hard reset reset hard reset reset hard reset reset hard reset hard reset reset hard reset ha	AB usb
C7AB usbirq 00 uuuuu 0 ibnir uresir suspir sutokir sofir sudokir C7AC in_ien 00 uuuuu 0 0 in5ien in4ien in3ien in2ien in1ien in0ien C7AD out_ien 00 uuuuu 0 out4ien out3ien out2ien out1ie out0 C7AE usbien 00 uuuuu 0 0 ibnie uresie suspie sutokie sofie suda C7AF usbbav 00 uuuuu 0 0 0 0 0 0 0 ave C7B4 ep0cs 08 uuuu 0 0 chgset dstall outbsy inbsy hsnak ep0s C7B5 in0bc 00 uuuu 0 0 0 0 0 in1bsy hsnak ep0s C7B6 in1cs 00 uuuu 0 0 <th>AC in_i</th>	AC in_i
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C7B9 in2bc 00 uuuuu 0 bc6 bc5 bc4 bc3 bc2 bc1 bc C7BA in3cs 00 uuuu 0 0 0 0 0 0 in3bsy in3s C7BB in3bc 00 uuuuu 0 bc6 bc5 bc4 bc3 bc2 bc1 bc C7BC in4cs 00 uuuu 0 0 0 0 0 in4bsy in4s C7BD in4bc 00 uuuu 0 bc6 bc5 bc4 bc3 bc2 bc1 bc C7BE in5cs 00 uuuu 0 0 0 0 0 0 in5bsy in5s	38 in2
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C7BA in3cs 00 uuuu 0 0 0 0 0 0 0 in3bsy in3s C7BB in3bc 00 uuuuu 0 bc6 bc5 bc4 bc3 bc2 bc1 bc C7BC in4cs 00 uuuu 0 0 0 0 0 in4bsy in4s C7BD in4bc 00 uuuu 0 bc6 bc5 bc4 bc3 bc2 bc1 bc C7BE in5cs 00 uuuu 0 0 0 0 0 0 in5bsy in5s	39 in2
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	26 out
uuu y	Jo July
C7C7 out1bc 00 uuuuu 0 bc6 bc5 bc4 bc3 bc2 bc1 bc	C7 out1
C7C8 out2cs 02 uuuuu 0 0 0 0 0 0 out2bs out2	C8 out2
uuu y	
C7C9 out2bc 00 uuuuu 0 bc6 bc5 bc4 bc3 bc2 bc1 bc	
	C9 out2
Uuu y C7CB out3bc 00 uuuuu 0 bc6 bc5 bc4 bc3 bc2 bc1 bc	
Unuu Uuuu Uuu Uuu Uuu Uuu Uuu Uuu Uuu Uu	CA out3
C7CC out4cs 02 uuuuu 0 0 0 0 0 0 out4bs out4	CA out3
uuu y	CA out3



Hex address	Name	Hex hard reset	USB reset	bit7	bit6	bit 5	bit 4	bit 3	bit 2	bit 1	bit 0
C7CD	out4bc	00	uuuuu uuu	0	bc6	bc5	bc4	bc3	bc2	bc1	bc0
C7CE	out5cs	02	uuuuu uuu	0	0	0	0	0	0	out5bs y	out5stl
C7CF	out5bc	00	uuuuu uuu	0	bc6	bc5	bc4	bc3	bc2	bc1	bc0
C7D6	usbcs	00	uuuuu uuu	wakesr c	0	sofgen	0	discon	0	forcej	sigr- sume
C7D7	togctl ^b	00	uuuuu uuu	q	S	r	io	0	ep2	ep1	ep0
C7D8	usbfrml	00	uuuuu uuu	fc7	fc6	fc5	fc4	fc3	fc2	fc1	fc0
C7D9	usbfrmh	00	uuuuu uuu	0	0	0	0	0	fc10	fc9	fc8
C7DB	fnaddr	00	0000	0	fa6	fa5	fa4	fa3	fa2	fa1	fa0
C7DD	usbpair	00	uuuuu uuu	isosend 0	0	0	pr4out	pr2out	0	pr4in	pr2in
C7DE	inbulkval	57	uuuuu uuu	0	0	in5val	in4val	in3val	in2val	in1val	1
C7DF	outbulkval	55	uuuuu uuu	0	0	out5va I	out4val	out3val	out2val	out1va I	1
C7E0	inisoval	07	uuuuu uuu	0	0	0	0	0	0	0	in8val
C7E1	outisoval	07	uuuuu uuu	0	0	0	0	0	0	0	out8val
C7E2	isostaddr	00	uuuuu uuu	0	addr10	addr9	addr8	addr7	addr6	addr5	addr4
C7E3	isosize	00	uuuuu uuu	0	size10	size9	size8	size7	size6	size5	size4
C7E8	setupbuf	00	uuuuu uuu	d7	d6	d5	d4	d3	d2	d1	d0
C7E9	setupbuf	00	uuuuu uuu	d7	d6	d5	d4	d3	d2	d1	d0
C7EA	setupbuf	00	uuuuu uuu	d7	d6	d5	d4	d3	d2	d1	d0
C7EB	setupbuf	00	uuuuu uuu	d7	d6	d5	d4	d3	d2	d1	d0
C7EC	setupbuf	00	uuuuu uuu	d7	d6	d5	d4	d3	d2	d1	d0
C7ED	setupbuf	00	uuuuu uuu	d7	d6	d5	d4	d3	d2	d1	d0



Hex address	Name	Hex hard reset	USB reset	bit7	bit6	bit 5	bit 4	bit 3	bit 2	bit 1	bit 0
C7EE	setupbuf	00	uuuuu uuu	d7	d6	d5	d4	d3	d2	d1	d0
C7EF	setupbuf	00	uuuuu uuu	d7	d6	d5	d4	d3	d2	d1	d0
C7F0	out8addr	00	uuuuu uuu	a9	a8	a7	а6	a5	a4	0	0
C7F8	in8addr	00	uuuuu uuu	a9	a8	a7	а6	a5	a4	0	0

a. The addresses for outxbuf and inxbuf are indirect addresses which are mapped according to the endpoint definitions given in register boutxaddr and binxaddr.

Table 25.USB buffer and register map

7.4 Control endpoints

Each USB device is allocated by endpoint numbers. The endpoint 0 (EP0) is reserved for control transfers. Using USB requests, the host uses EP0 for device configuration.

The device processes the SET_ADDRESS request and sets the address in the fnaddr register. Firmware interrupts this request as configured in the usbien register.

All other USB device requests must be processed by firmware.

7.4.1 Control endpoint 0 implementation

Every USB device must have the endpoint 0, it is the special control endpoint.

b. See also section 7.5.4.



7.4.2 Endpoint 0 registers

Register name	Bit name	Bit description
usbien(0)	sudavie	Setup data valid interrupt enable
usbien(2)	sutokie	Setup token interrupt enable
usbirq(0)	sudavir	Setup data valid interrupt request
usbirq(2)	sutokir	Setup token interrupt request
setupdat0	Setup Data	8 bytes setup data packet
setupdat7	Buffer	
in_irq(0)	in0ir	IN 0 endpoint interrupt request
out_irq(0)	out0ir	OUT 0 endpoint interrupt request
in_ien(0)	in0ien	IN 0 endpoint interrupt enable
out_ien(0)	out0ien	OUT 0 endpoint interrupt enable
ep0cs(0)	ep0stall	Endpoint 0 STALL bit
ep0cs(1)	hsnak	Handshake NAK
ep0cs(2)	inbsy	IN 0 buffer busy flag
ep0cs(3)	outbsy	OUT 0 buffer busy flag
ep0cs(4)	dstall	Send STALL in the data stage
ep0cs(5)	chgset	Setup Buffer content was changed
in0bc	Register	IN 0 byte counter
out0bc	Register	OUT 0 byte counter

Table 26. Endpoint 0 Register



7.4.3 Control transfer examples

A control transfer consists of two or three stages:

- Setup stage
- Data stage (optional)
- · Status stage

7.4.3.1 Control write transfer example

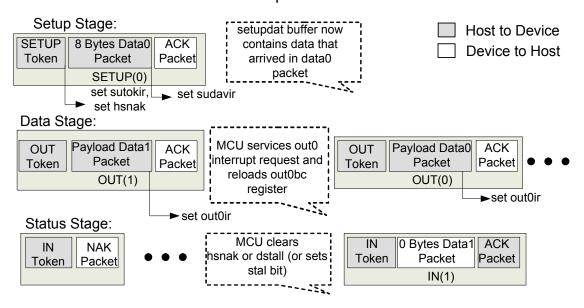


Figure 29. Control Write Transfer

After receiving the SETUP token, the USB controller sets the hsnak and sutokir bits. If an 8-byte data packet is received correctly, the USB controller sets the sudavir bit. Setting sutokir and (or) sudavir bits generates the appropriate interrupts. The data stage consists of one or more OUT bulk-like transactions.

The USB controller generates the OUT 0 interrupt request by setting the out0ir bit after each correct OUT transaction during the data stage. Out0bc register contains the number of data bytes received in the last OUT transaction. The MCU services the interrupt request and then prepares the endpoint for the next transaction by reloading the out0bc register with any value (setting outbsy bit). The status stage of a control transfer is the last operation in the sequence.

The MCU clears the hsnak bit (by writing 1 to it) to instruct the USB controller to ACK the status stage. The USB controller sends a STALL handshake when both hsnak and stall bits are set.



7.4.3.2 Control read transfer example

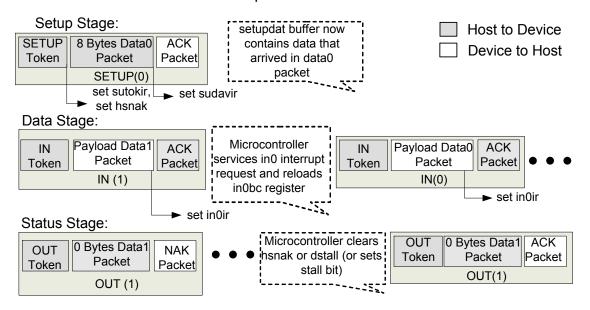


Figure 30. Control Read Transfer

Control read transfer is similar to control write transfer with the only difference in the data stage. During the data stage of control read transfers, the USB controller generates the IN 0 interrupt request by setting in0ir bit. This is done after each acknowledge by the host data packet. The MCU loads new data into the IN 0 buffer and then reloads the in0bc register with a valid number of loaded data. Reloading the in0bc register causes the inbsy bit to set and arms the endpoint for the next IN transaction.

The status stage of a control transfer is the last operation in the sequence. The MCU clears the hsnak bit (by writing 1 to it) to instruct the USB controller to ACK the status stage. The USB controller sends the STALL handshake when both hsnak and stall bits are set.

7.4.3.3 No-data control transfer example

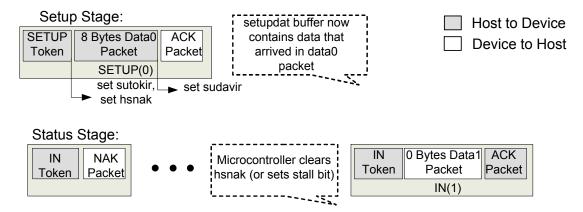


Figure 31. No-data Control Transfer



Some control transfers do not have a data stage. In this case the status stage consists of the IN data packet. The MCU clears the hsnak bit (by writing 1 to it) to instruct the USB controller to ACK (acknowledge) the status stage.

7.5 Bulk/Interrupt endpoints

Each USB transaction is formed as a token packet, optional data packet and, optional handshake packet.

Data transfers consist of two or three phases:

- Token packet
- Data packet
- Handshake packet (optional)

Only control, bulk and, interrupt transfers have their own handshake phase.

Isochronous transfers do not contain a handshake phase. Data is transferred during the data packet phase. Two PID types are available for this: DATA0 and DATA1.

7.5.1 Bulk/Interrupt endpoints implementation

The USB controller has 1 to 5 bulk IN endpoints and 1 to 5 bulk OUT endpoints.

7.5.2 Bulk/Interrupt endpoints registers

Register name	Bit name	Bit description
inbulkval(x)	Inxval	IN x endpoint valid (x = endpoint number)
usbpair	Register	Endpoint pairing register
in_ien(x)	Inxien	IN x endpoint interrupt enable (x = endpoint number)
inxbuf	Buffer	Endpoint x buffer (x = endpoint number)
inxbc	Register	IN x byte count register (x = endpoint number)
inxcs(0)	inxstl	IN x endpoint stall bit (x = endpoint number)
inxcs(1)	inxbsy	IN x endpoint busy bit (x = endpoint number)
in_irq(x)	inxir	IN x endpoint interrupt request

Table 27. Bulk/Interrupt IN endpoints registers

Register name	Bit name	Bit description	
out-	Outxval	OUT x endpoint valid (x = endpoint number)	
bulkval(x)			
usbpair	Register	Endpoint pairing register	
out_ien(x)	Outxien	OUT x endpoint interrupt enable (x = endpoint number)	
outxbuf	Buffer	Endpoint x buffer (x = endpoint number)	
outxbc	Register	OUT x byte count register (x = endpoint number)	
outxcs(0)	Outxstl	OUT x endpoint stall bit (x = endpoint number)	
outxcs(1)	Outxbsy	OUT x endpoint busy bit (x = endpoint number)	
out_irq(x)	Outxir	OUT x endpoint interrupt request	

Table 28. Bulk OUT endpoints registers



7.5.3 Bulk and interrupt endpoints initialization

The MCU sets the appropriate valid bits in the in(out)bulkval register to enable bulk IN (OUT) endpoints for normal operation.

7.5.3.1 Bulk and interrupt transfers

a) IN transfers

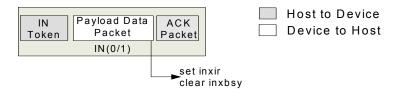


Figure 32. Bulk IN transfer

The host issues an IN token to receive bulk data. If the inxbsy bit is set, the USB controller responds by returning a data packet. If the host receives a valid data packet, it responds with an ACK handshake.

After receiving a valid ACK handshake from the host, the USB controller sets the inxir bit and clears the inxbsy bit. Setting the inxir bit generates an interrupt request for IN x endpoint (x = appropriate number of endpoint).

The MCU services the interrupt request. During a service interrupt request the MCU loads new data into the inxbuf buffer and then reloads the inxbc register with a valid number of data bytes to set the inxbsy bit. IN x endpoint is armed for the next transfer when the inxbsy bit is set.

When the inxbsy bit is not set, the USB controller returns NAK handshake for each IN token from the host. When the inxstl bit is set, the USB controller returns the STALL handshake.

Errors in IN token	Inxbsy	Inxstl	USB controller to host response
NO	1	0	Inxbc bytes data packet
NO	0	1	STALL
NO	0	0	NAK
NO	1	1	STALL
YES	-	-	No response

Table 29. The USB controller response for IN Token



b) OUT transfers

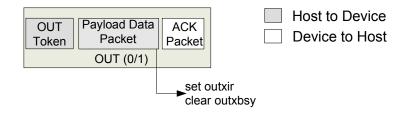


Figure 33. Bulk OUT transfer

When the host wants to transmit bulk data, it issues an OUT Token packet followed by a data packet. An ACK handshake is returned to the host and the outxir bit is set when the USB controller receives an error free OUT, data packets and, the outxbsy bit is set. Setting the outxir bit generates an interrupt request for the OUT x endpoint (x = appropriate number of endpoints).

The MCU services the OUT x interrupt request. The received data packet is available in the outxbuf buffer. After servicing an interrupt request, the MCU reloads the outxbc register with any value to set the outxbsy bit. When the outxbsy bit is set the OUT x endpoint is armed for the next OUT transfer.

A NAK handshake is returned to the host when the USB controller receives data packets and an error free OUT but the outxbsy bit is not set.

A STALL handshake is returned to the host when the USB controller receives an error free OUT and data packets and the outxstl bit is set. The USB controller does not return a handshake if any transmission error occurs during an OUT token or data phase.

Errors in OUT token or in data packet	outxbsy	outxstl	USB controller to host response
NO	0	0	NAK
NO	0	1	STALL
NO	1	0	ACK
NO	1	1	STALL
YES	-	-	No response

Table 30. The USB controller response for OUT transfers

7.5.4 Data packet synchronization

Data packet synchronization is achieved through the use of the data sequence toggle bits and the DATA0/DATA1 PIDs. The USB controller automatically toggles DATA0/DATA1 PIDs every bulk transfer.

The MCU can directly set or clear data toggle bits using the togctl register. The MCU clears the toggle bits when the host issues Clear Feature, Set Interface or, selects alternate settings.

To write a toggle bit the MCU performs the following sequence:

- Write to togctl register "000d0eee" value to select endpoint "eee" ("eee" binary value). Endpoint direction bit "d": "d"='0' OUT endpoint; "d"='1' IN endpoint.
- Clear or set toggle bit by writing to togctl register "0srd0eee" value. "sr"='10' setting toggle bit;
 "sr"='01' clearing toggle bit.



7.5.5 Endpoint pairing

To enable double buffering the MCU sets the appropriate bits in the usbpair register to '1' (see <u>section 15.1</u> on page 128).

When double buffering is enabled, the MCU may access one buffer of the pair while the USB host accesses the other. When an endpoint is paired, the MCU uses only an even numbered endpoint of the pair.

For example, if the usbpair(0) bit is set, that means that the IN 2 and the IN 3 endpoints are paired. The MCU should not access in3buf data buffer, in3val bit, in3bc register, in3ir bit, in3ien bit, or in3cs registers.

7.5.5.1 Paired IN endpoint status

When both endpoint buffers of the pair are filled and armed, the inxbsy bit is set to '1' by the USB controller and the MCU does not load new data into the inxbuf buffer.

When one or both buffers of the pair are empty (unarmed), the inxbsy bit is set to '0' by the USB controller and the MCU may fill inxbuf with new data and reload the inxbc register to arm the endpoint for transmission. Clearing the inxbsy bit (write a '1') causes both of the paired endpoints to unarm. An interrupt request is generated after each data packet is correctly sent, independent of the inxbsy bit.

7.5.5.2 Paired OUT endpoint status

When the MCU pairs OUT endpoints by setting bit in the usbpair register, it also reloads twice the outxbc register to arm paired OUT endpoints.

When both endpoint buffers of the pair are empty and no data is available for the MCU, the outxbsy bit is set to '1' by the USB controller.

When one or both of the buffers contain valid data, the outxbsy bit is reset to '0' by the USB controller. Clearing the outxbsy bit (write a '1') causes both of the paired endpoints to unarm. An interrupt request is generated after each data packet is correctly received, independent of outxbsy bit or dstall. To receive an interrupt you must arm the endpoint by setting outxbc to a non-zero value.

7.6 Isochronous endpoints

Isochronous (ISO) transactions have a token and a data phase, but no handshake phase. ISO transactions do not support a handshake phase or retry capability and they do not support a data toggle synchronization mechanism.

Isochronous transmission is double buffered. An ISO FIFO swap occurs for every start of frame packet.

7.6.1 Isochronous endpoints implementation

The USB controller contains one IN endpoint and one isochronous OUT endpoint (Endpoint 8 IN/OUT).



7.6.2 Isochronous endpoints registers

Register name	Bit name	Bit description	
inisoval	in8val	IN 8 endpoint valid	
in8addr	register	IN 8 endpoint address register	
usbpair(7)	isosend0	ISO endpoints send a zero length data packet if it is empty	
usbien(1)	sofie	Start of Frame interrupt enable	
in8data	register	IN 8 endpoint data register	
usbirq(1)	sofir	Start of Frame interrupt request	

Table 31. ISO IN endpoint registers

Register name	Bit name	Bit description	
outisoval	out8val	OUT 8 endpoint valid	
out8addr	register	OUT 8 endpoint address register	
usbien(1)	sofie	Start of Frame interrupt enable	
out8data	register	OUT 8 endpoint data register	
usbirq(1)	sofir	Start of Frame interrupt request	
out8bch	register	Received byte count register high	
out8bcl	register	Received byte count register low	
isoerr	iso8err	OUT 8 endpoint CRC error	

Table 32. ISO OUT endpoint registers

7.6.3 ISO endpoints initialization

The MCU performs the following steps to enable isochronous IN (OUT) endpoints for normal operation:

- Sets the appropriate valid bits into the in(out)isoval register.
- Sets the endpoint's FIFO size by loading the start address into the in(out)8addr register.
- Sets the isosend0 bit into the usbpair register for IN endpoints only.
- Enables the start of frame interrupt by setting the sofie bit in the usbien register.

7.6.4 ISO transfers

The MCU serves all the ISO endpoints in response to a start of frame interrupt request.

7.6.4.1 ISO IN transfers



Figure 34. ISO IN transfer

The MCU loads new data into the ISO IN endpoint buffer(s) at every start of frame interrupt request. The ISO IN endpoint is accessed through the in8data register. The USB controller keeps track of the number of bytes that the MCU loads and sends loaded data during the next frame.

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When the host wants to receive ISO data, it issues an IN token for a specific endpoint. If the IN buffer the host selected contains data, the USB controller responds by returning a data packet.

If the buffer is empty the USB controller behavior depends on the isosend0 bit:

- If the isosend0 bit is set, the USB controller responds with a zero byte length data packet.
- If the isosend0 bit is not set, USB controller does not respond.

7.6.4.2 ISO OUT transfers



Figure 35. ISO OUT transfer

With every start of frame interrupt request the MCU reads data that was sent by the host in the previous frame. Out8bch and out8bcl registers contain the number of transferred bytes. Data is accessible through the out8data register. The USB controller sets the iso8err bit when the ISO data packet is corrupted.

7.7 Memory configuration

7.7.1 On-chip memory map

All endpoint buffers are located in a single 512 byte memory block. Bulk OUT buffers block start at address 0. You can program localization of the Bulk IN buffers using binstaddr register. If the host sends a packet which is larger than the configured buffer size, the USB controller will not NAK or STALL.

You can program start of ISO buffers using isostaddr register. Additionally, program size of the ISO buffers using isosize register.

Note: All ISO endpoints are double buffered.

<u>Figure 36.</u> shows on-chip memory organization. See <u>Appendix A on page 175</u> for various USB memory configurations.



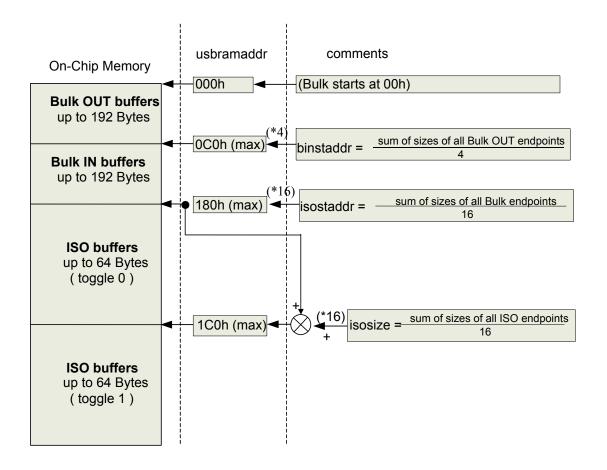


Figure 36. On-chip memory map

7.7.2 Setting ISO FIFO size

128 byte ISO buffers memory may be distributed over the two endpoint addresses: EP8 IN and EP8 OUT. The MCU initializes the endpoint FIFO sizes by setting the starting address for each FIFO. The first FIFO starting address is 0x000H. The size of an isochronous endpoint FIFO is determined by subtracting consecutive values of FIFO 8 starting addresses.

Note: Only the six most significant bits can be written by the MCU (see Figure 37. on page 79).

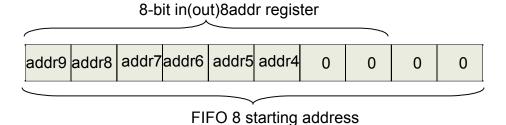


Figure 37. FIFO 8 starting address



The LSB values of the in(out)8addr register are always zero, that is, the smallest size of FIFO buffer for each ISO endpoints is 16 bytes.

7.7.3 Setting Bulk OUT size

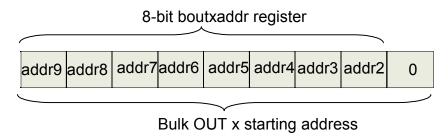


Figure 38. Bulk OUT x starting address

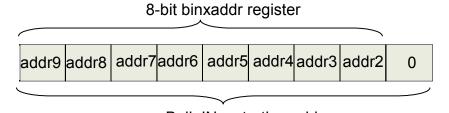
Bulk OUT buffers memory can be distributed over the 6 bulk OUT endpoints. Size of each Bulk OUT endpoint should be programmed using boutxaddr registers. When OUT x endpoint is not used the boutxaddr for this endpoint should be set to 000h.

The first starting address (EP0 OUT) is 000H. The size of a bulk OUT endpoint is determined by subtracting consecutive values of bulk OUT x starting addresses. The size of Bulk OUT buffer is a multiple of two bytes.

Here is an example initialization of the boutxaddr registers:

```
const uint8_t EP00UTSTARTADDR = 0; // start address for EP0 OUT
bout1addr = EP00UTSTARTADDR + (EP00UT_SIZE/2);
bout2addr = bout1addr + (EP10UT_SIZE/2);
bout3addr = bout2addr + (EP20UT_SIZE/2);
bout4addr = bout3addr + (EP30UT_SIZE/2);
bout5addr = bout4addr + (EP40UT_SIZE/2);
binstaddr = (bout5addr + (EP50UT_SIZE/2))/2; // beginning of Bulk IN buffers
```

7.7.4 Setting Bulk IN size



Bulk IN x starting address

Figure 39. Bulk IN x starting address

Bulk IN buffers memory can be distributed over the 6 bulk IN endpoints. Size of each bulk IN endpoint is programmed using binxaddr registers.

When IN x endpoint does not exist (or is not used) the binxaddr for it should be set to 000h. The first starting address (EP0 IN) is 000H. The size of a Bulk IN endpoint is determined by subtracting consecutive values of Bulk IN x starting addresses. The size of Bulk IN buffer is a multiple of two bytes.

Here is an example initialization of the binxaddr registers:

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```
const unsigned char EPOINSTARTADDR = 0; // start address for EPO IN
bin1addr = EPOINSTARTADDR + (EPOIN_SIZE/2);
bin2addr = bin1addr + (EPIIN_SIZE/2);
bin3addr = bin2addr + (EP2IN_SIZE/2);
bin4addr = bin3addr + (EP3IN_SIZE/2);
bin5addr = bin4addr + (EP4IN_SIZE/2);
isostaddr = (bin5addr + (EP5IN_SIZE/2))/8 + binstaddr/4; // beginning of the ISO buffers
```

7.8 The USB controller interrupts

The USB controller provides the two following interrupt signals for MCUs:

- USBWU
- USBIRQ

The USB controller generates interrupts by setting the USBWU or USBIRQ signal high and then setting it low. This interrupt request pulse is detected by the MCU as an edge triggered interrupt.

7.8.1 Wakeup interrupt request

When the USB controller is suspended by the host, it can be resumed in two ways:

- By the MCU setting the wakeup bit 6 of USBCON SFR register.
- · By receiving a resume request from the host.

After resuming, the USB controller generates a wakeup interrupt request by setting the USBWU signal high.

7.8.2 USB interrupt request

The USB interrupt request is provided through the USBIRQ signal and includes:

- 12 bulk endpoint interrupts
- Start of frame interrupt (sofir)
- Suspend interrupt (suspir)
- USB reset interrupt (uresir)
- Setup token interrupt (sutokir)
- Setup data valid interrupt (sudavir)

Figure 40. on page 82 shows all the interrupt sources and their natural priority.

After servicing the USB controller interrupt, the MCU clears the individual interrupt request flag in the USB registers. If any other USB interrupts are pending, the act of clearing the interrupt request flag causes the USB controller to generate another pulse for the highest priority pending interrupt. If more than one interrupt is pending, each is serviced in the priority order.

The sequence of clearing the interrupt requests is important. The MCU first clears the main interrupt request flag (USBIRQ) and then each individual interrupt request in the USB controller register (usbirq).

Clearing the interrupt source immediately generates an interrupt pulse for the next pending interrupt. The interrupt may be lost when the MCU clears the main interrupt request flag after clearing the individual interrupt source.



Note: There is a difference between the interrupt USBIRQ, which is defined in <u>Table 136.</u>, and the register usbirq described in <u>Table 43.</u>

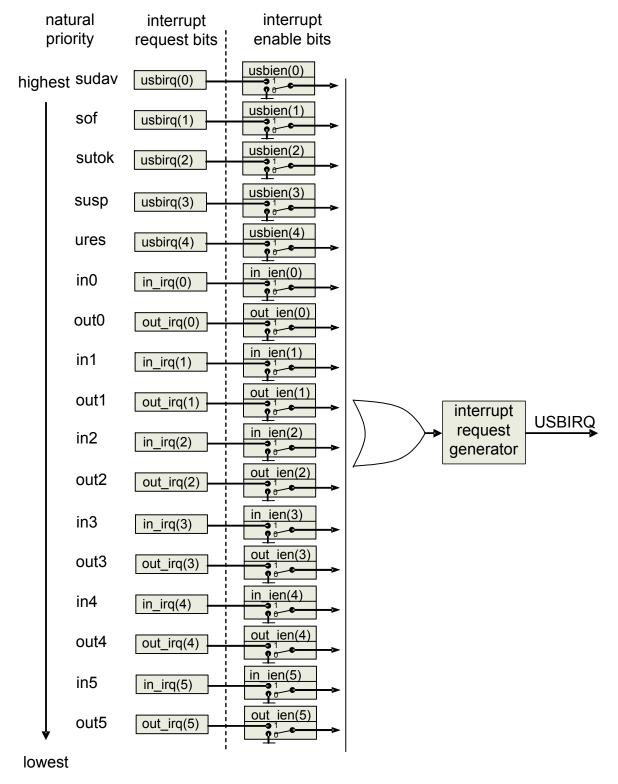


Figure 40. The USB controller interrupt sources



7.8.3 USB interrupt vectors

The USB controller prioritizes the USB interrupts if two or more occur simultaneously. The vector of the active interrupt is available in the ivec register. <u>Table 33.</u> shows the contents of the ivec register for the USB interrupts.

Source of interrupt	Register bit	Contents of ivec register
sudav	usbirq(0)	0x00H
sof	usbirq(1)	0x04H
sutok	usbirq(2)	0x08H
suspend	usbirq(3)	0x0CH
usbreset	usbirq(4)	0x10H
ep0in	In_irq(0)	0x18H
ep0out	out07irq(0)	0x1CH
ep1in	In_irq(1)	0x20H
ep1out	out07irq(1)	0x24H
ep2in	In_irq(2)	0x28H
ep2out	out07irq(2)	0x2CH
ep3in	In_irq(3)	0x30H
ep3out	out07irq(3)	0x34H
ep4in	In_irq(4)	0x38H
ep4out	out07irq(4)	0x3CH
ep5in	In_irq(5)	0x40H
ep5out	out07irq(5)	0x44H

Table 33. Interrupt vectors

7.9 The USB controller registers

The microprocessor interfaces with the USB controller logic through the following registers and RAM buffers.

7.9.1 Bulk IN data buffers (inxbuf)

Six 32 byte bulk IN buffers are in RAM memory.

Address	Name	Function
0xC700-0xC73F	in0buf	Max 64 bytes bulk 0 IN buffer
0xC680-0xC6BF	in1buf	Max 64 bytes bulk 1 IN buffer
0xC600-0xC63F	in2buf	Max 64 bytes bulk 2 IN buffer
0xC580-0xC5BF	in3buf	Max 64 bytes bulk 3 IN buffer
0xC500-0xC53F	in4buf	Max 64 bytes bulk 4 IN buffer
0xC480-0xC4BF	in5buf	Max 64 bytes bulk 5 IN buffer

Note: The sum of all endpoints (IN+OUT+ISO) must be less or equal to 512.

Table 34.Bulk IN endpoints memory locations



7.9.2 Bulk OUT data buffers (outxbuf)

Six 32 byte bulk OUT buffers are in RAM memory.

Address	Name	Function
0xC6C0-0xC6FF	out0buf	Max 64 bytes bulk 0 OUT buffer
0xC640-0xC67F	out1buf	Max 64 bytes bulk 1 OUT buffer
0xC5C0-0xC5FF	out2buf	Max 64 bytes bulk 2 OUT buffer
0xC540-0xC57F	out3buf	Max 64 bytes bulk 3 OUT buffer
0xC4C0-0xC4FF	out4buf	Max 64 bytes bulk 4 OUT buffer
0xC440-0xC47F	out5buf	Max 64 bytes bulk 5 OUT buffer

Note: The sum of all endpoints (IN+OUT+ISO) must be less or equal to 512.

Table 35.Bulk OUT endpoints memory locations

7.9.3 Isochronous OUT endpoint data FIFO (out8dat)

Address	Name	Function
0xC760	out8data	ISO OUT endpoint 8 data FIFO register

Table 36. The out8dat register

7.9.4 Isochronous IN endpoint data FIFOs (in8dat)

Address	Name	Function
0xC768	in8data	ISO IN endpoint 8 FIFO data register

Table 37. The in8dat register

7.9.5 Isochronous data bytes counter (out8bch/out8bcl)

Address	Name	Function
0xC770	out8bch	ISO OUT endpoint 8 data counter high
0xC771	out8bcl	ISO OUT endpoint 8 data counter low

Table 38. The outxbch/bcl register

7.9.6 Isochronous transfer error register (isoerr)

Address	MSB							LSB
0xC7A0	-	-	-	-	-	-	-	iso8err

Table 39. The isoerr register

The isoerr register is updated at every Start Of Frame. The iso8err bits indicate that an error occurred during the receiving of ISO OUT 8 endpoint data packet.

Iso8err bit = 1 means that a CRC error occurred, but received data is available in the out8data register.



7.9.7 The zero byte count for ISO OUT endpoints (zbcout)

Address	MSB							LSB
0xC7A2	-	-	-	-	-	-	-	ep8

Table 40. The zbcout register

The ep8 bit is set to '1' when zero-byte ISO OUT data packet is received for OUT 8 endpoint in the previous frame.

7.9.8 Endpoints 0 to 5 IN interrupt request register (in_irq)

Address	MSB							LSB
0xC7A9	-	-	in5ir	in4ir	in3ir	in2ir	in1ir	in0ir

Table 41. The in_irq register

inxir is set to '1' when IN packet transmits and ACK receives from the host. Firmware sets inxir to '1' to clear interrupt.

7.9.9 Endpoints 0 to 5 OUT interrupt request register (out_irq)

Address	MSB							LSB
0xC7AA	-	-	out5ir	out4ir	out3ir	out2ir	out1ir	out0ir

Table 42. The out_irq register

outxir is set to '1' when OUT packet is received error free. Firmware sets outxir to '1' to clear interrupt.

7.9.10 The USB interrupt request register (usbirq)

Address	Bit	Name	Function
0xC7AB	7:5		Must be zero
	4	uresir	USB reset interrupt request
			1: a USB bus reset is detected
	3	suspir	USB suspend interrupt request
			1: USB SUSPEND signaling detected
	2	sutokir	SETUP token interrupt request
			1: SETUP token detected
	1	sofir	Start of frame interrupt request
			1: SOF packet received
	0	sudavir	SETUP data valid interrupt request
			1: error free SETUP data packet received

Table 43. The usbirg bit functions

Firmware clears an interrupt request by writing '1' to the corresponding request bit.



7.9.11 Endpoint 0 to 5 IN interrupt enables (in_ien)

Address	MSB							LSB
0xC7AC	-	-	in5ien	in4ien	in3ien	in2ien	in1ien	in0ien

Table 44. The in_ien register

Firmware sets inxien to '1' to enable interrupt.

7.9.12 Endpoint 0 to 5 OUT interrupt enables (out_ien)

Address	MSB							LSB
0xC7AD	-	-	out5ien	out4ien	out3ien	out2ien	out1ien	out0ien

Table 45. The out_ien register

Firmware sets outxien to '1' to enable interrupt.

7.9.13 USB interrupt enable (usbien)

Address	Bit	Name	Function
0xC7AE	7:5	-	Must be zero
	4	uresie	USB reset interrupt enable
	3	suspie	USB suspend interrupt enable
	2	sutokie	SETUP token interrupt enable
	1	sofie	Start of frame interrupt enable
	0	sudavie	SETUP data valid interrupt enable

Table 46. The usbien register



7.9.14 Endpoint 0 control and status register (ep0cs)

Address	Bit	Name	Function
0xC7B4	7:6	-	Must be zero
	5	chgset	Setup Buffer content was changed.
			Chgset=1 - setup buffer was changed.
			Chgset=0 - setup buffer was not changed.
			The MCU clears the chgset bit by writing a '1' to it.
			The chgset bit is automatically set when USB controller
			receives setup data packet.
	4	dstall	Send STALL in the data stage.
			If dstall bit is set to '1', the USB controller sends a
			STALL handshake for any IN or OUT token in the data
			stage. When dstall is set and USB controller sends
			STALL in the data stage, the ep0stall is automatically
			set to '1' and USB controller sends STALL handshake
			also in the status stage. dstall is automatically cleared
			when a SETUP token arrives. The MCU sets this bit by
			writing '1' to it.
			The MCU should set dstall bit after last successful trans-
			action in the data stage. When there were not excessive
			transactions in the data stage and the next transaction
			is in the correct status stage the USB controller will
		. 1	answer based on hsnak and ep0stall settings.
	3	outbsy	OUT0 endpoint busy bit. Outbsy is a read only bit that is
			automatically cleared when a SETUP token arrives. The
			MCU sets this bit by writing a dummy value to the
			out0bc register.
			1: USB controller controls the OUT 0 endpoint buffer.
	2		0: the MCU controls of the OUT 0 endpoint buffer.
	2	inbsy	INO endpoint busy bit. inbsy is a read only bit that is automatically cleared when a SETUP token arrives. The
			MCU sets this bit by reloading the in0bc register.
			1: USB controller controls the IN 0 endpoint buffer.
			0: the MCU controls the IN 0 endpoint buffer.
	1	hsnak	If hsnak bit is set to '1', the USB controller responds with
	ı	IIBIIAN	a NAK handshake for every packet in the status stage.
			hsnak bit is automatically set when a SETUP token
			arrives. The MCU clears the hsnak bit by writing a '1' to
			it.
	0	ep0stall	Endpoint 0 stall.
		CPOSCAII	1: the USB controller sends a STALL handshake for any
			IN or OUT token. This is done in the data or handshake
			phases of the CONTROL transfer. Ep0stall is automati-
			cally cleared when a SETUP token arrives. The MCU
			sets this bit by writing '1' to it.
			ooto this sit sy writing it to it.

Table 47. ep0cs register



7.9.15 Endpoint 0 to 5 IN byte count registers (inxbc)

Address	Name	Function
0xC7B5	in0bc	IN 0 endpoint byte count register
0xC7B7	in1bc	IN 1 endpoint byte count register
0xC7B9	in2bc	IN 2 endpoint byte count register
0xC7BB	in3bc	IN 3 endpoint byte count register
0xC7BD	in4bc	IN 4 endpoint byte count register
0xC7BF	in5bc	IN 5 endpoint byte count register

Table 48. Endpoint 0 to 5 IN byte count register locations

After loading the IN x endpoint buffer, the MCU writes to the inxbc register with the number of loaded bytes. Writing to the inxbc register causes the arming of IN x endpoint by setting the inxbsy bit to '1'.

When the host sends IN token for IN x endpoint and inxbsy bit is set, the USB controller responds with an inxbc size data packet.

7.9.16 Endpoint 1 to 5 IN control and status registers (inxcs)

Address	Name	Function
0xC7B6	in1cs	IN 1 endpoint control and status register
0xC7B8	in2cs	IN 2 endpoint control and status register
0xC7BA	in3cs	IN 3 endpoint control and status register
0xC7BC	in4cs	IN 4 endpoint control and status register
0xC7BE	in5cs	IN 5 endpoint control and status register

Table 49. Endpoint 1 to 5 IN control and status register locations

Bit	Symbol	Function
7:2	-	Not used.
1	inxbsy	IN x endpoint busy bit.
		1: the USB controller takes control of the IN x endpoint buffer.
		0: the MCU takes control of the IN x endpoint buffer.
		When the host sends an IN token for IN x endpoint and the inxbsy
		bit is set, the USB controller responds with inxbc size data packet
		and clears the inxbsy bit.
		0: the IN x endpoint is empty and ready for loading by the MCU.
		1: the MCU does not access the IN x endpoint buffer.
		A '1' to '0' transition of the inxbsy bit generates an interrupt request
		for the IN x endpoint. The MCU sets the inxbsy bit by reloading the
		inxbc register.
0	inxstl	IN x endpoint stall bit.
		1: the USB controller returns a STALL handshake for all requests
		to the endpoint x.

Table 50. The inxcs register description



7.9.17 Endpoint 0 to 5 OUT byte count registers (outxbc)

Address	Name	Function
0xC7C5	out0bc	OUT 0 endpoint byte count register
0xC7C7	out1bc	OUT 1 endpoint byte count register
0xC7C9	out2bc	OUT 2 endpoint byte count register
0xC7CB	out3bc	OUT 3 endpoint byte count register
0xC7CD	out4bc	OUT 4 endpoint byte count register
0xC7CF	out5bc	OUT 5 endpoint byte count register

Table 51. Endpoint 0 to 5 OUT byte count register locations

The outxbc register contains the number of bytes sent during the last OUT transfer from the host to an OUT x endpoint. The outxbc is a read only register that is updated by the USB controller.

7.9.18 Endpoint 1 to 5 OUT control and status registers (outxcs)

Address	Name	Function
0xC7C6	out1cs	OUT 1 endpoint control and status register
0xC7C8	out2cs	OUT 2 endpoint control and status register
0xC7CA	out3cs	OUT 3 endpoint control and status register
0xC7CC	out4cs	OUT 4 endpoint control and status register
0xC7CE	out5cs	OUT 5 endpoint control and status register

Table 52. Endpoint 1 to 5 OUT control and status register locations

Bit	Symbol	Function								
	-	Not used								
1	outxbsy	OUT x endpoint busy bit.								
		1: the USB controller takes control of the OUT x endpoint buffer.								
		0: the MCU takes control of the OUT x endpoint buffer.								
		When the host sends an OUT token for an OUT x endpoint and the								
		outxbsy bit is set, the USB controller receives an OUT data								
		packet and clears the outxbsy bit. If outxbsy='1', the OUT x end-								
		point is empty and ready to receive the next data packet from the								
		nost. When outxbsy='1', the MCU does not read the OUT x end-								
		point buffer. A '1' to '0' transition of the outxbsy bit generates an								
		interrupt request for the OUT x endpoint. The MCU sets the outx-								
		bsy bit by reloading the outxbc register with a dummy value.								
0	outxstl	OUT x endpoint stall bit.								
		If outxstl='1', the USB controller returns a STALL handshake for all								
		requests to the endpoint x.								

Table 53. The outxcs register description



7.9.19 USB control and status register (usbcs)

Address	Bit	Name	Function
0xC7D6	7	wakesrc	Wakeup source. This bit indicates that a wakeup pin
			resumed the USB controller. The MCU resets this bit
			by writing a '1' to it.
	6	-	Not used.
	5	sofgen	Sofgen= 1 - internal SOF timer is used to generate
			SOF interrupt in case when SOF issued by USB host
			was missed.
			Sofgen= 0 - internal SOF timer is disabled.
			Default value (after reset) is '0'.
	4	-	Not used.
	3	discon	1: Disconnect the 1.5 kohm internal pull-up resistor
			on D+ line, 0: Normal
	2	-	Not used.
	1	forcej	Forcej should be used only in the suspend state. The
			MCU should set forcej bit to drive J state on the USB
			lines and then clear forcej and set sigrsume to drive
			resume-K state on the USB lines. Forcing J state
			between idle and K state can be done to raise the
			crossover voltage and eliminate any false SE0.
	0	sigrsume	Signal remote device resume. If the MCU sets this bit
			to '1', the USB controller sets K state on the USB.

Table 54. The usbcs bit functions

7.9.20 Data toggle control register (togctl)

Address	Bit	Name	Function
0xC7D7	7	đ	Data toggle value q='1' means that data toggle for endpoint selected by ep2,ep1,ep0 and io bits is set to DATA1. q='0' means that data toggle for endpoint selected by ep2,ep1,ep0 and io bits is set to DATA0. Before reading this bit, the MCU writes the ep2, ep1, ep0 and io bits.
	6	s	Set data toggle to DATA1. Writing '1' to this bit when endpoint is selected (ep2, ep1, ep0, io bits) causes setting the data toggle to DATA1.
	5	r	Reset data toggle to DATA0. Write '1' to this bit when endpoint is selected (ep2, ep1, ep0, io bits) causes setting data toggle to DATA0.
	4	io	Select IN or OUT endpoint io='1' selects IN endpoint, i0='0' selects OUT endpoint.
	3	-	Not used.
	2	ep2	Select number of endpoint. Valid values are 0 to 5 (000 – 101).
	1	ep1	
	0	ep0	

Table 55. The togctl bit functions



7.9.21 USB frame count low (usbframel/usbframeh)

Address	Name	Function
0xC7D8	usbframel	USB frame count low
0xC7D9	usbframeh	USB frame count high

Table 56. USB frame count low (usbframel/usbframeh)

The USB controller copies the frame count into the usbframel and usbframeh registers at every SOF (Start Of Frame). These registers are read only.

Note: Frame count wraps from 3ffh to 000h.

7.9.22 Function address register (fnaddr)

Address	Name	Function					
0xC7DB	fnaddr	USB function address (1-127)					

Table 57. Function address register (fnaddr)

The USB controller copies the "function address" which was sent by the host into the fnaddr register. The USB controller responds only with its assigned address. The fnaddr is a read only register.

7.9.23 USB endpoint pairing register (usbpair)

Address	Bit	Name	Function
0xC7DD	7	isosend0	ISO endpoints send zero length data packet.
			If the USB controller receives IN token for the isochro-
			nous endpoint and IN endpoint FIFO is empty, the
			USB controller response depends on the isosend0
			bit.
			If isosend0='1', the USB controller sends a zero
			length data packet.
			If isosend0='0', the USB controller does not respond.
	6:5		Not used.
	4	pr4out	1: Pair bulk OUT 4 and bulk OUT 5 endpoints.
	3	pr2out	1: Pair bulk OUT 2 and bulk OUT 3 endpoints.
	2	pr6in	1: Pair bulk IN 6 and bulk IN 7 endpoints.
	1	pr4in	1: Pair bulk IN 4 and bulk IN 5 endpoints.
	0	pr2in	1: Pair bulk IN 2 and bulk IN 3 endpoints.

Table 58. The usbpair bit functions

7.9.24 Endpoints 0 to 5 IN valid bits (Inbulkval)

Address	MSB							LSB
0xC7DE	0	0	in5val	in4val	in3val	in2val	in1val	1

Table 59. The inbulkval register

If inxval='1', the IN x endpoint is active. When inxval='0', the IN x endpoint is inactive and the USB controller does not respond if IN x endpoint is addressed.



7.9.25 Endpoints 0 to 5 OUT valid bits (outbulkval)

Address	MSB							LSB
0xC7DF	0	0	out5val	out4val	out3val	out2val	out1val	1

Table 60. The outbulkval register

If outxval='1', the OUT x endpoint is active. When outxval='0', the OUT x endpoint is inactive and the USB controller does not respond if OUT x endpoint is addressed.

7.9.26 Isochronous IN endpoint valid bits (inisoval)

Address	MSB							LSB
0xC7E0	0	0	0	0	0	0	0	in8val

Table 61. The inisoval register

If in8val='1', the IN 8 endpoint is active. When in8val='0', the IN 8 endpoint is inactive and the USB controller does not respond if IN 8 endpoint is addressed.

7.9.27 Isochronous OUT endpoint valid bits (outisoval)

Address	MSB							LSB
0xC7E1	0	0	0	0	0	0	0	out8val

Table 62. The outisoval register

If out8val='1', the OUT 8 endpoint is active. When out8val='0', the OUT 8 endpoint is inactive and the USB controller does not respond if OUT 8 endpoint is addressed.

7.9.28 SETUP data buffer (setupbuf)

Address	MSB							LSB
0xC7E8-0xC7EF	D7	D6	D5	D4	D3	D2	D1	D0

Table 63. The setupbuf buffer

The setupbuf contains the 8 bytes of the SETUP data packet from the latest CONTROL transfer.

7.9.29 ISO OUT endpoint start address (out8addr)

Address	MSB							LSB
0xC7F0	A9	A8	A7	A6	A5	A4	0	0

Table 64. The out8addr start address

7.9.30 ISO IN endpoint start address (in8addr)

Address	MSB							LSB
0xC7F8	A9	A8	A7	A6	A5	A4	0	0

Table 65. The in8addr start address



8 Encryption/Decryption Unit

The nRF24LU1+ OTP has dedicated HW for data encryption or decryption according to the AES (Advanced Encryption Standard) algorithm. An AES encryption/decryption consists of the transformation of a 128-bit block into an encrypted 128-bit block.

8.1 Features

The AES block supports both encryption and decryption in ECB, CBC, CFB, OFB and CTR modes using a 128-bit key and optionally a 128-bit initialization vector.

8.1.1 ECB – Electronic Code Book

ECB is the most basic AES encryption/decryption mode. In encryption E the plaintext on DI is converted to a ciphertext on DO. In decryption D the ciphertext on DI is converted to plaintext on DO. ECB must use the last expanded key to decrypt. Decryption reverses encryption operations and is identical to the encryption function.

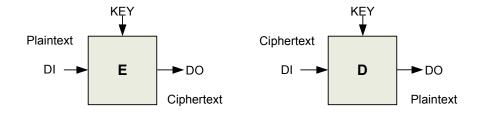


Figure 41. ECB - Electronic Code Book

8.1.2 CBC - Cipher Block Chaining

CBC adds a feedback mechanism to a block cipher. The result of the previous encryption operation is XOR'ed with incoming data. An initialization vector IV is used for the first iteration. CBC must use the last expanded key to decrypt. Decryption reverses encryption operations and is identical to the encryption function.

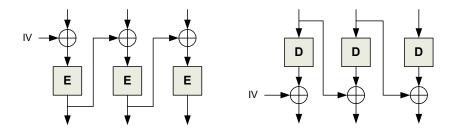


Figure 42. CBC - Cipher Block Chaining mode



8.1.3 CFB - Cipher FeedBack

In CFB the output of an encryption operation is fed back to the input of the AES block. An initialization vector IV is used for the first iteration. Input data is encrypted by XORing it with the output of the encryption module. Decryption reverses encryption operations and is identical to the encryption function.

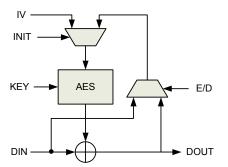


Figure 43. CFB - Cipher FeedBack mode

8.1.4 OFB – Output FeedBack mode

In OFB the output of an encryption operation is fed back to the input of the AES core. An initialization vector IV is used for the first iteration. Input data is encrypted by XORing it with the output of the encryption module. Decryption reverses encryption operations and is identical to the encryption function.

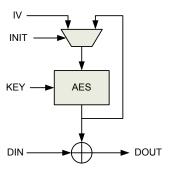


Figure 44. OFB - Output FeedBack mode

8.1.5 CTR – Counter mode

In CTR the output of a counter is the input of the AES core. When entering CTR mode, an initialization vector IV is used to initialize the counter. Input data is encrypted by XORing it with the output of the encryption module. Decryption reverses encryption operations and is identical to the encryption function.



Note: The counter cannot be reinitialized without changing mode.

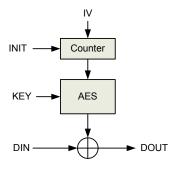


Figure 45. CTR - Counter mode

8.2 Functional description

The MCU initializes the AES block with key (AESKIN) and optionally the initialization vector (AESIV). Then the MCU loads a 128-bit block into AESD, selects mode and starts the operation with AESCS.

When the result is ready, the AESIRQ is asserted and the MCU reads out the AESD register. Alternatively, the AESCSgo can be polled instead of using interrupts.

Address	Reset value	Bit	Name	Description
0xE8	0x00	7:5	-	Not used
		4:2	mode	Type of AES encryption/decryption
				000: CBC, 001: CFB, 010: OFB, 011: CTR, 100: ECB
		1	decr	0: Encrypt, 1: Decrypt
		0	go	Set by SW to '1' to start operation. SW can poll this signal to
				check if AES block is busy. Automatically reset by HW when
				operation is completed. An encrypt or decrypt operation takes
				about 45 Cclk cycles.

Table 66. AESCS register

The AESKIN, AESIV and AESD are 128-bit registers. In order to update or read one of these registers, 16 consecutive write (or read) operations to a single register are required.

The order of writing (or reading) to update a register in nRF24LU1+ OTP begins with the last (16th) operation and works back to the first.



AES data sets are normally organized in two dimensional arrays (ai,j):

a0,0	a0,1	a0,2	a0,3
a1,0	a1,1	a1,2	a1,3
a2,0	a2,1	a2,2	a2,3
a3,0	a3,1	a3,2	a3,3

Table 67. A two dimensional array

The array position to write to is decided by AESIA1 which contains two 4 bit pointers for the AESKIN register and the AESIV register. These pointers are incremented by each read/write to AESKIN or AESIV. After 16 reads/writes, the pointers wrap around to the starting value.

The relation of the byte pointer address n and the position in the AES array (ai,j) is given by the following definition:

$$i = n \mod 4$$
; $j = [n / 4]$; $n = 15 - i - 4 * j$

The relationship between the byte pointer address and the AES array position in nRF24LU1+ OTP is shown in <u>Table 68</u>. below:

n = 15	n = 11	n = 7	n = 3
n = 14	n = 10	n = 6	n = 2
n = 13	n = 9	n = 5	n = 1
n = 12	n = 8	n = 4	n = 0

Table 68. Relation between the byte pointer address and AES data array

Address	Reset value	Bit	R/W	Description
0xF1	0x00	7:0	RW	AESKIN
0xF2	0x00	7:0	RW	AESIV
0xF3	0x00	7:0	RW	AESD

Table 69. AESKIN, AESIV and AESD registers

A partial update can be done by using the AESIA1 or AESIA2 registers (see <u>Table 70.</u> and <u>Table 71.</u>).

By setting AESIA1 a single byte or a smaller block can be updated.

	Address	Reset value	Bit	Name	Description
Ī	0xF5	0x00	7:4	ia_kin	AESKIN byte pointer address
			3:0	ia_iv	AESIV byte pointer address

Table 70. AESIA1 register

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The AESIA2 works like AESIA1, but only contains a 4-bit pointer for AESD.

Addres	s Reset value	Bit	Name	Description
0xF6	0x00	7:4	-	not used
		3:0	ia_data	AESD byte pointer address

Table 71. AESIA2 register



9 SPI master

The system features a simple single buffered SPI (Serial Peripheral Interface) master working in mode 0, that is, capture MISO on rising SCK, and changing MOSI on falling SCK.

The SPI bus (MMISO, MSCK and MMOSI) are available at the programmable digital I/O. The SPI hardware does not generate any chip select signal. Another programmable digital I/O must be used to act as chip selects for one or more external SPI devices, see <u>Table 98. on page 117</u> for details.

9.1 Block diagram

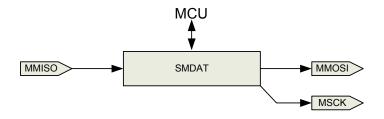


Figure 46. Master SPI block diagram

9.2 Functional description

The SPI hardware is controlled by SFR registers SMDAT and SMCTRL.

Address	Reset value	Bit	R/W	Function
0xB2	0x00		R/W	SPI data input/output

Table 72. SMDAT register

Address	Reset value	Bit	R/W	Function
0xB3	0x00	7:5	-	Not used
		4	RW	00: disable, 01: enable
		3:0	RW	Divider factor from MCU clock (Cclk) to SPI clock fre-
				quency
				0000: 1/2 of Cclk frequency
				0001: 1/2 of Cclk frequency
				0010: 1/4 of Cclk frequency
				0011: 1/8 of Cclk frequency
				0100: 1/16 of Cclk frequency
				0101: 1/32 of Cclk frequency
				0110: 1/64 of Cclk frequency
				other: 1/64 of Cclk frequency

Table 73. SMCTRL register.



9.3 SPI operation

A sequence of 8 pulses is started on MSCK every time you write to the SMDAT register. Also, the 8 bits of SMDAT register are clocked out on MMOSI with MSB clocking out first. Simultaneously, 8 bits from MMISO are clocked into SMDAT register. Output data is shifted on the negative edge of MSCK, and input data is read on the positive edge of MSCK. This is illustrated in Figure 47.

When the 8 bits from MMISO are finished, MSDONE interrupt goes active, and the 8 bits from MMISO can be read from SMDAT register. The interrupt bit must be cleared, by writing to SMDAT register again, before starting another SPI transaction.

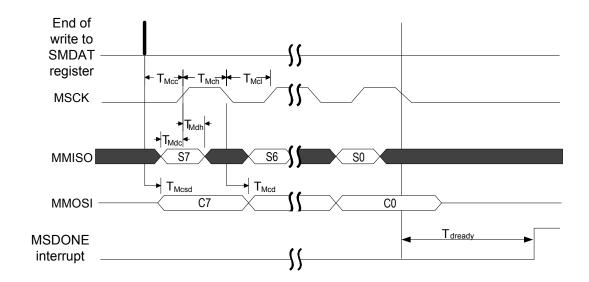


Figure 47. Master SPI timing

Value	Description
T _{Msck} = T _{Mch} +	SCK cycle time, as defined by SMCTRL register.
T _{Mcl}	
T _{Mcc}	Time from writing to SMDAT register to first MSCK pulse, T _{Msck} / 2.
T _{Mcd}	Delay from negative edge of MSCK to new MMOSI output data, may vary
	from -10ns to +10ns.
T _{Mdc}	MMISO setup time to positive edge of MSCK, T _{Mdc} > 45ns.
T _{Mdh}	MMISO hold time to positive edge of MSCK, T _{Mdh} > 0ns.
Tdready	Time from last MSCK pulse to MSDONE interrupt goes active. 7 MCU clock
	cycles.

Conditions: Output load= 10pF, MMISO rise/fall time=5ns.

Table 74. Master SPI timing values

Minimum time between two consecutive SPI transactions is: $8.5 \, T_{Msck} + Tdready + Tsw$ where Tsw is the time taken by the software to process MSDONE interrupt and write to SMDAT register.



10 SPI slave

The system features a simple single buffered SPI (Serial Programmable Interface) slave working in mode 0, that is, capturing SMOSI on rising SSCK, and changing SMISO on falling SSCK.

The slave SPI monitors the SCSN, SMOSI and SSCK pins, and controls the SMISO pin. They are available on P0.0 to P0.3, see chapter 13 on page 116 for details. The SPI slave may also be used for OTP programming when PROG=1. See section 17.6 on page 140.

10.1 Block diagram

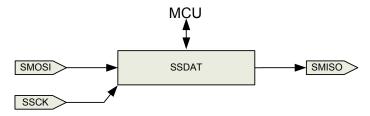


Figure 48. Slave SPI block diagram

10.2 Functional description

The following registers control the slave SPI.

Address	Reset value	Bit	R/W	Function
0xBC	0x00	7:6	-	Not used
		5	RW	1: Disable interrupt when SCSN goes high
		4	RW	1: Disable interrupt when SCSN goes low
		3	RW	1: Disable slave SPI interrupts
		2:1	-	Not used
		0	RW	1: Enable slave SPI

Table 75. SSCONF register

Address	Reset value	Bit	R/W	Function
0xBE	0x00	7:3	-	Not used
		2	R	1: Interrupt caused by positive edge of SCSN
		1	R	1: Interrupt caused by negative edge of SCSN
		0	R	1: Interrupt caused by data-byte sent or received ^a

a. If SPI is polled (no interrupts), then IRCON[2] (see <u>chapter 22.4.4 on page 167</u>) should be polled, since reading SSSTAT clears the status-flags.

Table 76. SSSTAT register

Address	Reset value	Bit	R/W	Function
0xBD	0x00		RW	Data register

Table 77. SSDAT register



10.3 SPI timing

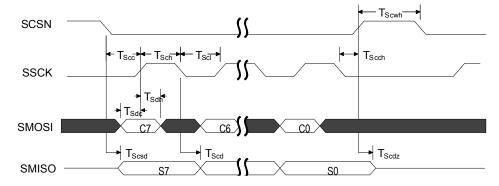


Figure 49. Slave SPI timing diagram

Parameter	Symbol	Min.	Max	Units
SMOSI to SSCK Setup	T _{Sdc}	5		ns
SSCK to SMOSI Hold	T _{Sdh}	2		ns
SCSN to SMISO Active	T _{Scsd}		35	ns
SSCK to SMISO Valid	T _{Scd}		42	ns
SSCK Low Time	T _{Scl}	50		ns
SSCK High Time	T _{Sch}	50		ns
SSCK Frequency	F _{SSCK}	0	8	MHz
SCSN to SSCK Setup	T _{Scc}	8		ns
SSCK to SCSN Hold	T _{Scch}	2		ns
SCSN inactive time	T _{Scwh}	130		ns
SCSN to SMISO High Z	T _{Scdz}		25	ns

Conditions: SMISO load= 10pF, SSCK rise/fall time=2ns, other inputs rise/fall time=5ns.

Table 78. Slave SPI timing parameters



11 Timer/Counters

The nRF24LU1+ OTP contains a set of counters used for timing up important system events.

11.1 Features

nRF24LU1+ OTP includes the following set of timers/counters:

- Three 16-bit timers/counters (Timer 0, Timer 1 and Timer 2) which can operate as either a timer with a clock rate based on the MCU clock, or as an event counter clocked by signals from the programmable digital I/O.
- In addition there is a RTC2 wakeup timer which is described in section 19.3.3 on page 154.

11.2 Block diagram

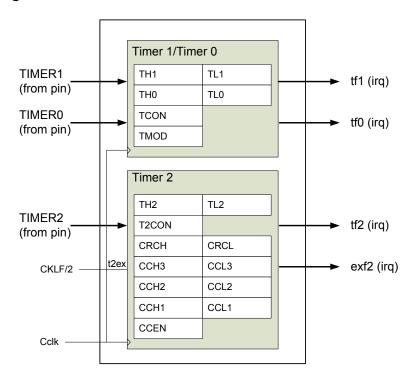


Figure 50. Block diagram of timers/counters

11.3 Functional description

11.3.1 Timer 0 and Timer 1

In timer mode, Timer 0/1 is incremented every 12 clock cycles.

In the counter mode, the Timers 1 and 0 are incremented when the falling edge is detected at the corresponding input pin T0 for Timer 0, or T1 for Timer 1.

Note: Timer input pins TO, T1, and T2 must be configured as described in section 13.2 on page 118.



Since it takes two clock cycles to recognize a 1-to-0 event, the maximum input count rate is ½ of the oscillator frequency. There are no restrictions on the duty cycle, however to ensure proper recognition of 0 or 1 state, an input should be stable for at least 1 clock cycle.

Timer 0 and Timer 1 status and control are in TCON and TMOD register. The actual 16-bit Timer 0 value is in THO (8 msb) and TLO (8 lsb), while Timer 1 use TH1 and TL1.

Four operating modes can be selected for Timer 0 and Timer 1. Two Special Function Registers, TMOD and TCON, are used to select the appropriate mode.

11.3.1.1 Mode 0 and Mode 1

In mode 0, Timer 0 and Timer 1 are configured as 13-bit registers (TL0/TL1 = 5 bits, TH0/TH1 = 8 bits). The upper three bits of TL0/TL1 are unchanged and should be ignored. In mode 1 Timer 0 and Timer 1 are configured as 16-bit registers.

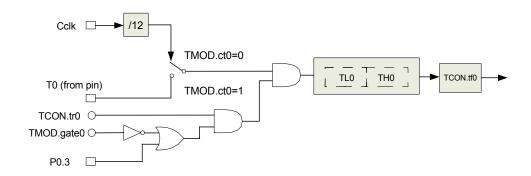


Figure 51. Timer 0 in mode 0 and 1

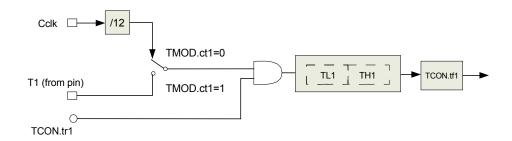


Figure 52. Timer 1 in mode 0 and 1



11.3.1.2 Mode 2

In this mode, Timer 0 and Timer 1 are configured as 8-bit registers with auto reload.

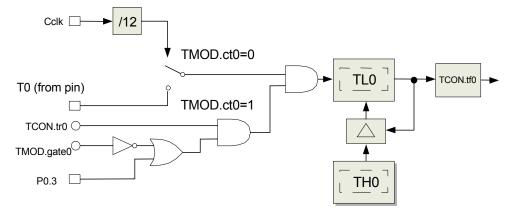


Figure 53. Timer 0 in mode 2

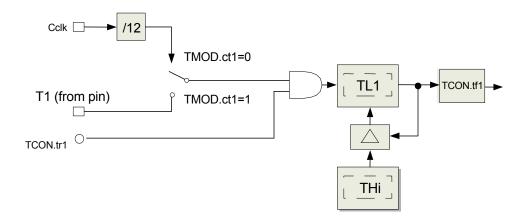


Figure 54. Timer 1 in mode 2



11.3.1.3 Mode 3

In mode 3 Timer 0 and Timer 1 are configured as one 8-bit timer/counter and one 8-bit timer, but timer 1 in this mode holds its count. When Timer 0 works in mode 3 Timer 1 can still be used in other modes by the serial port as a baud rate generator, or as an application not requiring an interrupt from Timer 1.

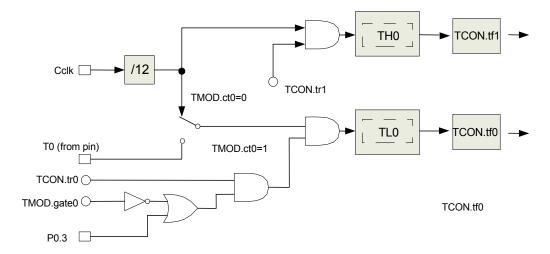


Figure 55. Timer 0 in mode 3

11.3.2 Timer 2

Timer 2 is controlled by T2CON while the value is in TH2 and TL2. Timer 2 also has four capture and one compare/reload registers which can read a value without pausing or reload a new 16-bit value when Timer 2 reaches zero, see <u>chapter 11.4.7 on page 110</u> and <u>chapter 11.4.8 on page 110</u>.

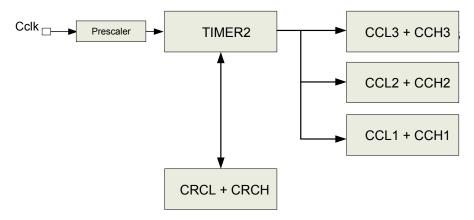


Figure 56. Timer 2 block diagram



11.3.2.1 Timer 2 description

Timer 2 can operate as a timer, event counter, or gated timer.

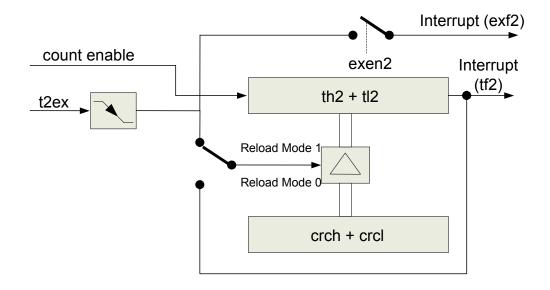


Figure 57. Timer 2 in Reload Mode

11.3.2.2 Timer mode

Timer mode is invoked by setting the t2i0=1 and t2i1=0 in the T2CON register. In this mode, the count rate is derived from the clk input.

Timer 2 is incremented every 12 or 24 clock cycles depending on the 2:1 prescaler. The prescaler mode is selected by bit t2ps of ${\tt T2CON}$ register. When t2ps=0, the timer counts up every 12 clock cycles, otherwise every 24 cycles.

11.3.2.3 Event counter mode

This mode is invoked by setting the t2i0=0 and t2i1=1 in the T2CON register.

In this mode, Timer 2 is incremented when external signal T2 (P0.5) (see section 13.2 on page 118 for more information on T2) changes its value from 1 to 0. The T2 input is sampled at every rising edge of the clock. Timer 2 is incremented in the cycle following the one in which the transition was detected. The maximum count rate is $\frac{1}{2}$ of the clock frequency.

11.3.2.4 Gated timer mode

This mode is invoked by setting the t2i0=1 and t2i1=1 in the T2CON register.

In this mode, Timer 2 is incremented every 12 or 24 clock cycles (depending on T2CON t2ps flag). Additionally, it is gated by the external signal T2 (P0.5). When T2=0, Timer 2 is stopped.



11.3.2.5 Timer 2 reload

A 16-bit reload from the CRC register can be done in two modes:

- Reload Mode 0: Reload signal is generated by Timer 2 overflow (auto reload).
- Reload Mode 1: Reload signal is generated by negative transition at t2ex.

Note: t2ex is connected to an internal clock signal which is half frequency of CKLF (see <u>section 19.3.1 on page 154</u>.

11.4 SFR registers

11.4.1 Timer/Counter control register – TCON

TCON register reflects the current status of MCU Timer 0 and Timer 1 and it is used to control the operation of these modules.

Address	Reset value	Bit	Name	Auto clear	Description
0x88	0x00	7	tf1	Yes	Timer 1 overflow flag. Set by hardware when Timer1 over-
					flows.
		6	tr1	No	Timer 1 Run control. If cleared, Timer 1 stops.
		5	tf0	Yes	Timer 0 overflow flag. Set by hardware when Timer 0 over-
					flows.
		4	tr0	No	Timer 0 Run control. If cleared, Timer 0 stops.
		3	ie1	Yes	External interrupt 1 flag. Set by hardware.
		2	it1	No	External interrupt 1 type control. 1: falling edge, 0: low level
		1	ie0	Yes	External interrupt 0 flag. Set by hardware.
		0	it0	No	External interrupt 0 type control. 1: falling edge, 0: low level

Table 79. TCON register

The tf0, tf1 (timer 0 and timer 1 overflow flags), ie0 and ie1 (external interrupt 0 and 1 flags) are automatically cleared by hardware when the corresponding service routine is called.



11.4.2 Timer mode register - TMOD

TMOD register is used for configuration of Timer 0 and Timer1.

Address	Reset value	Bit	Name	Description
0x89	0x00	7	reserved	Must be 0
		6	ct1	Timer 1 counter/timer select. 1: Counter, 0: Timer
		5-4	mode1	Timer 1 mode
				00 – Mode 0: 13-bit counter/timer
				01 – Mode 1: 16-bit counter/timer
				10 – Mode 2: 8-bit auto-reload timer
				11 – Mode 3: Timer 1 stopped
		3	gate0	Timer 0 gate control
		2	ct0	Timer 0 counter/timer select. 1: Counter, 0: Timer
		1-0	mode0	Timer 0 mode
				00 – Mode 0: 13-bit counter/timer
				01 – Mode 1: 16-bit counter/timer
				10 – Mode 2: 8-bit auto-reload timer
				11 – Mode 3: two 8-bit timers/counters

Table 80. TMOD register

11.4.3 Timer0 - TH0, TL0

Address	Register name
A8x0	TL0
0x8C	TH0

Table 81. Timer 0 register (TH0:TL0)

These registers reflect the state of Timer 0. TH0 holds higher byte and TL0 holds lower byte. Timer 0 can be configured to operate as either a timer or a counter.

11.4.4 Timer1 - TH1, TL1

Address	Register name
0x8B	TL1
0x8D	TH1

Table 82. Timer 1 register (TH1:TL1)

These registers reflect the state of Timer 1. TH1 holds higher byte and TL1 holds lower byte. Timer 1 can be configured to operate as either timer or counter.



11.4.5 Timer 2 control register – T2CON

T2CON register reflects the current status of Timer 2 and is used to control the Timer 2 operation.

Address	Reset value	Bit	Name	Description				
0xC8	0x00	7	t2ps	Prescaler select. 0: timer 2 is clocked with 1/12 of the Cclk frequency.				
				: timer 2 is clocked with 1/24 of the Cclk frequency.				
		6	i3fr	NT3 edge select. 0: falling edge, 1: rising edge				
		5	i2fr	NT2 edge select: 0: falling edge, 1: rising edge				
		4:3	t2r	imer 2 reload mode. 0X – reload disabled, 10 – Mode 0, 11 – Mode 1				
		2	t2cm	imer 2 compare mode. 0: Mode 0, 1: Mode 1				
		1-0	t2i	Timer 2 input select. 00: stopped, 01: f/12 or f/24, 10: falling edge of t2,				
				11: f/12 or f/24 gated by t2.				

Table 83. T2CON register

11.4.6 Timer 2 – TH2, TL2

Address	Register name
0xCC	TL2
0xCD	TH2

Table 84. Timer 2 (TH2:TL2)

The TL2 and TH2 registers reflect the state of Timer 2. TH2 holds higher byte and TL2 holds lower byte. Timer 2 can be configured to operate in compare, capture or, reload modes.



11.4.7 Compare/Capture enable register – CCEN

The CCEN register serves as a configuration register for the Compare/Capture Unit associated with the Timer 2.

Address	Reset value	Bit	Name	Description	
0xC1	0x00	7:6	coca3	compare/capture mode for CC3 register	
				00: compare/capture disabled	
				01: reserved	
				10: reserved	
				11: capture on write operation into register CCL3	
		5:4	coca2	compare/capture mode for CC2 register	
				00: compare/capture disabled	
				01: reserved	
				10: reserved	
				11: capture on write operation into register CCL2	
		3:2	coca1	compare/capture mode for CC1 register	
				00: compare/capture disabled	
				01: reserved	
				10: reserved	
				11: capture on write operation into register CCL1	
		1:0	coca0	compare/capture mode for CRC register	
				00: compare/capture disabled	
				01: reserved	
				10: reserved	
				11: capture on write operation into register CRCL	

Table 85. CCEN register

11.4.8 Capture registers – CC1, CC2, CC3

The Compare/Capture registers (CC1, CC2, CC3) are 16-bit registers used by the Compare/Capture Unit associated with the Timer 2. CCHn holds higher byte and CCLn holds lower byte of the CCn register.

Address	Register name
0xC2	CCL1
0xC3	CCH1
0xC4	CCL2
0xC5	CCH2
0xC6	CCL3
0xC7	CCH3

Table 86. Capture Registers - CC1, CC2 and CC3



11.4.9 Compare/Reload/Capture register – CRCH, CRCL

Address	Reset value	Register name		
0xCA	0x00	CRCL		
0xCB	0x00	CRCH		

Table 87. Compare/Reload/Capture register - CRCH, CRCL

CRC (Compare/Reload/Capture) register is a 16-bit wide register used by the Compare/Capture Unit associated with Timer 2. CRCH holds higher byte and CRCL holds lower byte.



12 Serial Port (UART)

The MCU system is configured with one serial port that is identical in operation to the standard 8051 serial port (Serial interface 0). The two serial port signals RXD and TXD are available at the programmable digital I/O. See Chapter 13 on page 116.

The serial port (UART) derives its clock from the MCU clock; Cclk. See <u>chapter 20.4.1 on page 160</u> for more information.

12.1 Features

- Synchronous mode, fixed baud rate
- · 8-bit UART mode, variable baud rate
- 9-bit UART mode, variable baud rate
- 9-bit UART mode, fixed baud rate
- Additional baud rate generator

12.2 Block diagram

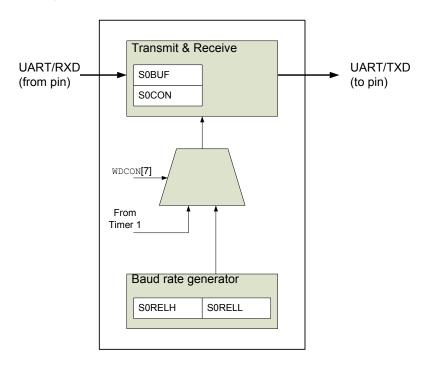


Figure 58. Block diagram of serial port

12.3 Functional description

The serial port is controlled by SOCON, while the actual data transferred is read or written in the SOBUF register. Transmission speed (baud rate) is selected using the SORELL, SORELH and WDCON registers.



12.4 SFR registers

12.4.1 Serial Port 0 control register – S0CON

The SOCON register controls the function of Serial Port 0.

Address	Reset value	Bit	Name	Description				
0x98	0x00	7:6	sm0:	Serial Port 0 mode select				
			sm1	0 0: Mode 0 – Shift register at baud rate Cclk / 12				
				0 1: Mode 1 – 8-bit UART. Baud rate see Figure 59. on page 114				
				1 0: Mode 2 – 9-bit UART at baud rate Cclk /32 or Cclk/64 ^a				
				1 1: Mode 3 – 9 bit UART. Baud rate see Figure 59. on page 114				
		5	sm20	Multiprocessor communication enable				
		4	ren0	Serial reception enable: 1: Enable Serial Port 0.				
		3	tb80	Transmitter bit 8. This bit is used while transmitting data through				
				Serial Port 0 in Modes 2 and 3. The state of this bit corresponds with				
				the state of the 9th transmitted bit (for example, parity check or multi-				
				processor communication). It is controlled by software.				
		2	rb80	Received bit 8. This bit is used while receiving data through Serial				
				Port 0 in Modes 2 and 3. It reflects the state of the 9th received bit.				
		1	ti0	Transmit interrupt flag. It indicates completion of a serial transmission				
				at Serial Port 0. It is set by hardware at the end of bit 8 in mode 0 or				
				at the beginning of a stop bit in other modes. It must be cleared by				
				software.				
		0	ri0	Receive interrupt flag. It is set by hardware after completion of a				
				serial reception at Serial Port 0. It is set by hardware at the end of bit				
				8 in mode 0 or in the middle of a stop bit in other modes. It must be				
				cleared by software.				

a. If smod = 0 baud rate is Cclk/64, if smod = 1 then baud rate is Cclk/32.

Table 88. S0CON register

<u>Table 89. on page 113</u> shows register settings for some common UART baud rates.

Baud rate	Cclk	SMOD	s0rel
600	16 MHz	1	0x00BF
1200	16 MHz	1	0x025F
2400	16 MHz	1	0x0330
4800	16 MHz	1	0x0398
9600	16 MHz	1	0x03CC
19200	16 MHz	1	0X03E6
38400	16 MHz	1	0X03f3

Table 89. Register settings for selected baud rates using internal baud rate generator (wdcon[7]=1)

To configure other baud rates, please use the formulas in <u>Figure 59. on page 114</u> where the baud rate for Mode 1 or Mode 3 is:



for bd (wdcon
$$[7]$$
) = 0:

baud rate =
$$\frac{2^{smod} * Cclk}{32} * (Timer1 overflow rate)$$

baud rate =
$$\frac{2^{smod} * Cclk}{64 * (2^{10} - s0rel)}$$

Figure 59. Equation of baud rate settings for Serial Port 0



Below is an explanation of some of the values used in Figure 59. :

Value	Definition
smod (PCON[7])	Serial Port 0 baud rate select flag
s0rel	The contents of S0REL registers (s0relh, s0rell) see chapter 12.4.3 on
	<u>page 115</u> .
bd (wdcon[7])	The MSB of WDCON register see chapter 12.4.4 on page 115

Table 90. Values of S0CON equation

12.4.2 Serial port 0 data buffer – S0BUF

Address	Reset value	Register name
0x99	0x00	SOBUF

Table 91. S0BUF register

Writing data to the SOBUF register sets data in serial output buffer and starts the transmission through Serial Port 0. Reading from the SOBUF reads data from the serial receive buffer.

12.4.3 Serial port 0 reload register – S0RELH, S0RELL

Serial Port 0 Reload register is used for Serial Port 0 baud rate generation. Only 10 bits are used, 8 bits from the SORELL, and 2 bits from the SORELH.

Address	Reset value	Register name
0xAA	0xD9	SORELL
0xBA	0x03	SORELH

Table 92. SORELL/SORELH register

12.4.4 Serial Port 0 baud rate select register - WDCON

The MSB of this register is used by Serial Port 0 for baud rate generation

Address	Reset value	Bit	Name	· ·	
0xD8	0x00	7	bd	Serial Port 0 baud rate select (in modes 1 and 3) When 1, additional internal baud rate generator is used, otherwise Timer 1 overflow is used. ^a	
		6-0		Not used	

Table 93. WDCON register

a. It is not recommended to use Timer1 overflow as baud generator.



13 Input/Output port (GPIO)

Six general purpose I/O lines are available on the nRF24LU1+ OTP. These can be used for general I/O with selectable direction for each bit, or these lines can be used for specialized functions.

13.1 Normal IO

When PROG=0, the GPIO pins are controlled by the registers POALT, PODIR and POEXP, when PROG=1 the GPIO pins are configured as a slave SPI port, see pins SCSN, SMISO,SMOSI, SSCK below. The POALT register selects between the default and the alternate functions for each of the six port pins when POEXP=0. If POALT=0 then the default function is selected, port data is set with the PO register, and pin direction is set with PODIR register.

Address	Reset value	bit7	bit6	bit5	bit4	bit3	bit2	bit1	bbit0
0x80	0xFF	-	-	D5	D4	D3	D2	D1	D0

Table 94. P0 register

Address	Reset value	Bit	Description
0x94	0xFF	7:6	Not used
		5:0	0: P0.x is output, 1: P0.x is input

Table 95. P0DIR register

The POALT and POEXP registers are used to select alternate or expanded functions, see <u>Table 98. on page</u> 117 for details.

Address	Reset value	Bit	Description
0x95	0x00	7:6	Not used
		5:0	1: Alternate function, 0: General I/O, see <u>Table 99. on page 118</u>

Table 96. POALT register

Address	Reset value	Bit	Description
0xC9	0x00	7:6	Controls P0.5
		5:4	Controls P0.4
		3:2	Not used
		1:0	Controls P0.3-P0.0, see <u>Table 99. on page 118</u> for details

Table 97. P0EXP register

The relationship between the POEXP and POALT registers is shown in Table 98. on page 117.



	No	rmal				
Pin	Default function	Alternate	Expanded 1	Expanded 2	Expanded 3	
			POEXP[7			
		00	01	10	11	
		ALT[5]		P0ALT [5]		
	0	1		Х		
P0.5	D5	T0 (timer0	T2 (timer2 input)			
		input)				
			P0EXP[5	-		
	00		01	10	11	
		ALT[4]	POALT[4]			
		0 1 x				
P0.4	D4		T1 (timer1 input)			
			POEXP[1			
		00	01	10	11	
		POALT[3:0] POALT[3:0]				
	0	1		X		
P0.3	D3	INT0 (inter-	P0.3 ^a	SCSN		
		rupt)		0		
P0.2	D2	TXD (UART)	MMISO	SMISO		
P0.1	D1	RXD (UART)	MMOSI	SMOSI		
P0.0	D0	GTIMER ^b	MSCK	SSCK		

a. Configured as output, typically used for Master SPI, see chapter 9 on page 98.

Table 98. Port functions

b. GTIMER is an RTC output controlled by WGTIMER, see chapter 19.3.6 on page 155.



13.2 Expanded IO

The combined effect of the POALT and POEXP register is shown in <u>Table 99</u>. on page 118. The content of both POALT and POEXP is shown in binary. An 'X' in Table 104 means that the bit can both be '0' or '1'.

P0ALT	P0EXP	P0.5	P0.4	P0.3	P0.2	P0.1	P0.0
00000000	00000000	D5	D4	D3	D2	D1	D0
001XXXXX	00XXXXXX	T0 ^a					
001XXXXX	01XXXXXX	T2 ^b					
00X1XXXX	XXX00XXXX						
00X1XXXX	XX01XXXX		T1 ^c				
00X1XXXX	XX11XXXX						
00XX1XXX	XXXXXX00			INT0 ^d			
00XX1XXX	XXXXXXX01			MCSN			
00XX1XXX	XXXXXX10			SCSN			
00XX1XXX	XXXXXXX11						
00XXX1XX	XXXXXX00				TXD		
00XXX1XX	XXXXXXX01				MMISO		
00XXX1XX	XXXXXX10				SMISO		
00XXX1XX	XXXXXXX11						
00XXXX1X	XXXXXX00					RXD	
00XXXX1X	XXXXXXX01					MMOSI	
00XXXX1X	XXXXXX10					SMOSI	
00XXXX1X	XXXXXXX11						
00XXXXX1	XXXXXX00						GTIMER ^e
00XXXXX1	XXXXXXX01						MSCK
00XXXXX1	XXXXXX10						SSCK
00XXXXX1	XXXXXX11						

- a. Timer0 input
- b. Timer2 input
- c. Timer1 input
- d. Interrupt input INT0
- e. GTIMER is an RTC output controlled by WGTIMER, see chapter 19.3.6 on page 155.

Table 99. Alternative functions of Port 0



14 MCU

The nRF24LU1+ OTP contains a fast 8-bit MCU, which executes the normal 8051 instruction set.

The architecture eliminates redundant bus states and implements parallel execution of fetch and execution phases. Most of the one-byte instructions are performed in one single cycle. The MCU uses 1 clock per cycle. This leads to a performance improvement rate of 8.0 (in terms of MIPS) with respect to legacy 8051 devices.

The original 8051 had a 12-clock architecture. A machine cycle needed 12 clocks and most instructions were either one or two machine cycles. Except for MUL and DIV instructions, the 8051 used either 12 or 24 clocks for each instruction. Each cycle in the 8051 also used two memory fetches. In many cases, the second fetch was a dummy, and extra clocks were wasted.

<u>Table 100.</u> shows the speed advantage compared to a legacy 8051. A speed advantage of 12 implies that the instruction is executed twelve times faster. The average speed advantage is 8.0. However, the real speed improvement seen in any system depends on the instruction mix.

Speed advantage	Number of instructions	Number of opcodes
24	1	1
12	27	83
9.6	2	2
8	16	38
6	44	89
4.8	1	2
4	18	31
3	2	9
Average: 8.0	Sum: 111	Sum: 255

Table 100. Speed advantage summary

14.1 Features

- Control Unit
 - ▶ 8-bit Instruction decoder
 - ▶ Reduced instruction cycle time (up to 12 times in respect to standard 80C51)
- Arithmetic-Logic Unit
 - ▶ 8-bit arithmetic and logical operations
 - ▶ Boolean manipulations
 - ▶ 8 x 8 bit multiplication and 8 / 8 bit division
- Multiplication-Division Unit
 - ▶ 16 x 16 bit multiplication
 - ▶ 32 / 16 bit and 16 / 16 bit division
 - ▶ 32-bit normalization
 - ▶ 32-bit L/R shifting
- Three 16-bit Timers/Counters
 - ▶ 80C51-like Timer 0 & 1
 - ▶ 80515-like Timer 2
- Compare/Capture Unit, dedicated to Timer 2
 - ▶ Four 16-bit Compare registers used for Pulse Width Modulation
 - ▶ Four external Capture inputs used for Pulse Width Measuring
 - ▶ 16-bit Reload register used for Pulse Generation



- Full Duplex Serial Interfaces
 - ► Serial 0 (80C51-like)
 - ▶ Synchronous mode, fixed baud rate
 - ▶ 8-bit UART mode, variable baud rate
 - ▶ 9-bit UART mode, fixed baud rate
 - ▶ 9-bit UART mode, variable baud rate
 - ▶ Baud Rate Generator
- Interrupt Controller
 - ▶ Four Priority Levels with 13 interrupt sources
- Memory interface
 - ▶ addresses up to 64 kB of External Program/Data Memory
 - ▶ Dual Data Pointer for fast data block transfer

14.2 Block diagram

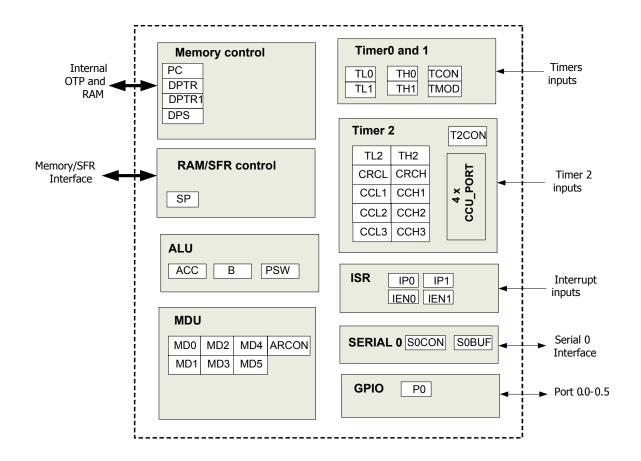


Figure 60. MCU block diagram



14.3 Arithmetic Logic Unit (ALU)

The Arithmetic Logic Unit (ALU) provides 8-bit division, 8-bit multiplication, and 8-bit addition with or without carry. The ALU also provides 8-bit subtraction with borrow and some bitwise logic operations, that is, logical AND, OR, Exclusive OR or NOT.

All operations are unsigned integer operations. Additionally, the ALU can increment or decrement 8 bit registers. For accumulator only, it can rotate left or right through carry or not, swap nibbles, clear or complement bits and perform a decimal adjustment.

The ALU is handled by three registers, which are memory mapped as special function registers. Operands for operations may come from accumulator ACC, register B or from outside of the unit. The result may be stored in accumulator ACC or may be driven outside of the unit. The control register, that contains flags such as carry, overflow or parity, is the PSW (Program Status Word) register.

The nRF24LU1+ OTP also contains an on-chip co-processor MDU (Multiplication Division Unit). This unit enables 32-bit division, 16-bit multiplication, shift and normalize operations, see chapter 18 on page 149 for details.

14.4 Instruction set summary

All instructions are binary code compatible and perform the same functions as they do within the legacy 8051 processor. The following tables give a summary of instruction cycles of the MCU core.

Mnemonic	Description	Code	Bytes	Cycles
ADD A,Rn	Add register to accumulator	0x28-0x2F	-	1
	Add directly addressed data to accumulator	0x25	2	2
ADD A,@Ri	Add indirectly addressed data to accumulator	0x26-0x27	1	2
ADD A,#data	Add immediate data to accumulator	0x24	2	2
	Add register to accumulator with carry	0x38-0x3F	1	1
	Add directly addressed data to accumulator with carry	0x35	2	2
ADDC A,@Ri	Add indirectly addressed data to accumulator with carry	0x36-0x37	1	2
ADDC A,#data	Add immediate data to accumulator with carry	0x34	2	2
SUBB A,Rn	Subtract register from accumulator with borrow	0x98-0x9F	1	1
SUBB A, direct	Subtract directly addressed data from accumulator with bor-	0x95	2	2
	row			
SUBB A, @Ri	Subtract indirectly addressed data from accumulator with bor-	0x96-0x97	1	2
	row			
SUBB A, #data	Subtract immediate data from accumulator with borrow	0x94	2	2
INC A	Increment accumulator	0x04	1	1
INC Rn	Increment register	0x08-0x0F	1	2
INC direct	Increment directly addressed location	0x05	2	3
INC @Ri	Increment indirectly addressed location	0x06-0x07	1	3
INC DPTR	Increment data pointer	0xA3	1	1
DEC A	Decrement accumulator	0x14	1	1
DEC Rn	Decrement register	0x18-0x1F	1	2
DEC direct	Decrement directly addressed location	0x15	2	3
DEC @Ri	Decrement indirectly addressed location	0x16-0x17	1	3
MUL AB	Multiply A and B	0xA4	1	5
DIV	Divide A by B	0x84	1	5
DA A	Decimal adjust accumulator	0xD4	1	1

Table 101. Arithmetic operations



Mnemonic	Description	Code	Bytes	Cycles
ANL A, Rn	AND register to accumulator	0x58-0x5F	1	1
ANL A,direct	AND directly addressed data to accumulator	0x55	2	2
ANL A,@Ri	AND indirectly addressed data to accumulator	0x56-0x57	1	2
ANL A,#data	AND immediate data to accumulator	0x54	2	2
ANL direct,A	AND accumulator to directly addressed location	0x52	2	3
ANL	AND immediate data to directly addressed loca-	0x53	3	4
direct,#data	tion			
ORL A,Rn	OR register to accumulator	0x48-0x4F	1	1
ORL A,direct	OR directly addressed data to accumulator	0x45	2	2
ORL A,@Ri	OR indirectly addressed data to accumulator	0x46-0x47	1	2
ORL A,#data	OR immediate data to accumulator	0x44	2	2
ORL direct,A	OR accumulator to directly addressed location	0x42	2	3
ORL	OR immediate data to directly addressed loca-	0x43	3	4
direct,#data	tion			
XRL A,Rn	Exclusive OR register to accumulator	0x68-0x6F	1	1
XRL A, direct	Exclusive OR indirectly addressed data to accu-	0x66-0x67	1	2
	mulator			
XRL A,@Ri	Exclusive OR indirectly addressed data to accu-	0x66-0x67	1	2
	mulator			
XRL A,#data	Exclusive OR immediate data to accumulator	0x64	2	2
XRL direct,A	Exclusive OR accumulator to directly addressed	0x62	2	3
	location			
XRL	Exclusive OR immediate data to directly	0x63	3	4
direct,#data	addressed location			
CLR A	Clear accumulator	0xE4	1	1
CPL A	Complement accumulator	0xF4	1	1
RL A	Rotate accumulator left	0x23	1	1
RLC A	Rotate accumulator left through carry	0x33	1	1
RR A	Rotate accumulator right	0x03	1	1
RRC A	Rotate accumulator right through carry	0x13	1	1
SWAP A	Swap nibbles within the accumulator	0xC4	1	1

Table 102. Logic operations

Mnemonic	Description	Code	Bytes	Cycles
MOV A,Rn	Move register to accumulator	0xE8-0xEF	1	1
MOV A,direct	Move directly addressed data to accumulator	0xE5	2	2
MOV A,@Ri	Move indirectly addressed data to accumula-	0xE6-0xE7	1	2
	tor			
MOV A,#data	Move immediate data to accumulator	0x74	2	2
	Move accumulator to register	0xF8-0xFF	1	2
	Move directly addressed data to register	0xA8-0xAF	2	4
MOV Rn,#data	Move immediate data to register	0x78-0x7F	2	2
MOV direct,A	Move accumulator to direct	0xF5	2	3
MOV direct,Rn	Move register to direct	0x88-0x8F	2	3
MOV	Move directly addressed data to directly	0x85	3	4
directl,direct2	addressed location			
MOV	Move indirectly addressed data to directly	0x86-0x87	2	4
direct,@Ri	addressed location			



Mnemonic	Description	Code	Bytes	Cycles
MOV direct,#data	Move immediate data to directly addressed location	0x75	3	3
MOV @Ri,A	Move accumulator to indirectly addressed location	0xF6-0xF7	1	3
MOV @Ri,direct	Move directly addressed data to indirectly addressed location	0xA6-0xA7	2	5
MOV @Ri,#data	Move immediate data to indirectly addressed location	0x76-0x77	2	3
MOV DPTR,#datal6	Load data pointer with a 16-bit immediate	0x90	3	3
MOVC A,@A+DPTR	Load accumulator with a code byte relative to DPTR	0x93	1	3
MOVC A,@A+PC	Load accumulator with a code byte relative to PC	0x83	1	3
MOVX A,@Ri	Move external RAM (8-bit addr) to accumulator	0xE2-0xE3	1	3-10
MOVX A,@DPTR	Move external RAM (16-bit addr) to accumulator	0xE0	1	3-10
MOVX @Ri,A	Move accumulator to external RAM (8-bit addr)	0xF2-0xF3	1	4-11
MOVX @DPTR,A	Move accumulator to external RAM (16-bit addr)	0xF0	1	4-11
PUSH direct	Push directly addressed data onto stack	0xC0	2	4
POP direct	Pop directly addressed location from stack	0xD0	2	3
XCH A,Rn	Exchange register with accumulator	0xC8-0xCF	1	2
XCH A,direct	Exchange directly addressed location with accumulator	0xC5	2	3
XCH A,@Ri	Exchange indirect RAM with accumulator	0xC6-0xC7	1	3
XCHD A,@Ri	Exchange low-order nibbles of indirect and accumulator	0xD6-0xD7	1	3

Table 103. Data transfer operations

Mnemonic	Description	Code	Bytes	Cycles
ACALL addr11	Absolute subroutine call	xxx10001b	2	6
LCALL	Long subroutine call	0x12	3	6
addr16				
RET	Return from subroutine	0x22	1	4
RETI	Return from interrupt	0x32	1	4
AJMP addr11	Absolute jump	xxx00001b	2	3
LJMP addrl6	3, 1	0x02	3	4
SJMP rel	Short jump (relative address)	0x80	2	3
JMP	Jump indirect relative to the DPTR	0x73	1	2
@A+DPTR				
JZ rel	Jump if accumulator is zero	0x60	2	3
JNZ rel	Jump if accumulator is not zero	0x70	2	3
JC rel	Jump if carry flag is set	0x40	2	3
JNC rel	Jump if carry flag is not set	0x50	2	3
JB bit, rel	Jump if directly addressed bit is set	0x20	3	4
JNB bit, rel	Jump if directly addressed bit is not set	0x30	3	4
JBC bit, rel	Jump if directly addressed bit is set and clear bit	0x10	3	4

Mnemonic	Description	Code	Bytes	Cycles
CJNE A, direct,	Compare directly addressed data to accumulator	0xB5	3	4
rel	and jump if not equal			
CJNE	Compare immediate data to accumulator and	0xB4	3	4
A,#data,rel	jump if not equal			
CJNE Rn,	Compare immediate data to register and jump if	0xB8-0xBF	3	4
#data, rel	not equal			
CJNE @Ri,	Compare immediate data to indirect addressed	0xB6-B7	3	4
#data, rel	value and jump if not equal			
DJNZ Rn, rel	Decrement register and jump if not zero	0xD8-DF	2	3
DJNZ direct, rel	Decrement directly addressed location and jump	0xD5	3	4
	if not zero			
NOP	No operation	0x00	1	1

Table 104. Program branches

Mnemonic	Description	Code	Bytes	Cycles
CLR C	Clear carry flag	0xC3	1	1
CLR bit	Clear directly addressed bit	0xC2	2	3
SETB C	Set carry flag	0xD3	1	1
SETB bit	Set directly addressed bit	0xD2	2	3
CPL C	Complement carry flag	0xB3	1	1
CPL bit	Complement directly addressed bit	0xB2	2	3
ANL C,bit	AND directly addressed bit to carry flag	0x82	2	2
ANL C,/bit	AND complement of directly addressed bit to carry	0xB0	2	2
ORL C,bit	OR directly addressed bit to carry flag	0x72	2	2
ORL C,/bit	OR complement of directly addressed bit to carry	0xA0	2	2
MOV C,bit	Move directly addressed bit to carry flag	0xA2	2	2
MOV bit,C	Move carry flag to directly addressed bit	0x92	2	3

Table 105. Boolean manipulation



14.5 Opcode map

Opcode	Mnemonic	Opcode	Mnemonic	Opcode	Mnemonic
00H	NOP	56H	ANL A,@R0	ACH	MOV R4,direct
01H	AJMP addr11	57H	ANL A,@R1	ADH	MOV R5,direct
02H	JUMP addrl6	58H	ANL A,R0	AFH	MOV R6,direct
03H	RRA	59H	ANL A,R1	AFH	MOV R7,direct
04H	INCA	5AH	ANL A,R2	B0H	ANL C,/bit
05H	INC direct	5BH	ANL A,R3	B1H	ACALL addr11
06H	INC @R0	5CH	ANL A,R4	B2H	CPL bit
07H	INC @R1	5DH	ANL A,R5	B3H	CPLC
08H	INC R0	5EH	ANL A,R6	B4H	CJNE A,#data,rel
09H	INC R1	5FH	ANL A,R7	B5H	CJNE A, direct, rel
0AH	INC R2	60H	JZ rel	B6H	CJNE @R0,#data,rel
0BH	INC R3	61H	AJMP addr11	B7H	CJNE @R1, #data,rel
0CH	INC R4	62H	XRL direct, A	B8H	CJNE R0, #data,rel
0DH	INC R5	63H	XRL direct, #data	B9H	CJNE R1,#data,rel
0EH	INC R6	64H	XRL A, #data	BAH	CJNE R2,#data,rel
0FH	INC R7	65H	XRL A,direct	BBH	CJNE R3,#data,rel
10H	JBC bit, rel	66H	XRLA,@R0	BCH	CJNE R4,#data,rel
11H	ACALL addr11	67H	XRL A,@R1	BDH	CJNE R5,#data,rel
12H	LCALL add r16	68H	XRL A,R0	BEH	CJNE R6,#data,rel
13H	RRC A	69H	XRL A,R1	BFH	CJNE R7,#data,rel
14H	DEC A	6AH	XRL A,R2	C0H	PUSH direct
15H	DEC direct	6BH	XRL A,R3	C1H	AJMP addr11
16H	DEC @R0	6CH	XRL A,R4	C2H	CLR bit
17H	DEC @R1	6DH	XRL A,R5	C3H	CLR C
18H	DEC R0	6EH	XRL A,R6	C4H	SWAP A
19H	DEC R1	6FH	XRL A,R7	C5H	XCH A, direct
1AH	DEC R2	70H	JNZ rel	C6H	XCH A,@R0
1BH	DECR3	71H	ACALL addr11	C7H	XCH A,@R1
1CH	DECR4	72H	ORL C, bit	C8H	XCH A,R0
1DH	DECR5	73H	JMP @A+DPTR	C9H	XCH A,R1
1EH	DECR6	74H	MOV A, #data	CAH	XCH A,R2
1FH	DECR7	75H	MOV direct, #data	CBH	XCHA,R3
20H	JB bit, rel	76H	MOV @R0,#data	CCH	XCH A,R4
21H	AJMP addr11	77H	MOV @R1, #data	CDH	XCH A,R5
22H	RET	78H	MOV R0, #data	CEH	XCH A,R6
23H	RL A	79H	MOV R1, #data	CFH	XCHA,R7
24H	ADD A, #data	7AH	MOV R2, #data	D0H	POP direct
25H	ADD A, direct	7BH	MOV R3, #data	D1H	ACALL addr11
26H	ADD A,@R0	7CH	MOV R4, #data	D2H	SETB bit
27H	ADD A,@R1	7DH	MOV R5, #data	D3H	SETB C
28H	ADD A,R0	7EH	MOV R6, #data	D4H	DAA
29H	ADD A,R1	7FH	MOV R7, #data	D5H	DJNZ direct, rel
2AH	ADD A,R2	80H	SJMP rel	D6H	XCHDA,@R0
2BH	ADD A,R3	81H	AJMP addr11	D7H	XCHD A,@R1
2CH	ADD A,R4	82H	ANL C, bit	D8H	DJNZ R0,rel
2DH	ADD A,R5	83H	MOVC A,@A+PC	D9H	DJNZ R1,rel
2EH	ADD A,R6	84H	DIV AB	DAH	DJNZ R2,rel
2FH	ADD A,R7	85H	MOV direct, direct	DBH	DJNZ R3,rel
30H	JNB bit, rel	86H	MOV direct, @R0	DCH	DJNZ R4,rel
31H	ACALL addr11	87H	MOV direct,@R1	DDH	DJNZ R5,rel
0111	AUALL addi I I	0/11	IVIO V GIICCI, WITT	ווטט	D0142 130,161

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Opcode	Mnemonic	Opcode	Mnemonic	Opcode	Mnemonic
32H	RETI	88H	MOV direct,R0	DFH	DJNZ R6,rel
33H	RLC A	89H	MOV direct,R1	DFH	DJNZ R7,rel
34H	ADDC A,#data	8AH	MOV direct,R2	F0H	MOVX A,@DPTR
35H	ADDC A, direct	8BH	MOV direct,R3	F1H	AJMP addr11
36H	ADDC A,@R0	8CH	MOV direct,R4	E2H	MOVX A,@R0
37H	ADDC A,@R1	8DH	MOV direct, R5	F3H	MOVX A,@R1
38H	ADDC A,R0	8EH	MOV direct,R6	E4H	CLR A
39H	ADDC A,R1	8FH	MOV direct,R7	F5H	MOVA, direct
3AH	ADDC A,R2	90H	MOV DPTR, #datal6	E6H	MOVA,@R0
3BH	ADDC A,R3	91H	ACALL addr11	F7H	MOV A,@R1
3CH	ADDC A,R4	92H	MOV bit, C	E8H	MOV A,R0
3DH	ADDC A,R5	93H	MOVCA,@A+DPTR	F9H	MOV A,R1
3EH	ADDC A,R6	94H	SUBB A, #data	EAH	MOV A,R2
3FH	ADDC A,R7	95H	SUBB A, direct	FRH	MOV A,R3
40H	JC rel	96H	SUBB A,@R0	ECH	MOV A,R4
41H	AJMP addr11	97H	SUBB A,@R1	FDH	MOV A,R5
42H	ORL direct, A	98H	SUBB A, R0	EEH	MOV A,R6
43H	ORL direct, #data	99H	SUBB A,R1	EFH	MOV A,R7
44H	ORL A, #data	9AH	SUBB A,R2	F0H	MOVX @DPTR,A
45H	ORL A, direct	9BH	SUBB A,R3	F1H	ACALL addr11
46H	ORL A,@R0	9CH	SUBB A,R4	F2H	MOVX @R0,A
47H	ORL A,@R1	9DH	SUBB A,R5	F3H	MOVX @R1,A
48H	ORL A,R0	9EH	SUBB A,R6	F4H	CPL A
49H	ORL A,R1	9FH	SUBB A,R7	F5H	MOV direct, A
4AH	ORL A,R2	A0H	ORL C,/bit	F6H	MOV @R0,A
4BH	ORLA,R3	A1H	AJMP addr11	F7H	MOV @R1,A
4CH	ORL A,R4	A2H	MOV C, bit	F8H	MOV R0,A
4DH	ORL A,R5	A3H	INC DPTR	F9H	MOV R1,A
4EH	ORL A,R6	A4H	MUL AB	FAH	MOV R2,A
4FH	ORLA,R7	A5H	Debug	FBH	MOV R3,A
50H	JNC rel	A6H	MOV @R0,direct	FCH	MOV R4,A
51H	ACALL addr11	A7H	MOV @R1,direct	FDH	MOV R5,A
52H	ANL direct, A	A8H	MOV R0, direct	FEH	MOV R6,A
53H	ANL direct, #data	A9H	MOV R1, direct	FFH	MOV R7,A
54H	ANL A, #data	AAH	MOV R2,direct		
55H	ANL A, direct	ABH	MOV R3,direct		

Table 106. Opcode map

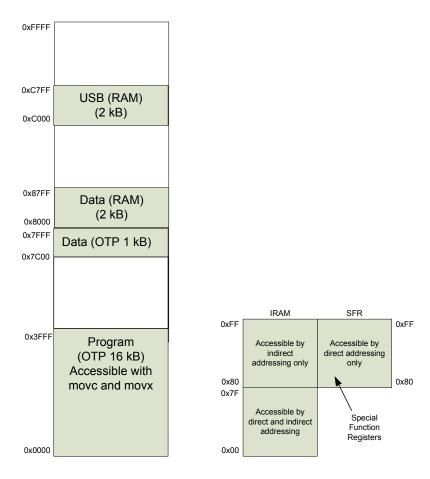


15 Memory and I/O organization

The MCU has a 64-kbyte address space for code and data, an area of 256 byte for internal data (IRAM), and an area of 128 byte for Special Function Registers (SFR).

The nRF24LU1+ OTP has 16 + 1 kbytes of OTP program memory, 2 kbytes of SRAM data memory and a dedicated internal RAM of 256 byte for MCU internal data, see <u>Figure 61.</u> To allow write OTP operations, the MCU must run the sequence described in <u>section 17.5.1</u>.

In addition, an area of 2 kbytes is reserved for the USB buffer RAM and the USB configuration registers.



Note: In a program running in a protected OTP area, movc may not be used to access addresses 0x00 to 0x03.

Figure 61. nRF24LU1+ OTP memory map



15.1 Special function registers

15.1.1 Special function registers locations

The map of Special Function Registers is shown in <u>Table 107.</u>.

Address	X000	X001	X010	X011	X100	X101	X110	X111
0xF8-0xFF	<u>FSR</u>	<u>FPCR</u>	FCR					
0xF0-0xF7	<u>B</u>	<u>AESKIN</u>	<u>AESIV</u>	<u>AESD</u>		AESIA1	AESIA2	
0xE8-0xEF	<u>AESCS</u>	MD0	MD1	MD2	MD3	<u>MD4</u>	MD5	ARCON
0xE0-0xE7	<u>ACC</u>					<u>RFDAT</u>	<u>RFCTL</u>	
0xD8-0xDF	WDCON	<u>USBSLP</u>						
0xD0-0xD7	<u>PSW</u>							
0xC8-0xCF	T2CON	P0EXP	<u>CRCL</u>	<u>CRCH</u>	<u>TL2</u>	<u>TH2</u>		
0xC0-0xC7	IRCON	<u>CCEN</u>	CCL1	<u>4CCH1</u>	CCL2	CCH2	CCL3	CCH3
0xB8-0xBF	<u>IEN1</u>	<u>IP1</u>	SORELH		SSCONF	<u>SSDAT</u>	<u>SSSTAT</u>	
0xB0-0xB7		<u>RSTRES</u>	<u>SMDAT</u>	SMCTRL		TICKDV		
0xA8-0xAF	<u>IEN0</u>	<u>IP0</u>	SORELL	<u>REGXH</u>	<u>REGXL</u>	REGXC		
0xA0-0xA7	<u>USBCON</u>			CLKCTL	<u>PWRDWN</u>	WUCONF	<u>INTEXP</u>	
0x98-0x9F	S0CON	S0BUF						
0x90-0x97	RFCON		DPS		P0DIR	P0ALT		
0x88-0x8F	TCON	TMOD	<u>TL0</u>	<u>TL1</u>	<u>TH0</u>	<u>TH1</u>	CKCON	
0x80-0x87	<u>P0</u>	<u>SP</u>	<u>DPL</u>	<u>DPH</u>	DPL1	DPH1		<u>PCON</u>

Table 107. Special Function Registers locations

Note: Undefined locations are reserved and must not be read or written.

The registers in the X000 column in <u>Table 107.</u> above are both byte and bit addressable. The other registers are only byte addressable.



15.1.2 Special function registers reset values

ACC 0xE0 0x00 Section 15.1.3 on page 131 Accumulator AESCS 0xE8 0x00 Section 8.2 on page 95 AES Command/Status AESD 0xF3 0x00 Section 8.2 on page 95 AES Data In/Out AESIA1 0xF5 0x00 Section 8.2 on page 95 AES Indirect Address register AESIV 0xF2 0x00 Section 8.2 on page 95 AES Indirect Address register AESIV 0xF2 0x00 Section 8.2 on page 95 AES Indirect Address register AESIV 0xF1 0x00 Section 8.2 on page 95 AES Indirect Address register AESIV 0xF2 0x00 Section 8.2 on page 95 AES Indirect Address register AESIV 0xF1 0x00 Section 8.2 on page 95 AES Indirect Address register AESIV 0xF2 0x00 Section 8.2 on page 95 AES Indirect Address register AESIV 0xF2 0x00 Section 18.2 on page 95 AES Indirect Address register AESIV 0xF2 0x00 Section 11.4.7 on page 110 Compare/Capture register 1, byte	ister nigh nigh ow
AESCS 0xE8 0x00 Section 8.2 on page 95 AES Command/Status AESD 0xF3 0x00 Section 8.2 on page 95 AES Data In/Out AESTA1 0xF5 0x00 Section 8.2 on page 95 AES Indirect Address register AESIA2 0xF6 0x00 Section 8.2 on page 95 AES Indirect Address register AESIV 0xF2 0x00 Section 8.2 on page 95 AES Indirect Address register AESKIN 0xF1 0x00 Section 8.2 on page 95 AES Indirect Address register AESKIN 0xF1 0x00 Section 8.2 on page 95 AES Indirect Address register AESKIN 0xF1 0x00 Section 18.4 on page 95 AES Key In ARCON 0xEF 0x00 Section 18.4 on page 149 Arithmetic Control register B 0xF0 0x00 Section 11.4.7 on page 110 Compare/Capture Enable reg CCH1 0xC3 0x00 Section 11.4.8 on page 110 Compare/Capture register 2, byte CCH2 0xC5 0x00 Section 11.4.8 on page 110 Compare/Capture register 2, byte <td>ister nigh nigh ow</td>	ister nigh nigh ow
AESD 0xF3 0x00 Section 8.2 on page 95 AES Data In/Out AESIA1 0xF5 0x00 Section 8.2 on page 95 AES Indirect Address register AESIA2 0xF6 0x00 Section 8.2 on page 95 AES Indirect Address register AESIV 0xF2 0x00 Section 8.2 on page 95 AES Initialization Vector AESKIN 0xF1 0x00 Section 8.2 on page 95 AES Key In ARCON 0xEF 0x00 Section 18.4 on page 149 Arithmetic Control register B 0xF0 0x00 Section 15.1.4 on page B register CCH1 0xC3 0x00 Section 11.4.8 on page 110 Compare/Capture Enable register 1, byte CCH2 0xC5 0x00 Section 11.4.8 on page 110 Compare/Capture register 2, byte CCH3 0xC7 0x00 Section 11.4.8 on page 110 Compare/Capture register 3, byte CCL2 0xC4 0x00 Section 11.4.8 on page 110 Compare/Capture register 2, byte CCL3 0xC6 0x00 Section 11.4.8 on page 110 Compare/Capture register 3, byte	ister nigh nigh ow
AESIA1 0xF5 0x00 Section 8.2 on page 95 AES Indirect Address register AESIA2 0xF6 0x00 Section 8.2 on page 95 AES Indirect Address register AESIV 0xF2 0x00 Section 8.2 on page 95 AES Indirect Address register AESIV 0xF1 0x00 Section 8.2 on page 95 AES Initialization Vector AESKIN 0xF1 0x00 Section 8.2 on page 95 AES Key In ARCON 0xEF 0x00 Section 18.4 on page 149 Arithmetic Control register B 0xF0 0x00 Section 15.1.4 on page B register 131 CCEN 0xC1 0x00 Section 11.4.7 on page 110 Compare/Capture Enable register 1, byte CCH1 0xC3 0x00 Section 11.4.8 on page 110 Compare/Capture register 1, byte CCH2 0xC5 0x00 Section 11.4.8 on page 110 Compare/Capture register 2, byte CCL1 0xC2 0x00 Section 11.4.8 on page 110 Compare/Capture register 3, byte CCL1 0xC2 0xO0 Section 11.4.8 on page 110 Compare/Capture register 1, byte CCL2 0xC4 0x00 Section 11.4.8 on page 110 Compare/Capture register 1, byte CCL2 0xC4 0x00 Section 11.4.8 on page 110 Compare/Capture register 1, byte CCL2 0xC4 0x00 Section 11.4.8 on page 110 Compare/Capture register 2, byte CCL3 0xC6 0x00 Section 11.4.8 on page 110 Compare/Capture register 2, byte CCL3 0xC6 0x00 Section 11.4.8 on page 110 Compare/Capture register 3, byte CKCON 0x8E 0x01 Section 16.1 on page 134 Memory cycle control CKCTL 0xA3 0x80 Section 20.4.1 on page 111 Compare/Reload/Capture register 160 Section 11.4.9 on page 111 Compare/Reload/Capture register 170 Section 11	ister nigh nigh ow
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CRCH 0xCB 0x00 Section 11.4.9 on page 111 Compare/Reload/Capture reg	
high byte	
	ster,
CDCT OvCA OvCA Continued 44.4 Common 444 Common and Continued to the	
CRCL 0xCA 0x00 Section 11.4.9 on page 111 Compare/Reload/Capture reg	ster,
low byte	
DPH 0x83 0x00 Section 15.1.7 on page Data Pointer High	
<u>132</u>	
DPL 0x82 0x00 Section 15.1.7 on page Data Pointer Low	
<u>132</u>	
DPS 0x92 0x00 Section 15.1.9 on page Data Pointer Select register	
<u>133</u>	
FCR 0xFA 0x00 Section 17.3.4 on page OTP Command register	
<u>139</u>	
FPCR 0xF9 NA Section 17.3.4 on page OTP Protect Configuration re	jister
<u>139</u>	
FSR 0xF8 NA Section 17.3.4 on page OTP Status register	
<u>139</u>	
IEN0 0xA8 0x00 Section 22.4.1 on page Interrupt Enable register 0	
<u>165</u>	
IEN1 0xB8 0x00 <u>Section 22.4.2 on page</u> Interrupt Priority register / Eng	
<u>166</u> register 1	ble
INTEXP 0xA6 0x01 Section 22.4.2 on page	ble
166	ible

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Register name	Address	Reset value	More information	Description
IP0	0xA9	0x00	Section 22.4.3 on page	Interrupt Priority register 0
			166	, , ,
IP1	0xB9	0x00	Section 22.4.3 on page	Interrupt Priority register 1
			<u>166</u>	
IRCON	0xC0	0x00	Section 22.4.4 on page	Interrupt Request Control register
			<u>167</u>	
MD0	0xE9	0x00	Section 18.4 on page 149	Multiplication/Division register 0
MD1	0xEA	0x00	Section 18.4 on page 149	Multiplication/Division register 1
MD2	0xEB	0x00	Section 18.4 on page 149	Multiplication/Division register 2
MD3	0xEC	0x00	Section 18.4 on page 149	Multiplication/Division register 3
MD4	0xED	0x00	Section 18.4 on page 149	Multiplication/Division register 4
MD5	0xEE	0x00	Section 18.4 on page 149	Multiplication/Division register 5
P0	0x80	0xFF	Section 13.1 on page 116	Port 0 (only P0.0 – P0.5 available
				externally)
POALT	0x95	0x00	Section 13.1 on page 116	GPIO port functions
PODIR	0x94	0xFF	Section 13.1 on page 116	GPIO pin direction control
POEXP	0xC9	0x00	Section 13.1 on page 116	
PCON	0x87	0x00	Section 20.4.5 on page	Power Control
			<u>162</u>	
PSW	0xD0	0x00	Section 15.1.5 on page	Program Status Word
			132	
PWRDWN	0xA4	0x00	Section 20.4.2 on page	
	0.45		<u>161</u>	
REGXC	0xAD	0x00	Section 19.3.6 on page	Control register for watchdog and
	0.45	0.00	<u>155</u>	wakeup functions
REGXH	0xAB	0x00	Section 19.3.6 on page	High byte of 16-bit watchdog/
22011	040	000	155	wakeup register
REGXL	0xAC	0x00	Section 19.3.6 on page	Low byte of 16-bit watchdog/
D = 0017	000	000	155	wakeup register
RFCON	0x90	0x02	Section 6.5.1 on page 53	RF Transceiver configuration regis-
DECE	0xE6	0x00	Section 6.5.1 on page 53	RF Transceiver control register
RFCTL	0xE6	0x00 0x00	Section 6.5.1 on page 53	RF data register
RFDAT	0xE3	0x00	Section 20.4.3 on page	RF data register
RSTRES	UXDI	0,000	161	
SOBUF	0x99	0x00		Serial Port 0, Data Buffer
SUBUF	UX99	0,000	115	Serial Fort 0, Data Buller
SOCON	0x98	0x00	Section 12.4.1 on page	Serial Port 0, Control register
SUCON	0,00	0,00	113	Serial Port 0, Control register
SORELH	0xBA	0x03	Section 12.4.3 on page	Serial Port 0, Reload register, high
SUKELIH	UNDA	0,03	115	byte
SORELL	0xAA	0xD9	Section 12.4.3 on page	Serial Port 0, Reload register, low
SUKELL	UX/V1	OXDS	115	byte
SMCTRL	0xB3	0x00	Section 9.2 on page 98	SPI Master Control register
SMCTRL	0xB3	0x00	Section 9.2 on page 98	SPI Master data register
SP	0x81	0x07	Section 15.1.6 on page	Stack Pointer
51			132	
SSCONF	0xBC	0x00	Section 10.2 on page 100	SPI Slave configuration
SSDAT	0xBD	0x00	Section 10.2 on page 100	SPI Slave Data register
SSSTAT	0xBE	0x00	Section 10.2 on page 100	SPI Slave Status register
T2CON	0xC8	0x00	Section 11.4.5 on page	Timer 2 Control register
			109	= = = = = = = = = = = = = = = = = = =
L	L	l	<u> </u>	<u> </u>



Register name	Address	Reset value		Description
TCON	0x88	0x00	<u>Section 11.4.1 on page</u> <u>107</u>	Timer/Counter Control register
THO	0x8C	0x00	Section 11.4.3 on page 108	Timer 0, high byte
TH1	0x8D	0x00	Section 11.4.4 on page 108	Timer 1, high byte
TH2	0xCD	0x00	<u>Section 11.4.6 on page</u> <u>109</u>	Timer 2, high byte
TICKDV	0xB5	0x03	<u>Section 19.3.2 on page</u> <u>154</u>	Divider for watchdog and wakeup functions
TLO	A8x0	0x00	<u>Section 11.4.3 on page</u> <u>108</u>	Timer 0, low byte
TL1	0x8B	0x00	<u>Section 11.4.4 on page</u> <u>108</u>	Timer 1, low byte
TL2	0xCC	0x00	<u>Section 11.4.6 on page</u> <u>109</u>	Timer 2, low byte
TMOD	0x89	0x00	Section 11.4.2 on page 108	Timer Mode register
USBCON	0xA0	0x00	Section 7.3 on page 65	USB configuration/status register
USBSLP	0xD9	0x00	Section 7.3 on page 65	USB sleep
WDCON	0xD8	0x00	Section 12.4.4 on page 115	Serial Port 0 Baud Rate Select register (only wdcon[7] bit used)
WUCONF	0xA5	0x00	<u>Section 20.4.4 on page</u> <u>161</u>	Wakeup configuration register

Table 108. Special Function Registers reset values

15.1.3 Accumulator - ACC

Accumulator is used by most of the MCU instructions to hold the operand and to store the result of an operation.

Note: The mnemonics for accumulator specific instructions refer to accumulator as A, not ACC.

Address	Reset value	bit7	bit6	bit5	bit4	bit3	bit2	bit1	bit0
0xE0	0x00	acc.7	acc.6	acc.5	acc.4	acc.3	acc.2	acc.1	acc.0

Table 109. ACC register

15.1.4 B register – B

The B register is used during multiplying and division instructions. It can also be used as a scratch-pad register to hold temporary data.

Address	Reset value	bit7	bit6	bit5	bit4	bit3	bit2	bit1	bit0
0xF0	0x00	b.7	b.6	b.5	b.4	b.3	b.2	b.1	b.0

Table 110. B register



15.1.5 Program Status Word register - PSW

The PSW register contains status bits that reflect the current state of the MCU.

Address	Reset value	Bit	Name	Description
0xD0	0x00	7	су	Carry flag: Carry bit in arithmetic operations and accumulator
				for Boolean operations.
		6	ac	Auxiliary Carry flag: Set if there is a carry-out from 3rd bit of
				Accumulator in BCD operations
		5	f0	General purpose flag 0
		4-3	rs	Register bank select, bank 03 (0x00-0x07, 0x08-0x0f, 0x10-
				0x17, 0x18-0x1f)
		2	OV	Overflow flag: Set if overflow in Accumulator during arithme-
				tic operations
		1	f1	General purpose flag 1
		0	р	Parity flag: Set if odd number of '1' in ACC.

Table 111. PSW register

Note: The Parity bit can only be modified by hardware in the ACC register state.

15.1.6 Stack Pointer - SP

This register points to the top of the stack in internal data memory space. It is used to store the return address of a program before executing an interrupt routine or subprograms. The SP register is incremented before executing PUSH or CALL instruction and it is decremented after executing POP or RET(I) instruction (it always points to the top of the stack).

Address	Reset value	Register name
0x81	0x07	SP

Table 112. SP register

15.1.7 Data Pointer – DPH, DPL

Address	Reset value	Register name
0x82	0x00	DPL
0X83	0x00	DPH

Table 113. Data Pointer register (DPH:DPL)

The Data Pointer registers can be accessed through DPL and DPH. The actual data pointer is selected by the DPS register.

The Data Pointer registers are intended to hold a 16-bit address in the indirect addressing mode used by MOVX (move external memory), MOVC (move program memory) or JMP (computed branch) instructions. They may be manipulated as 16-bit register or as two separate 8-bit registers. DPH holds the higher byte and DPL holds the lower byte of an indirect address.

These registers are used to access external code or data space (for example, MOVC A, @A+DPTR or MOV A, @DPTR).



15.1.8 Data Pointer 1 – DPH1, DPL1

Address	Register name
0x84	DPL1
0X85	DPH1

Table 114. Data Pointer 1 register (DPH1:DPL1)

The Data Pointer register 1 can be accessed through DPL1 and DPH1. The actual data pointer is selected by the DPS register.

These registers are intended to hold a 16-bit address in the indirect addressing mode used by MOVX (move external memory), MOVC (move program memory) or JMP (computed branch) instructions. They can be manipulated as a 16-bit register or as two separate 8-bit registers. DPH1 holds the higher byte and DPL1 holds the lower byte of an indirect address.

These registers are used to access external code or data space (for example, MOVC A,@A+DPTR or MOV A,@DPTR respectively).

The Data Pointer 1 is an extension to the standard 8051 architecture to speed up block data transfers.

15.1.9 Data Pointer Select register – DPS

The MCU contains two Data Pointer registers. Both Data Pointer registers can be used as 16-bits address source for indirect addressing. The DPS register serves for selecting the active data pointer register.

Ī	Address	Reset value	Bit	Name	Description
Ī	0x92	0x00	7:1	-	Not used
			0	dps	Data Pointer Select. 0: select DPH:DPL, 1: select DPH1:DPL1

Table 115. DPS register



16 Random Access Memory (RAM)

The nRF24LU1+ OTP contains two separate RAM blocks. These blocks are used to save temporary data or programs.

The RAM blocks are 256x8 IRAM bits and 2048x8 bits.

Note: The information in these blocks is lost when power to the device is removed.

As described in <u>chapter 15 on page 127</u>, the RAM resides in different maps, that is, different instructions are used to access them.

The smallest RAM-block (256 bytes) resides in the "internal" RAM-area, called IRAM, and contains scratch-pad data, subroutine stacks, register files, and so on.

Note: The lower 128 bytes can be addressed direct or indirectly, while the upper 128 bytes can only be accessed using indirect addressing.

The largest RAM (2048 bytes) resides in the XDATA space and is a fixed block located from address 0x8000 to 0x87FF. This block is used for data or program code.

16.1 Cycle control

The MCU has a programmable SFR register that controls timing to on-chip memory. Since this memory is fast, the default values are recommended.

Address	Reset value	Bit	Description	
0x8E	0x01	7	Not used	
		6-4	Program memory wait state control	
			000: No wait-states (default at power-up)	
			Other values are reserved and should not be used	
		3	Not used	
		2-0	External data memory stretch control.	
			001: One stretch cycle (default)	
			Other values are reserved and should not be used	

Table 116. CKCON register

16.2 PDATA memory addressing

PDATA (Paged Data memory) addressing into data space is supported. One page (256 bytes) can be accessed by an indirect addressing scheme through registers R0 and R1 (@R0, @R1).

Start address of the PDATA page is 0x8000.



17 One-Time Programmable (OTP) Memory

The nRF24LU1+ OTP has 16 kB of One-Time Programmable (OTP) memory intended as program memory and 1 kB OTP memory intended for non-volatile data. There is also a 256 byte InfoPage that is user-programmable. The OTP memory can be read and written by the MCU.

You can also configure and program the OTP memory through an external SPI slave interface.

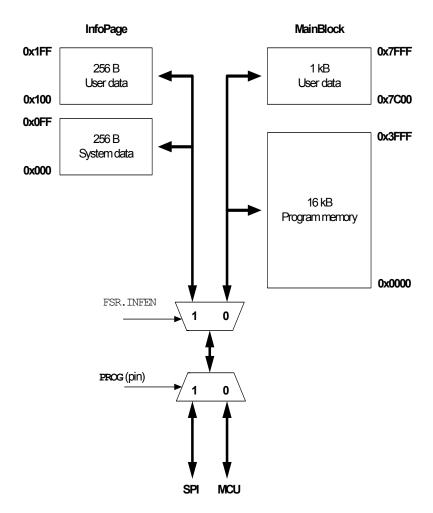
The OTP memory can be configured to inhibit readback or modification of the memory content, and is organized so that the nRF24LU1+ OTP is compatible with the nRF24LU1+.

17.1 Features

- 16 + 1 kB OTP memory (16 kB for code and 1 kB for data, for compatibility with flash versions)
- · 256 bytes of user programmable InfoPage
- Direct SPI programmable
- · Read and write accessible from MCU
- · Configurable SPI readback protection



17.2 Block diagram



Note: The PROG pin has logical has logical level "1" at 3.3V and 6.75V. Logical level "0" at 0V.

Figure 62. OTP memory block diagram

17.3 Functional description

17.3.1 OTP memory configuration

The OTP memory is divided into two blocks, MainBlock and InfoPage.

At the chip interface the OTP behaves as an SPI programmable OTP memory. All configuration and setup of the behavior during normal mode (that is, when MCU is active and running) is defined through the SPI and the configuration data is stored in the InfoPage. During the chip reset/start-up sequence the configuration data is read and stored in a set of registers that control OTP memory behavior.

You can program the InfoPage through the SPI only, because the MCU has only read access to the InfoPage, except for byte 0x23, which is writable from the MCU, see <u>Table 117.</u>

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Note: All bytes of the OTP memory are pre-set to the value 0xFF. When an OTP bit is written, it is either changed to 0 or remains at 1. If changed to 0, the bit can never again be set to 1. No OTP bit should be programmed (to 0) more than once.



17.3.2 InfoPage content

The content of the InfoPage is given in <u>Table 117</u>. The InfoPage content is set at factory so that all non-reserved bytes, except CHIPID, initially have the value 0xFF.

InfoPage data	Size	Address	Comment	
Reserved	11 bytes	0x00	Reserved	
CHIPID	5 bytes	0x0B	ID number for each individual device. The ID is gener-	
			ated by a pseudo random process. No ID will violate	
			the rules specificed in section 6.4.3.2	
Reserved	16 bytes	0x10	Reserved	
Reserved	1 byte	0x20	Byte value 0xFF; implies FPCR.NUPP=0xFF	
Reserved	1 byte	0x21	Byte value 0x00; implies FPCR.DAEN=1	
Reserved	1 byte	0x22	Byte value 0xFF	
Readback blocking	1 byte	0x23	Read out during reset/start-up sequence of chip.	
byte for MainBlock			Byte value:	
			0xFF: FSR.RDISMB=0	
			Other value: FSR.RDISMB=1	
			Note: This byte may be written by the MCU.	
Reserved	1 byte	0x24	Byte value 0xFF	
Reserved	219 bytes	0x25	Reserved	
For user data	256 bytes	0x100	Free to use. Writeable and readable by SPI. Readable	
			only by MCU.	

Table 117. InfoPage content

17.3.3 Software compatability with flash versions of nRF24LU1+

The nRF24LU1+ (flash versions) is compatible with nRF24LU1+ OTP if FPCR. DAEN=1 and FPCR. NUPP=0xFF, in the nRF24LU1+ flash info page. Refer to nRF24LU1+ Product Specification for details.



17.3.4 SFR registers for OTP memory operations

Addr	Reset value	Bit	Name	RW	Function	
0xF8	0		-		FSR	
		7		R	OTP Status Register	
					Reserved, read as 0.	
		6	-	R	Reserved, read as 0.	
	0	5	WEN	RW	OTP write enable. 1: enable	
	0	4	RDYN	R	OTP interface ready. 0: ready	
	0	3	INFEN	RW	InfoPage enable. 1: enable	
	Read	2	RDISMB	R	SPI read-back disable of MainBlock. 1: read back disable	
	from				and also inhibits MainBlock write. Writable by SPI com-	
	OTP,				mand RDISMB and may never be cleared again. Can also	
	see				be written indirectly by MCU as described in <u>Table 117.</u>	
	<u>Table</u>				<u>on page 138</u> .	
	<u>117.</u>	1	-	R	1 10001100,1001000	
		0	-	R	Reserved, read as 0.	
0xF9	0xFF	7:0		R	FPCR - OTP Protect Configuration Register	
			-			
					Reserved, read as 0xFF.	
0xFA	0x00	7:0	EPA	RW	FCR – OTP Command Register Used for secure MCU OTP write, see section 17.5.1 on	
					page 140. for information about the MCU write of the	
					MainBlock.	

Table 118. FSR, FPCR and FCR registers

17.4 Brown-out

There is an on-chip power-fail detector which ensures that any OTP memory program access will be ignored when the 'Power Fail' signal (see Figure 75.) is active. Both the microcontroller and the OTP memory still function according to specification, and any write operation that was started will be completed. If the supply voltage drops further, then the signal "reset" will be set active and the chip will be reset. Please refer to Figure 75. for reference. If the power supply rises again before reaching the reset threshold, there will be no reset, and there is no status indication to show that this has happened.

To ensure proper programming of the OTP in the cases where power supply may be unreliable, the user should take the following precautions:

- Make sure the data read back from the OTP is identical to what is written to OTP. The mechanism above will guarantee that the data is safely stored to OTP if the value does compare. If the compare fails, the write has been ignored due to a power supply event.
- Using the VBUS supply, the time from "Power Fail" to "Reset" is longer than one OTP byte write operation (around 100 µs), as this is assured by the 10µF capacitor on the VBUS pin. If using the VDD supply, make sure that this requirement is met by sufficient reservoir on this supply.

17.5 OTP programming from the MCU

This section describes how you can write the OTP memory using the MCU. Note that all OTP write operations require that Cclk = 16 MHz, see <u>Table 131</u>. on page 160.



17.5.1 MCU write of the MainBlock

When an OTP write is initiated, the MCU is halted for approximately 12800 clock cycles (0.8ms) for each byte written. During this time the MCU does not respond to any interrupts.

The MCU can perform write operations to the unprotected part and the data part of the OTP MainBlock. Please see <u>Figure 62</u>. on page 136.

To prevent unwanted/harmful write operations, a security mechanism is implemented. To allow write OTP operations the MCU must run the following sequence:

- 1. Write 0xAA to the FCR register. This starts an internal 7 bit down counter. The counter counts down from 127 to 0.
- 2. Before the count down period has expired (8 μ s @16 MHz), write 0x55 to the FCR. This restarts the internal 7 bit down counter. Then the counter counts down again from 127 to 0. In the count down period (8 μ s) the FSR. WEN bit is writeable from the MCU.
- 3. Set FSR. WEN high before the count down period has expired.
- 4. The OTP is now open for write from the MCU until FSR.WEN is set low again. FSR.WEN can be set low directly (no security mechanism applies).
- 5. Bytes are written individually (there is no auto increment) to the OTP using the specific memory address. When the programming code executes from the OTP, any write operation is self timed and the MCU stops until the operation is finished. If the programming code executes from the XDATA RAM the code must wait until the operation has finished. This can be done either by polling the FSR.RDYN bit to go low or by a wait loop. Do not set FSR.WEN low before the write operation is finished. Memory address is identical to the OTP address, see section 17.6 on page 140 for information regarding memory mapping.

17.6 OTP programming through SPI

The on-chip OTP is designed to interface a standard SPI device for programming. The interface uses an 8 bit instruction register and a set of instructions/commands to program and configure the OTP memory. Note that all OTP write operations require that Cclk = 16 MHz, see Table 131. on page 160.

Note: For SPI programming the PROG pin must be connected to a 6.75 V supply. For SPI read the PROG pin supply may be reduced to 3.3V.

17.6.1 SPI commands

To allow access through the SPI the external PROG pin must be set high (6.75V) during all OTP operation commands. After activating the PROG pin you must wait at least 1.5 ms before you input the first OTP command. When the PROG pin is set, the GPIO pins are automatically configured as slave SPI (see section 17.6 on page 140. Further description of SPI slave is found in section 17.6). Before each OTP write command, FSR.WEN must be set, because this bit is automatically cleared after any write command. The value of FSR.INFEN always decides if access goes to the OTP MainBlock or the InfoPage.

Command	Command format	Address	Number of databytes	Command operation	
WREN	0x06	NA 0 Set OTP write enable, FSR. WEN		Set OTP write enable, FSR. WEN	
WRDIS	0x04	NA	NA 0 Reset OTP write enable, FSR.WEN		
RDSR	0x05	NA 1 (or more) Read OTP Status Register (FSR)		Read OTP Status Register (FSR)	
WRSR	0x01	NA	` '		



Command	Command format	Address	Number of databytes	Command operation	
READ	0x03	Start	1-17408	Read data from OTP	
		address,			
		2 bytes			
PROGRAM	0x02	Start	1-256	Write data to OTP	
		address,			
		2 bytes			
RESERVED	0x52	NA	NA	Reserved command, do not use.	
RESERVED	0x62	NA	NA	Reserved command, do not use.	
RDFPCR	0x89	NA	1	Read OTP Protect Configuration Register	
				(FPCR)	
RESERVED	0x84	NA	0	Reserved command, do not use.	
RDISMB	0x85	NA	0	Set OTP MainBlock read-back disable,	
				FSR.RDISMB and write 0x00 to InfoPage byte	
				0x23.	
Reserved	0x86	NA	NA	Reserved command, do not use.	

Table 119. OTP SPI operation commands

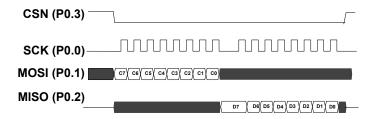


Figure 63. SPI read command without address

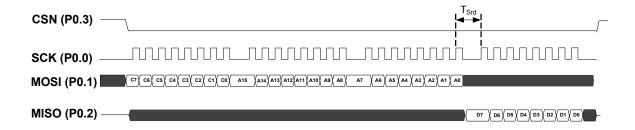


Figure 64. SPI OTP read operation, shown with 1 databyte

Note: For the READ command there must be a delay, T_{Srd}, from the last address bit to the first data bit. Minimum value of T_{Srd} is 4 clock cycles (xc1) + 10ns, which is 260ns when xc1 is 16 MHz. For other timing parameters, see section 10.3 on page 101.

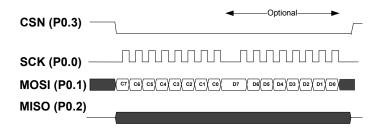


Figure 65. SPI write command without address

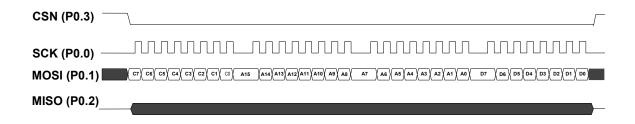


Figure 66. SPI OTP write operation, shown with 1 databyte

An SPI command always starts with the external master sending a command byte to the OTP slave, followed by a variable number of address and data bytes. The number of address and data bytes is specific to each command, as shown in Table 119. On page 141. In Figure 63. On page 141 to Figure 66. On page 142, Cn are the SPI command bits. Anare the address bits and Dn are the data bits (note: MSBit in each byte first). After CSN is deactivated, an OTP write command requires the chip to do the OTP programming, and this will take some time to complete. Therefore, it is advised to not issue a new command until the specified amount of time has elapsed. Alternatively, you can repeatedly issue RDSR commands until the FSR.RDYN bit reads back as 0.

17.6.1.1 WREN/WRDIS

SPI command WREN sets the OTP write enable bit FSR. WEN, and SPI command WRDIS resets FSR. WEN. This bit enables all SPI write operations to the OTP memory. The device powers up in write disable state and will automatically return to write disable state after any SPI OTP write command. Each SPI OTP write instruction must therefore be preceded by a WREN command. Both WREN and WRDIS are one-byte commands with no data.

17.6.1.2 RDSR

The SPI command RDSR reads out the content of the OTP status register FSR, and consists of one-command byte and one-data byte as shown in <u>Figure 63</u>. on page 141. By keeping the CSN line active after the first data byte, FSR will be repeatedly re-read until CSN is set inactive.

17.6.1.3 WRSR

The SPI command WRSR writes to the OTP status register FSR, and consists of a one-command byte and one-data byte as shown in Figure 65. on page 142.



17.6.1.4 READ

The SPI command READ reads out the content of the OTP memory, starting from the given address. If FSR.INFEN=0, the OTP MainBlock will be read. If FSR.INFEN=1, the OTP InfoPage will be read. The following sequence is required:

- 1. The CSN line is activated (that is, pulled low) to enable/ activate the SPI slave.
- 2. The READ command is transmitted through the MosI line followed by the two byte address to the byte to be read as shown in Figure 64. on page 141.
- 3. The addressed data byte is shifted out on the MISO line.

If the CSN line is kept active after the first byte is read out; the read command can be extended, the address is auto incremented and data continues to be shifted out. The internal address counter rolls over when the highest address is reached, allowing the complete memory to be read in one continuous read command.

A readback of the OTP content is only possible if the respective read disable bit FSR.RDISMB is not set.

17.6.1.5 PROGRAM

The SPI command PROGRAM writes to (programs) the OTP memory, starting from the given address. If FSR.INFEN=0, the OTP MainBlock will be written to. If FSR.INFEN=1, the OTP InfoPage will be written to. The following sequence is required:

- 1. Enable the device for writing (set FSR. WEN) using the WREN or WRSR command.
- 2. The csn line is pulled low to enable the SPI slave.
- 3. The PROGRAM command is sent on the MOSI line followed by the two-byte address (address of the first byte) and the data to be programmed/ written, as shown in Figure 66. on page 142.
- 4. The on-chip driven program sequence is started when you set the CSN pin high/ deactivated.
- 5. Programming n bytes takes n*1600 clock cycles (XC1) after CSN is deactivated. During the program sequence all SPI commands are ignored except the RDSR command.

The CSN line can be kept active to write up to 256 bytes (with address auto increment) in one PROGRAM command. The first byte can be anywhere in a page. All bytes of the OTP memory are preset to value 0xFF. Bits in the OTP memory can only be cleared, so after a 0 has been written, it can never be set back to 1 again.

Note: FSR.RDISMB = 1 inhibits the write to the OTP MainBlock.

The device returns to write disable after completion of a PROGRAM command.

17.6.1.6 RDFPCR

The SPI command RDFPCR reads out the content of the OTP protect configuration register FPCR, and consists of one command byte and one data byte as shown in <u>Figure 63</u>. on page 141.

17.6.1.7 RDISMB

This disables OTP MainBlock readback and writes 0x00 to byte 0x23 in OTP InfoPage. The command disables all read and write access to the OTP MainBlock from the SPI external interface. This will protect the content of the OTP MainBlock from being read out over the external SPI. This is a single byte command with no data. The following sequence is required:

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- 1. Enable the device for writing (set FSR.WEN) using the WREN or WRSR command.
- 2. The CSN line is pulled low to enable the SPI slave.
- 3. The RDISMB command is sent on the Mosi line.
- 4. The on-chip driven program sequence is started when the CSN pin is high/deactivated.
- 5. The program sequence takes 1600 clock cycles (XC1) after CSN is deactivated. During this sequence all SPI commands are ignored except the RDSR command.

The device returns to write disable after completion of an RDISMB command.

Note: RDISMB can never be be cleared again.

17.6.1.8 SPI Readback disable

This is implemented to prevent readback over the external SPI interface. One byte of the InfoPage is reserved for this. The MainBlock has its own readback disable signal, FSR.RDISMB. The InfoPage content is checked whenever the chip is started or restarted. If byte 0x23 of InfoPage=0xFF, FSR.RDISMB=0, otherwise FSR.RDISMB=1.

The SPI command RDISMB enables the readback disable function. The InfoPage byte 0x23 (RDISMB) is also writable by MCU. Once disabled, the readback function can never be enabled again. FSR.RDISMB=1 also inhibits write to OTP (both MainBlock and InfoPage).

17.6.2 Standalone programming requirements

When programming the nRF24LU1+ OTP in a standalone OTP programmer, an adapter board (or socket assembly) with capacitors and resistors and an oscillator are required. The following table describes how the device pins are used:

Signal	Pins	Disposition	Further information
VDD	1, 3, 9, 19, 24, 27	Connect together to supply and decouple	See <u>17.6.2.2</u>
VBUS	3	Open	See <u>17.6.2.2</u>
D+	4	Leave open	
D-	5	Leave open	
VSS	6, 12, 17, 18, 23, 26, 30	Connect to ground net (plane)	See <u>17.6.2.2</u>
PROG/VPP	7	Connect to 6.75 V with 5mA drive	
RESET	8	Connect to pin electronics or strap to VDD	See <u>2.2.2</u>
SCK	10	Connect to pin electronics (nRF24LU1+ OTP in)	See <u>17.6.1</u>
MOSI	11	Connect to pin electronics (nRF24LU1+ OTP in)	See <u>17.6.1</u>
MISO	13	Connect to pin electronics (nRF24LU1+ OTP out)	See <u>17.6.1</u>
CSN	14	Connect to pin electronics (nRF24LU1+ OTP in)	See <u>17.6.1</u>
P0.4	15	Leave open	
P0.5	16	Leave open	
VDD_PA	20	Leave open	_
ANT1	21	Leave open	
ANT2	22	Leave open	
IREF	25	Leave open	



Signal	Pins	Disposition	Further information
DEC1	28	Leave open	
DEC2	29	Decouple to VSS	See <u>17.6.2.2</u>
XC2	31	Leave open (optionally connect to XTAL)	See <u>17.6.2.1</u>
XC1	32	Connect to clock source	See <u>17.6.2.1</u>

Table 120. Device pins

17.6.2.1 Clock requirements

The xc1 requires a clock between 13.6 MHz and 16 MHz during the entire programming sequence. The programming speed is directly proportional to the speed of the clock, so we recommend a clock speed of 16 MHz \pm 60ppm. The clock source can be a crystal between xc1 and xc2 or an external clock source connected to the xc1 pin:

- From an oscillator module on the adapter board or a pin driver in the programmer.
 - ▶ Required amplitude is at least 0.5V p-p, maximum 3.3V p-p.
 - ▶ Waveform is sine or square.
 - ▶ Required duty cycle is 40% to 60% (V/2 in the sine case).

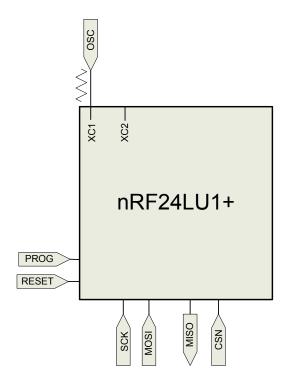


Figure 67. External clock source

- From a crystal between xc1 (pin 32) and xc2 (pin 31)
 - ► See <u>chapter 23 on page 168</u> for oscillator circuitry details.
 - ▶ Make sure the socket solution does not add significant parasitics to the circuit.

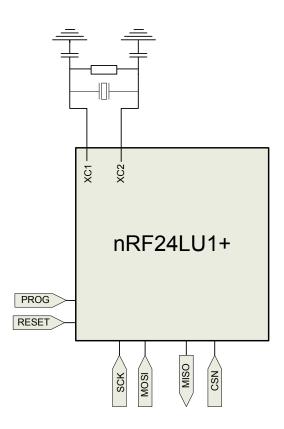


Figure 68. Clock source from a crystal between XC1 and XC2 pins

17.6.2.2 Power supply requirements

All vss pins should be well connected to the adapter board, preferably using a ground plane. All vdd pins should be connected together and decoupled with at least three capacitors (two 10nF capacitors and one 100nF capacitor), to vss. The dec2 pin should be decoupled with 33nF to vss.

Using 3.3V supply is preferred. Leave the VBUS pin open and connect a $3.3V \pm 5\%$ power supply to the VDD pins. The PROG pin must be connected to 6.75V supply with 5mA drive.

17.6.2.3 Signal pin requirements

SPI Port

The pins CSN, SCK and MOSI must be driven by programmer pin electronics. All write operations to the OTP are controlled by these three signals. The pin MISO is an output of the nRF24LU1+ OTP that must be read to validate OTP contents, and can be read to check status during write operations.

The clock frequency of the SPI port is not correlated to the xc1 clock (it does not need to be synchronous). The SPI data signals have no defined relation to the XC1 clock (can be any phase). For more information see section 17.6 on page 140.



Control pin RESET

If the power-on sequence is clean (that is, the nRF24LU1+ OTP is well seated when the power is ramped and the power ramp is monotonous), the reset signal may be strapped to VDD. However, if possible, this signal should be controlled by a pin driver so that they are independent of power ramp quality.

17.6.3 In circuit programming over SPI

You can program a finished PCB with nRF24LU1+ OTP that has all parts mounted. There are similar requirements to a standalone programmer with the following exceptions:

- All pins must be connected according to application requirements.
- PROG pin needs a pull-down on the PCB.
- PROG pin should be under the control of the programmer over the edge of the PCB or through a pogo pin.
- RESET pin needs a pull-up on the PCB.
- RESET pin should be under the control of the programmer over the edge of the PCB or through a pogo pin (to restart the device after programming if required).
- The SPI input pins (CSN, SCK, MOSI) should be under the control of the programmer over the edge of the PCB or through a pogo pin.
- The SPI output pin (MISO) should be readable by the programmer over the edge of the PCB or through a pogo pin.
- The application's use of the SPI port pins should not conflict with the use of these pins as an SPI port.
- The nRF24LU1+ OTP can be powered effectively by a 5V source connected to VBUS (over USB plug or pogo pin) or by a 3.3V ± 5% source connected to VDD over the edge of the PCB or through a pogo pin.

17.6.4 SPI programming sequences

The details of SPI timing are described in <u>section 17.6 on page 140</u>. With limited tracked length (and other loading on MISO) it is possible to operate the SPI up to 8 MHz. Reducing that to 4 MHz (or even 2 MHz) does not significantly impact the overall programming time.

The sequences of command and data in an SPI command are found in <u>Figure 64</u>. on <u>page 141</u> and <u>Figure 66</u>. on <u>page 142</u>. In these figures only 1 byte of data is shown. Typically for read and write data transfers, the block should be as long as possible (64 to 256 data bytes gives the best performance).

The typical production-line sequence of commands is:

- 1. Pull RESET pin low for minimum 0.2 µs and return to high.
- 2. Pull PROG pin high (6.75V) and wait for 2 ms.
- 3. Repeat the following steps 68 times for 16 + 1 kB OTP memory
 - ▶ Issue WREN command
 - ▶ Issue PROGRAM command followed by the next address and then the next 256 data bytes
 - ▶ Wait until the PROGRAM command is finished (this is 256 times 1600 clock cycles (XC1) after the positive edge of CSN).
- 4. Repeat the following steps 68 times for 16 + 1 kB OTP memory
 - ▶ Issue READ command followed by next address then read out 256 bytes on MISO
 - ▶ Compare read bytes against expected

The following are optional steps that update the InfoPage fields:



5. Issue WFSR to set FSR. INFEN bit to 1.

IF "Readback blocking for MainBlock" is specified:

- 6. Issue SPI command RDISMB
- 7. Wait until the PROGRAM command has completed (this is 1600 clock cycles (XC1) after the positive edge of CSN).

Note: The completion of the PROGRAM command may be ensured by waiting the specified amount of time, or, alternatively, by repeatedly issuing RDSR commands until the FSR.RDYN bit reads back as 0.



18 MDU – Multiply Divide Unit

The MDU – Multiplication Division Unit, is an on-chip arithmetic co-processor which enables the MCU to perform additional extended arithmetic operations like 32-bit division, 16-bit multiplication, shift and, normalize operations.

18.1 Features

The MDU is controlled by the SFR registers MD0 .. MD5 and ARCON.

18.2 Block diagram

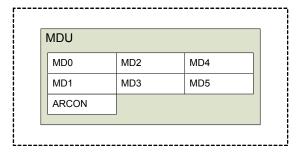


Figure 69. Block diagram of MDU

18.3 Functional description

All operations are unsigned integer operations. The MDU is handled by seven registers, which are memory mapped as Special Function Registers. The arithmetic unit allows concurrent operations to be performed independent of the MCU's activity.

Operands and results are stored in MD0..MD5 registers. The module is controlled by the ARCON register. Any calculation of the MDU overwrites its operands.

The MDU does not allow reentrant code and cannot be used in multiple threads of the main and interrupt routines at the same time. Use the NOMDU_R515 directive to disable MDU operation in possible conflicting functions.

18.4 SFR registers

The MD0 .. MD5 are registers used in the MDU operation.

Address	Register name
0xE9	MD0
0xEA	MD1
0xEB	MD2
0xEC	MD3
0xED	MD4
0xEE	MD5

Table 121. Multiplication/Division registers MD0..MD5



The ARCON register controls the operation of MDU and informs you about its current state.

Address	Reset value	Bit	Name	Description
0xEF	0x00	7	mdef	MDU Error flag MDEF. Indicates an improperly performed opera-
				tion (when one of the arithmetic operations has been restarted or
				interrupted by a new operation).
		6	mdov	MDU Overflow flag MDOV. Overflow occurrence in the MDU oper-
				ation.
		5	slr	Shift direction, 0: shift left, 1: shift right.
		4-0	SC	Shift counter. When set to '0's, normalize operation is selected.
				After normalization, the "sc.0" "sc.4" contains the number of
				normalizing shifts performed.
				Shift operation is selected when at least one of these bits is set
				high. The number of shifts performed is determined by the num-
				ber written to "sc.4", "sc.0", where "sc.4" is the MSB.

Table 122. ARCON register

The operation of the MDU consists of the following phases:

18.4.1 Loading the MDx registers

The type of calculation the MDU has to perform is selected in accordance with the order in which the MDx registers are written.

Operation	32 bit/16 bit	16 bit / 16 bit	16 bit x 16 bit	Shift/normalize
first write	MD0 (lsb) ㅁ	MD0 (lsb)	MD0 (lsb) Num1	MD0 (lsb)
	MD1 op MD2 ≥	MD1 (msb)	MD4 (lsb) Num2	MD0 (ISb) Laguer MD1 MD2 MD2
	MD3 (msb)	Ξ		MD3 (msb)
	sor	sor	MD1 (msb) Num1	
last write	MD4 (lsb)	MD4 (lsb) ∑ P P P P P P P P P P P P P P P P P P	MD5 (msb) Num2	ARCON

Table 123. MDU registers write sequence

- 1. Write MD0 to start any operation.
- 2. Write operations, as shown in Table 123. to determine appropriate MDU operation.
- 3. Write (to MD5 or ARCON) starts selected operation.

The SFR Control detects some of the above sequences and passes control to the MDU. When a write access occurs to MD2 or MD3 between write accesses to MD0 and finally to MD5, then a 32/16 bit division is selected.

When a write access to MD4 or MD1 occurs before writing to MD5, then a 16/16 bit division or 16x16 bit multiplication is selected. Writing to MD4 selects 16/16 bit division and writing to MD1 selects 16x16 bit multiplication, that is, Num1 x Num2.



18.4.2 Executing calculation

During executing operation, the MDU works on its own in parallel with the MCU.

Operation	Number of clock cycles				
Division 32bit/16bit	17 clock cycles				
Division 16bit/16bit	9 clock cycles				
Multiplication	11 clock cycles				
Shift	min. 3 clock cycles (sc = 01h)	max 18 clock cycles (sc = 1Fh)			
Normalize	min. 4 clock cycles (sc <- 01h) max 19 clock cycles (sc <- 1Fr				

Table 124. MDU operations execution times

18.4.3 Reading the result from the MDx registers

Operation	32 bit/16 bit		16 bit / 16 bi	it	16 bit x 16	bit	Shift/norma	alize
first read	MD0 (lsb) MD1 MD2 MD3 (msb)	Quotient	MD0 (Isb) MD1 (msb)	ien	MD0 (lsb) MD1 MD2	duct	MD0 (lsb) MD1 MD2	Number
last read	MD4 (lsb) MD5 (msb)	Remainder	MD4 (lsb) MD5 (msb)	Remainder	MD3 (msb)	Pro	MD3 (msb)	Nur

Table 125. MDU registers read sequence

The Read out sequence of the first MDx registers is not critical but the last read (from MD5 - division and MD3 - multiplication, shift or normalize) determines the end of a whole calculation (end of phase three).

18.4.4 Normalizing

All leading zeroes of 32-bit integer variable stored in the MD0 .. MD3 registers are removed by shift left operations. The whole operation is completed when the MSB (Most Significant Bit) of MD3 register contains a '1'. After normalizing, bits ARCON[4:0] contain the number of shift left operations that were done.

18.4.5 Shifting

In shift operation, 32-bit integer variable stored in the MD0 ... MD3 registers (the latter contains the most significant byte) is shifted left or right by a specified number of bits. The slr bit (ARCON[5]) defines the shift direction and bits ARCON[4:0] specify the shift count (which must not be 0). During shift operation, zeroes come into the left end of MD3 for shifting right or they come in the right end of the MD0 for shifting left.

18.4.6 The mdef flag

The mdef error flag (see <u>Table 122. on page 150</u>) indicates an improperly performed operation (when one of the arithmetic operations is restarted or interrupted by a new operation). The error flag mechanism is automatically enabled with the first write operation to MD0 and disabled with the final read instruction from MD3 (multiplication or shift/norm) or MD5 (division) in phase three.

The error flag is set when:



nRF24LU1+ OTP Product Specification

- If you write to MD0 .. MD5 and/or ARCON during phase two of MDU operation (restart or calculations interrupting).
- If any of the MDx registers are read during phase two of MDU operation when the error flag mechanism is enabled. In this case, the error flag is set but the calculation is not interrupted.

The error flag is reset only after read access to the ARCON register. The error flag is read only.

18.4.7 The mdov flag

The mdov overflow flag (see <u>Table 122</u>. on page 150) is set when one of the following conditions occurs:

- · division by zero.
- multiplication with a result greater than 0000 FFFFh.
- start of normalizing if the most significant bit of MD3 is set ("md3.7" = '1').

Any operation of the MDU that does not match the above conditions clears the overflow flag.

Note: The overflow flag is exclusively controlled by hardware, it cannot be written.



19 Watchdog and wakeup functions

In order to achieve the lowest possible average current consumption, the processor clock can be stopped under firmware control. Operation can be resumed (wakeup) on external events like toggling of GPIO pins or from the internal RTC wakeup timer, USB or, the RF-module, see chapter.org/ on page 158 for details.

In addition, a programmable watchdog timer can be enabled to reset the system if the software hangs.

19.1 Features

- 32 kHz operation
- · Programmable 8-bit resoulution
- 16-bit range Watchdog
- · Watchdog disabled (reset) only by a system reset
- 24-bit range wakeup timer
- · Timer is a possible interrupt source
- Timer reload can be signalled on GPIO

19.2 Block diagram

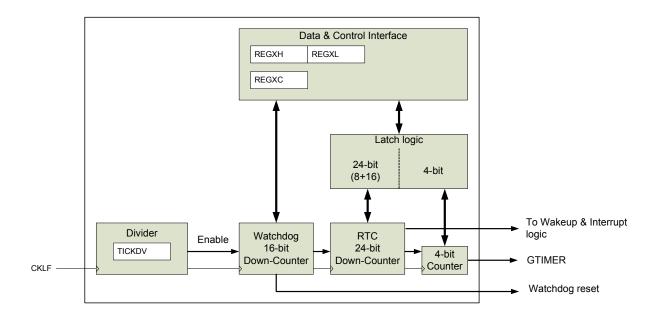


Figure 70. Watchdog and wakeup functions block diagram



19.3 Functional description

19.3.1 The Low Frequency Clock (CKLF)

CKLF frequency f_{CKLF} is 32000 Hz (derived from the crystal oscillator¹ and is used for wakeup functions and the Watchdog. This clock is always running.

19.3.2 Tick calibration

The tick is an interval (in CKLF periods) that determines the resolution of the watchdog and the RTC wakeup timer. By default the tick is set to 125 μ s (4 CKLF cycles). The programmable range is from 31.25 μ s to 8 ms. The tick is as accurate as the 32 kHz source.

The tick is controlled by the TICKDV register.

Addr	Reset value	bit	R/W	Function
0xB5	0x03	7:0	RW	Divider that is used in generating tick from CKLF frequency.
				Ttick = (1 + TICKDV) / f _{CKLF}

Table 126. TICKDV register

19.3.3 RTC wakeup timer

The RTC is a simple 24 bit down counter that produces an optional interrupt and reloads automatically when the count reaches zero. This process is initially disabled, and is enabled with the first write to the lower 16 bit of the timer latch (WRTCLAT). Writing the lower 16 bits of the timer latch is always followed by a reload of the counter. Only write the upper 8 bit of the timer latch when the timer is disabled, see <u>Table</u> 128. on page 157.

The RTC counter may be disabled again by writing a disable opcode to the control register (WRTCDIS). Both the latch and the counter value may be read by giving the respective codes in the control register, see the description in <u>Table 127. on page 156</u> and <u>Table 128. on page 157</u>.

The RTC counter is used for a wakeup sometime in the future (a relative time wakeup call). If 'N' is written to the counter, the first wakeup happens between 'N+1' and 'N+2' "tick" from the completion of the write. From then on a new wakeup is issued every "N+1" "tick" until the unit is disabled or another value is written to the latch.

The wakeup timer is one of the sources that can generate a WU interrupt (see <u>Table 138</u>. on <u>page 166</u>) to the MCU. You may poll the flag or enable the interrupt. If the MCU is in a power down or standby state, the wakeup forces the device to exit power down or standby regardless of the state of the interrupt enable.

The MCU system does not provide any "absolute time functions". Absolute time functions can be handled in software since the RAM is continuously powered even when in sleep mode.

^{1.} f_{CKLF} is 1/500 of oscillator frequency.



19.3.4 Programmable GPIO wakeup function

All pins in port 0 can be used as wakeup signals for the MCU system. The device can be programmed to react on rising, falling or, both edges of each pin individually. Additionally, each pin is equipped with a programmable filter that is used for glitch suppression.

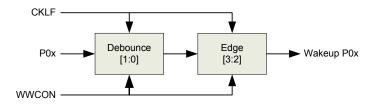


Figure 71. Wakeup filter, each pin for GPIO wakeup function

The debounce logic acts as a low pass filter. The input has to be stable for the number of clock pulses that are given (in WGTIMER) to appear on the output. Edge triggers on positive, negative, or both edges. The edge delay is 2 clock cycles. Please see <u>Table 128</u>. on page 157 and <u>Table 129</u>. on page 157 for filter configuration.

19.3.5 Watchdog

The watchdog is activated on the first write to its control register REGXC. It cannot be disabled by any other means than a reset.

The watchdog register is loaded by writing a 16-bit value (number of ticks) to the two 8-bit data registers (REGXH and REGXL) and then writing the correct opcode to the control register. The watchdog counts down towards 0 and when 0 is reached the complete MCU is reset.

To avoid the reset, the software must regularly load new values into the watchdog register.

19.3.6 Programming interface to watchdog and wakeup functions

Figure 72. on page 156 shows how the blocks that are always active are connected to the MCU.

RTC timer GPIO wakeup and Watchdog are controlled through three SFRs. The three registers, REGXH, REGXL and, REGXC, are used to interface the blocks running on the slow CKLF clock. The 16-bit register REGXH:REGXL can be written or read as two bytes from the MCU.

Typical sequences are:

Write:Write REGXH, Write REGXL, Write REGXC Read: Write REGXC, Read REGXH, Read REGXL

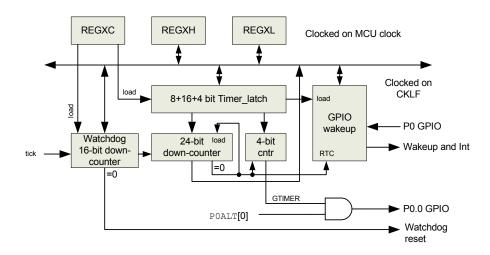


Figure 72. Block diagram of wakeup and watchdog functions

<u>Table 127. on page 156</u> describes the functions of the SFR registers that control those blocks, and <u>Table 128. on page 157</u> explains the contents of the individual control registers for watchdog and wakeup functions.

Addr	Reset value	bit	R/W	Init	Name	Function
0xAB	0x00	7:0	RW	0x00	REGXH	Most significant byte of 16-bit data register
0xAC	0x00	7:0	RW	0x00	REGXL	Least significant byte of 16-bit data register
0xAD	0x00			0x00	REGXC	Control register for 16 bit data register
		7:5	-			Not used
		4	R			Status of last REGXC write access 0: finished, 1: not finished
		3	RW			0: read, 1: write; see R/W column in Table 128. on page 157.
		2:0	RW			Indirect address, see the far left column in Table 128. on page
						<u>157</u> .

Table 127. REGXH, REGXL and REGXC registers

Indirect Address	Data register Bit	R/W ^a	Name	Function
000	15:0	R	RWD	Watchdog register (count)
	15:0	W	WWD	Watchdog register (count)
001	15:8	R	RGTIMER	MSB part of RTC counter
	7:0	R		MSB part of RTC latch
	15:12	-	WGTIMER	Not used
	11:8	W		GTIMER latch
	7:0	W		MSB part of RTC latch
010	15:0	R	RRTCLAT	Least significant part of RTC latch
	15:0	W	WRTCLAT	Least significant part of RTC latch
011	15:0	R	RRTC	RTC counter value
	-	W	WRTCDIS	Disable RTC (data not used)



Indirect Address	Data register Bit	R/W ^a	Name	Function
	15:9	-	RWSTA0	Not used
100	8	R		Wakeup status for RTC timer
	5:0	R		Wakeup status for pins P05-P00. RWSTA0 is
100				automatically cleared after read.
	15:14	W	WWCON0	Edge selection of P03
	13:12	W		Debounce filter for P03
	11:10	W		Edge selection of P02
	9:8	W		Debounce filter for P02
	7:6	W		Edge selection of P01
	5:4	W		Debounce filter for P01
	3:2	W		Edge selection of P00
	1:0	W		Debounce filter for P00, see <u>Table 129. on page</u>
				<u>157</u> .
101	15:9	-	RWSTA1	Identical to RWSTA0 above
	8	R		
	7:0	R		
	15:8	-	WWCON1	Not used
	7:6	W		Edge selection of P05
	5:4	W		Debounce filter for P05
	3:2	W		Edge selection of P04
	1:0	W		Debounce filter for P04, see <u>Table 129. on page</u>
				<u>157</u> .
110	15:0	-	-	Reserved, do not use
111	15:0	-	-	Reserved, do not use

a. REGXC bit-3 selects between R(ead) and W(rite) operation

Table 128. Indirect addresses and functions

Debou	ınce filter selection	Edge selection			
Code	Number of clock pulses	Code	positive/negative trigger		
00	0	00	Off		
01	2	01	Positive		
10	8	10	Negative		
11	64	11	Both		

Table 129. GPIO wakeup filter configuration, WWCON



20 Power management

The nRF24LU1+ OTP Power Management function controls the power dissipation through the administration of modes of operation and by controlling clock frequencies.

20.1 Features

- Supports low power modes for MCU, RF Tranceiver, USB and 48 MHz PLL
- Programmable MCU clock frequency from 64 kHz to 16 MHz
- Multi-source MCU wakeup
- Watchdog and wakeup functionality running in low power mode

20.2 Block diagram

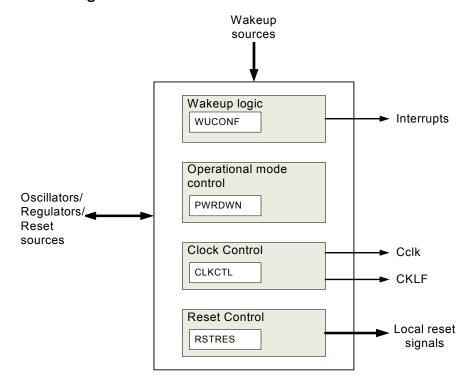


Figure 73. Power management block diagram



20.3 Modes of operation

There are four main power consuming functions on the chip. These can be controlled on and off in different ways depending on the required functionality after the start-up/reset sequence is ended.

These functions are:

- MCU
 - states of operation: active and standby
 - ▶ active at the end of the reset sequence
 - ► Set to standby by software (write PWRDWN register = 0x01)
 - ▶ Set to active by wakeup sources:

Interrupt from USB

Interrupt from RF Transceiver

Interrupt from external pin

Interrupt from on-chip RTC

- RF Transceiver
 - ▶ states of operation: **power down**, **standby** and **active** (TX or RX)
 - pwrdwn at the end of the reset sequence
 - ▶ Set to standby, active or power down by software, see section 6.3.1 on page 27
- USB
 - states of operation: active and suspend
 - ▶ active at the end of the reset sequence
 - ▶ Set to suspend by software (write USBSLP register = 0x01)
 - ▶ Set to active by software or by wakeup from USB host (through the USB bus)
- PLL
 - ▶ states of operation: on and off
 - ▶ on at the end of the reset sequence
 - ➤ Set to on or off by hardware with one exception: if the USB is in suspend the PLL may be controlled by software (Enable PLL, bit 7 in the CLKCTL register)

Table 130. on page 159 summarizes the available modes of operation after the reset sequence is ended:

- PROG is an external pin on the nRF24LU1+ OTP.
- RF Transceiver, USB, MCU and PLL represent the functions defined above.

PROG	RF Transceiver	USB	MCU	PLL	Comment
1	-	-	-	-	OTP programming mode via SPI
0	standby	suspend	standby	OFF	
0	standby	suspend	active	software	
0	standby	active	standby	ON	
0	standby	active	active	ON	
0	active	suspend	standby	OFF	
0	active	suspend	active	software	
0	active	active	standby	ON	
0	active	active	active	ON	

Table 130. nRF24LU1+ OTP modes of operation



In nRF24LU1+ OTP the 16 MHz oscillator is always running. An internal PLL can be enabled that multiplies the 16 MHz by three to get an internal 48 MHz clock. This clock is required for USB operation.

The internal 32.000 kHz clock (CKLF) is generated from the 16 MHz oscillator.

To save power when the USB is suspended, the PLL can be turned off, and the clock frequency to the MCU can be reduced. This reduces power consumption, but also reduces performance.

To further reduce power, the MCU clock can be stopped using the PWRDWN register.

The following various internal and external events can resume the MCU clock:

- Interrupt from RF Transceiver, RFIRQ
- Interrupt from USB
- Interrupt from RTC timer or GPIO-pins (see chapter 19 on page 153)

The WUCONF register controls how these events are handled.

20.4 Functional description

20.4.1 Clock control – CLKCTL

Addr	Reset value	Bit	R/W	Function		
0xA3	0x80	7	RW	Enable PLL, 1: PLL on, 0: PLL off		
		6:4	RW	Set Cclk (MCU clock) frequency when PLL is ON 000: 16 MHz 001: 12 MHz 010: 8 MHz 011: 4 MHz 010: 1.6 MHz 001: 1.6 MHz 00: 1.6 MHz 00: 1.6 MHz 0ther combinations: reserved.		
		3:2	-	Not used		
		1:0	RW	Set Cclk (MCU clock) frequency when PLL is OFF 00: 4 MHz 01: 1.6 MHz 10: 320 kHz 11: 64 kHz		

Table 131. CLKCTL register



20.4.2 Power down control – PWRDWN

Addr	Reset value	Bit	R/W	Function	
0xA4	0x00	7:4	-	Not used	
		3	R	Read CKLF clock (32 kHz clock, always running)	
		2:0	W	Set MCU to standby if different from 000	

Note: Any pending interrupt flags in IRCON must be cleared before setting MCU to standby.

Table 132.PWRDWN register

20.4.3 Reset result – RSTRES

The following three reset sources initiate the same reset/start-up sequence:

- Reset from the on-chip reset generator.
- · Reset from pin.
- Reset generated from the on-chip watchdog function.

The RSTRES register stores the reset cause:

Addr	Reset value	Bit	R/W	Function
0xB1	0x00	7:1	-	Not used
		0	R	Reset cause, 1: Watchdog, 0: other

Table 133. RSTRES register

20.4.4 Wakeup configuration register – WUCONF

Addr	Reset value	Bit	R/W	Function		
0xA5	0x00	7:6	RW	00: Enable wakeup on RFIRQ, if IEN1[1]=1		
				01: Reserved, not used		
				10: Enable wakeup on RFIRQ, regardless of IEN1[1]		
				11: Ignore RFIRQ		
		5:4	RW	00: Enable wakeup on WU, if IEN1[5]=1a		
				01: Reserved, not used		
				10: Enable wakeup on WU, regardless of IEN1[5]		
				11: Ignore WU		
		3:2	RW	00: Enable wakeup on USBIRQ, if IEN1[4]=1		
				01: Reserved, not used		
				10: Enable wakeup on USBIRQ, regardless of EN1[4]		
				11: Ignore USBIRQ		
		1:0	RW	00: Enable wakeup on USBWU, if IEN1[3]=1		
				01: Reserved, not used		
				10: Enable wakeup on USBWU, regardless of IEN1[3]		
				11: Ignore USBWU		

a. WU is generated as described in sections 19.3.3 and 19.3.4

Note: IRCON flag will be set upon wakeup, even if interrupt is not enabled in IEN1.

Table 134.WUCONF register



20.4.5 Power control register - PCON

The PCON register is used to control the Program Memory Write Mode and Serial Port 0 baud rate doubler.

Address	Reset value	Bit	Name	Description		
0x87	0x00	7	smod	Serial Port 0 baud rate select, see <u>Table 88. on page 113</u> (baud rate doubler).		
		6	gf3	General purpose flag 3		
		5	gf2	General purpose flag 2		
		4	pmw	Program memory write mode. Setting this bit enables the program memory write mode.		
		3	gf1	General purpose flag 1		
		2	gf0	General purpose flag 0		
		1	-	Reserved, must be zero. Always read as 0.		
		0	-	Reserved, must be zero. Always read as 0.		

Table 135. PCON register



21 Power supply supervisor

The power supply supervisor initializes the system at power-on, provides an early warning of impending power failure, and puts the system in reset state if the supply voltage is too low for safe operation.

21.1 Features

- Power-on reset
- Brown-out reset
- · Early power-fail warning with some hardware protection of data in OTP memory

21.2 Functional description

21.2.1 Power-on reset

A Power-on reset generator initializes the system at power-on. The system is held in reset state until VDD has reached around 2.7V or higher.

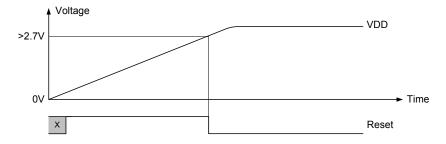


Figure 74. Power-on reset

21.2.2 Brown-out detection

If supply VBUS or VDD drops below around 2.7V (which is outside the operational specification), a power-fail detection signal goes active. If the supply goes below around 1.8V, a brown-out reset signal goes on and the chip is reset. The supply must rise above approximately 2.7V again before the reset signal is released. The power-fail signal is used to prevent OTP memory write at low voltage, see section 17.4 on page 139.

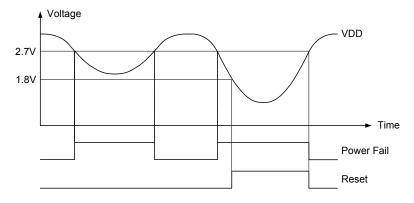


Figure 75. Brown-out detection



22 Interrupts

nRF24LU1+ OTP has an advanced interrupt controller with 15 sources, as shown in <u>Figure 76.</u> The unit manages dynamic program sequencing based upon important real-time events as signalled from timers, the RF Transceiver, the USB interface or pin activity.

22.1 Features

- Interrupt controller with 15 sources and 4 priority levels
- Interrupt request flags available
- · Interrupt from pin with selectable polarity

22.2 Block diagram

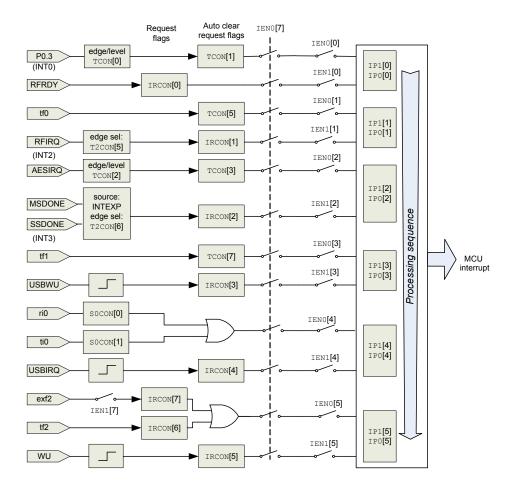


Figure 76. nRF24LU1+ OTP interrupt structure



22.3 Functional description

When an enabled interrupt occurs, the MCU vectors to the address of the interrupt service routine (ISR) associated with that interrupt, as listed in <u>Table 136</u>. on <u>page 165</u>. The MCU executes the ISR to completion unless another interrupt of higher priority occurs.

Source	Vector	Polarity	Description	
P0.3	0x0003	low/fall	External pin P0.3	
tf0	0x000B	high	Timer 0 interrupt	
AESIRQ	0x0013	low/fall	AES ready interrupt	
tf1	0x001B	high	Timer 1 interrupt	
ri0	0x0023	high	Serial channel receive interrupt	
ti0	0x0023	high	Serial channel transmit interrupt	
tf2	0x002B	high	Timer 2 interrupt	
exf2	0x002B	High	Timer 2 external event (pin P0.5)	
RFRDY	0x0043	high	RF SPI ready	
RFIRQ	0x004B	fall/rise	RF interrupt	
MSDONE	0x0053	fall/rise	Master SPI transaction completed	
SSDONE	0x0053	fall/rise	Slave SPI transaction completed	
USBWU	0x005B	rise	USB wakeup interrupt	
USBIRQ	0x0063	rise	USB interrupt	
WU	0x006B	rise	Internal Wakeup interrupt	

Table 136. nRF24LU1+ OTP interrupt sources

22.4 SFR registers

Various SFR registers are used to control and prioritize between different interrupts.

The IRCON, SCON, IPO, IP1, IENO, IEN1 and INTEXP are described in this section. In addition, a description of the TCON and T2CON registers is found in chapter 11 on page 102.

22.4.1 Interrupt enable 0 register – IEN0

The IENO register is responsible for global interrupt system enabling/disabling as well as Timer0, 1 and 2, Port 0 and Serial Port individual interrupts enabling/disabling.

Address	Reset value	Bit	Description		
0xA8	0x00	7	1: Enable interrupts. 0: all interrupts are disabled.		
		6	Not used.		
		5	1: Enable Timer2 interrupt.		
		4	1: Enable Serial Port interrupt.		
		3	1: Enable Timer1 overflow interrupt		
			1: Enable pin P0.4 interrupt.		
		1	1: Enable Timer0 overflow interrupt.		
		0	1: Enable pin P0.3 interrupt.		

Table 137. IEN0 register



22.4.2 Interrupt enable 1 register – IEN1

The IEN1 register is responsible for RF, SPI, USB and Timer 2 interrupts.

Address	Reset value	Bit	Bit Description	
0xB8	0x00	7	1: Enable Timer2 external reload interrupt	
		6 Not used		
		5	1: Wakeup interrupt enable	
		4	1: USB interrupt enable	
		3	1: USB wakeup interrupt enable	
		2 1: Master or Slave SPI ready interrupt enable		
		1	1: RF interrupt enable	
		0	1: RF SPI ready enable	

Table 138. IEN1 register

Master SPI and Slave SPI share the same interrupt line.

Address	Reset value	Bit	Function		
0xA6	0x01	7:2	Not used		
		1	1: Enable Master SPI interrupt		
		0	1: Enable Slave SPI interrupt		

Table 139. INTEXP register.

22.4.3 Interrupt priority registers – IP0, IP1

The 14 interrupt sources are grouped into six priority groups. For each of the groups, one of four priority levels can be selected. It is achieved by setting appropriate values in IPO and IPI registers.

The contents of the Interrupt Priority Registers define the priority levels for each interrupt source according to the tables below.

Address	Reset value	Bit	Description		
0xA9	0x00	7:6	Not used.		
		5:0	Interrupt priority. Each bit together with corresponding bit from IP1		
			register specifies the priority level of the respective interrupt priority		
			group.		

Table 140. IP0 register

Address	Reset value	Bit	Description	
0xB9	0x00	7:6	Not used.	
		5:0	Interrupt priority. Each bit together with corresponding bit from IP0 register specifies the priority level of the respective interrupt priority group.	

Table 141. IP1 register



Group	Interrupt bits			
0	IP1[0], IP0[0]	P0.3 interrupt	RF SPI interrupt	
1	IP1[1], IP0[1]	Timer 0 interrupt	RF interrupt	
2	IP1[2], IP0[2]	P0.4 interrupt	Master SPI interrupt	Slave SPI interrupt
3	IP1[3], IP0[3]	Timer 1 interrupt	USB wakeup	
4	IP1[4], IP0[4]	Serial port receive	Serial port transmit	USB interrupt
5	IP1 [5] , IP0 [5]	Timer 2 interrupt	Wakeup interrupt	

Table 142. Priority groups

IP1.x	IP0.x	Priority level
0	0	Level 0 (lowest)
0	1	Level 1
1	0	Level 2
1	1	Level 3 (highest)

Table 143. Priority levels (x is the number of priority group)

22.4.4 Interrupt request control registers – IRCON

The IRCON register contains Timer 2, SPI, RF, USB and wakeup interrupt request flags.

Address	Reset value	Flag	Bit	Auto clear ^a	Description
0xC0	0x00	exf2	7	-	Timer 2 external reload flag
		tf2	6	-	Timer 2 overflow flag
		WU	5	Yes	Wakeup interrupt flag
		USBIRQ	4	Yes	USB interrupt flag
		USBWU	3	Yes	USB wakeup interrupt flag
		M- or S-DONE	2	Yes	Master or Slave SPI interrupt flag
		RFIRQ	1	Yes	RF interrupt flag
		RFRDY	0	-	RF SPI interrupt flag

a. Auto clear means that the flag is cleared by hardware automatically when the corresponding service routine is vectored.

Table 144. IRCON register



23 Peripheral information

This chapter describes peripheral circuitry and PCB layout requirements that are important for achieving optimum RF performance from the nRF24LU1+ OTP.

23.1 Antenna output

The **ANT1** and **ANT2** output pins provide a balanced RF output to the antenna. The pins must have a DC path to VDD_PA, either through a RF choke or through the center point in a balanced dipole antenna. A load of 15 Ω +j88 Ω is recommended for maximum output power (0dBm). Lower load impedance (for instance 50 Ω) can be obtained by fitting a simple matching network between the load and **ANT1** and **ANT2**. A recommended matching network for 50Ω load impedance is illustrated in Chapter 24 on page 170.

23.2 Crystal oscillator

A crystal being used with the nRF24LU1+ OTP must fulfil the specifications given in Table 9. on page 24.

You must use a crystal with a low load capacitance specification to achieve a crystal oscillator solution with low power consumption and fast start-up time. A lower C0 also gives lower current consumption and faster start-up time, but may increase the cost of the crystal. Typically C0=1.5pF at a crystal specified for C0max=7.0pF.

The crystal load capacitance, CL, is given by:

$$C_L = \frac{C_1 \cdot C_2 \cdot C_2}{C_1 \cdot C_2 \cdot C_2}$$
 , where C1' = C1 + CPCB1 +CI1 and C2' = C2 + CPCB2 + CI2

C1 and C2 are SMD capacitors as shown in the application schematics, see <u>Chapter 24 on page 170</u>. CPCB1 and CPCB2 are the layout parasitic on the circuit board. Cl1 and Cl2 are the capacitance seen into the XC1 and XC2 pins respectively; the value is typically 1pF for each of these pins.

23.3 PCB layout and decoupling guidelines

A well-designed PCB is necessary to achieve good RF performance. A poor layout can lead to loss of performance or functionality. A fully qualified RF-layout for the nRF24LU1+ OTP and its surrounding components, including matching networks, can be downloaded from www.nordicsemi.no.

A PCB with a minimum of two layers including a ground plane is recommended for optimum performance. The nRF24LU1+ OTP DC supply voltage should be decoupled as close as possible to the VDD pins with high performance RF capacitors. See the schematics layout in Chapter 24 on page 170 for recommended decoupling capacitor values. The nRF24LU1+ OTP supply voltage should be filtered and routed separately from the supply voltages of any digital circuitry.

Long power supply lines on the PCB should be avoided. All device grounds, VDD connections and VDD bypass capacitors must be connected as close as possible to the nRF24LU1+ OTP IC. For a PCB with a topside RF ground plane, the VSS pins should be connected directly to the ground plane. For a PCB with a bottom ground plane, the best technique is to have via holes as close as possible to the VSS pads. A minimum of one via hole should be used for each VSS pin.

nRF24LU1+ OTP Product Specification

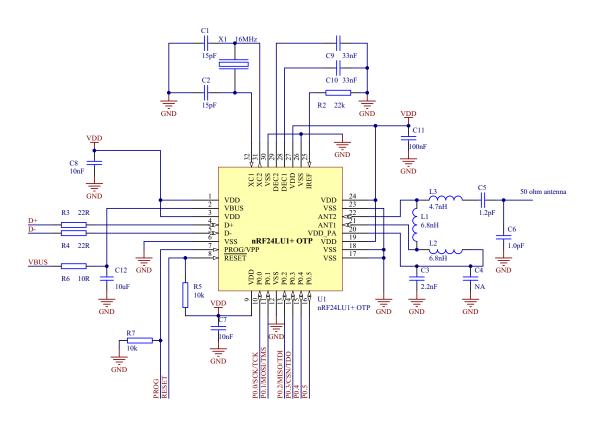


Full swing digital data or control signals should not be routed close to the crystal or the power supply lines. The exposed die attach pad is a ground pad connected to the IC substrate die ground and is intentionally not used in our layouts. It is recommended to keep it unconnected.



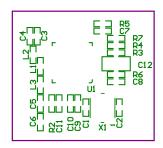
24 Reference circuitry

24.1 Schematic



24.2 Layout

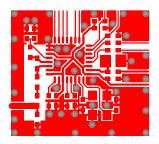
A double sided FR-4 board of 1.6 mm thickness is used. This PCB has a ground plane on the bottom layer. There are ground areas on the component side of the board to ensure sufficient grounding of critical components. A large number of via holes connect the top layer ground areas to the bottom layer ground plane.

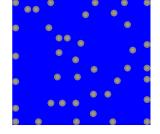


Top silk screen

No components in bottom layer







Top view

Bottom view

24.3 Bill Of Materials (BOM)

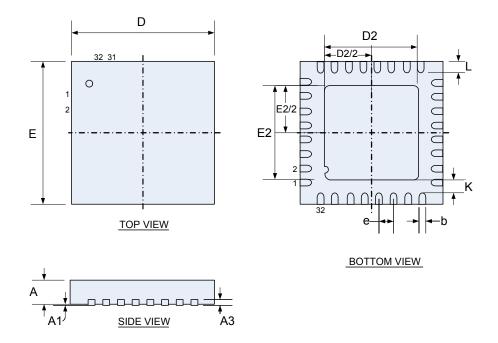
Designator	Value	Footprint	Comment
C1	15pF	0402	NP0 ±2%
C2	15pF	0402	NP0 ±2%
C3	2.2nF	0402	X7R ±10%
C4	Not mounted	0402	
C5	1.2pF	0402	NP0 ±0.1pF
C6	1.0pF	0402	NP0 ±0.1pF
C7	10nF	0402	X7R ±10%
C8	10nF	0402	X7R ±10%
C9	33nF	0402	X7R ±10%
C10	33nF	0402	X7R ±10%
C11	100nF	0402	X7R ±10%
C12	10uF	0805	X5R ±10%
L1	6.8nH	0402	High frequency chip inductor
			±5%
L2	6.8nH	0402	High frequency chip inductor
			±5%
L3	4.7nH	0402	High frequency chip inductor
			±5%
R2	22k	0402	±1%
R3	22R	0402	±1%
R4	22R	0402	±1%
R5	10k	0402	±5%
R6	10R	0402	±5%
R7	10k	0402	±5%
U1	nRF24LU1P-O	QFN32	nRF24LU1+ OTP
X1	16 MHz	3.2 x 2.4 mm	SMD-3225, 16 MHz,
			CL=9pF, ±60ppm
PCB substrate	FR4 laminate	17.0 x 15.4 mm	2 layer, thickness 1.6 mm

Table 145. Bill Of Materials



25 Mechanical specifications

nRF24LU1+ OTP is packaged in a QFN32 5 x 5 x 0.85 mm, 0.5 mm pitch.



Package	Α	A1	А3	b	D, E	D2, E2	е	K	٦	
QFN32	0.80	0.00		0.18	4.9	3.20		0.20	0.35	Min
	0.85	0.02	0.20	0.23	5.0	3.30	0.5		0.40	Тур
	0.90	0.05		0.30	5.1	3.40			0.45	Max

Table 146. QFN32 dimensions in mm



26 Ordering information

26.1 Package marking

Ζ	R	F		В	Χ
L	\Box	1	Р	Α	
Υ	Υ	W	W	L	L

26.1.1 Abbreviations

Abbreviation	Definition				
LU1PA	Product number				
В	Build Code, a unique code for production sites and versioning, test platform.				
X	"X" grade, that is, Engineering Samples (optional).				
YY	Two digit Year number				
WW	Two digit week number				
LL	Two letter wafer lot number code				

Table 147. Abbreviations

26.2 Product options

26.2.1 RF silicon

Ordering code	Package	Container	MOQ
nRF24LU1P-O17Q32-T	5x5mm 32-pin QFN, lead free (green)	Tray	490
nRF24LU1P-O17Q32-R7	5x5mm 32-pin QFN, lead free (green)	7" reel	1500
nRF24LU1P-O17Q32-R	5x5mm 32-pin QFN, lead free (green)	13" reel	4000
nRF24LU1P-O17Q32-S	5x5mm 32-pin QFN, lead free (green)	Sample box	5

Table 148. nRF24LU1+ OTP RF silicon options

26.2.2 Development tools

Type Number	Description
nRF24LU1P-FxxQ32-DK	nRF24LU1+ Development kit
nRF6700	nRFgo Starter Kit

Table 149. nRF24LU1+ OTP solution options



27 Glossary of terms

Term	Description					
ACC	Accumulator					
ACK	Acknowledgement					
ART	Auto Re-Transmit					
Cclk	MCU Clock					
CRC	Cyclic Redundancy Check					
CSN	Chip Select NOT					
DPS	Data Pointer Select register					
ESB	Enhanced ShockBurst™					
FCR	OTP Command Register					
FPCR	OTP Protect Config Register					
FSR	OTP Status Register					
GFSK	Gaussian Frequency Shift Keying					
HAL	Hardware Abstraction Layer					
HID	Human Interface Device					
IRQ	Interrupt Request					
ISM	Industrial-Scientific-Medical					
LNA	Low Noise Amplifier					
LSB	Least Significant Bit					
LSByte	Least Significant Bit Least Significant Byte					
MCU	Microcontroller					
Mbps	Megabit per second					
MISO	Master In Slave Out					
MOQ	Minimum Order Quantity					
MOSI	Master Out Slave In					
MSB	Most Significant Bit					
MSByte	Most Significant Byte					
OTP	One Time Programmable					
PCB	Printed Circuit Board					
PER	Packet Error Rate					
PID	Packet Identity Bits					
PLD	Payload					
PRX	Primary RX					
PSW	Program Status Word Register					
PTX	Primary TX					
pwrdwn	Power Down					
PWR UP	Power Up					
QFN	Quad Flat No lead					
RAM	Random Access Memory					
RDSR	Read Status Register					
rfce	Radio transceiver chip enable					
RX	Receive					
RX DR	Receive Data Ready					
SP	Stack Pointer					
SPI	Serial Peripheral Interface					
TX	Transmit					
TX DS	Transmit Data Sent					
USB	Universal Serial Bus					
WE	Write Enable					
WO	Write Only					
	wine only					

Table 150. Glossary



Appendix A - (USB memory configurations)

The USB buffer memory has a total size of 512 bytes. Bulk/control buffer size can be 2, 4, 8, 16, 32 or, 64 bytes, while ISO buffers (if used) must be multiples of 16 bytes.

Some example configurations are given below.

Configuration 1

Endpoint 0-5 Bulk/control IN/OUT, each of size 32 bytes.

Endpoint 8 ISO IN/OUT, each of size 32 bytes (with double buffering).

Total buffer area: 448 bytes.

Register	Value (hex)	Calculation	Comment
bout1addr	0x10	(ep0 out size)/2	Start addr. of bulk 1 OUT
bout2addr	0x20	bout1addr + (ep1out size)/2	Start addr. of bulk 2 OUT
bout3addr	0x30	bout2addr + (ep2 out size)/2	Start addr. of bulk 3 OUT
bout4addr	0x40	bout3addr + (ep3 out size)/2	Start addr. of bulk 4 OUT
bout5addr	0x50	bout4addr + (ep4 out size)/2	Start addr. of bulk 5 OUT
binstaddr	0x30	(bulk out size)/4	Start addr. of bulk 1 IN
bin1addr	0x10	(ep0 in size)/2	Start addr. of bulk 1 IN
bin2addr	0x20	bin1addr + (ep1 in size)/2	Start addr. of bulk 2 IN
bin3addr	0x30	bin2addr + (ep2 in size)/2	Start addr. of bulk 3 IN
bin4addr	0x40	bin3addr + (ep3 in size)/2	Start addr. of bulk 4 IN
bin5addr	0x50	bin4addr + (ep4 in size)/2	Start addr. of bulk 5 IN
isostaddr	0x18	(bulk size)/16	Start addr. of iso
out8addr	0x00	0	Start addr. of iso OUT
in8addr	0x08	(ep8 out size)/4	Start addr. of iso IN
isosize	0x04	(iso size)/16	

Table 151. Configuration 1

Configuration 2

Endpoint 0-2 bulk/control IN/OUT, each of size 32 bytes

Endpoint 3-4 bulk IN/OUT, each of size 16 bytes

Endpoint 8 ISO IN/OUT, each of size 32 bytes (with double buffering).

Total buffer area: 320 bytes

Register	value (hex)	Calculation	Comment
bout1addr	0x10	(ep0 out size)/2	Start addr. of bulk 1 OUT
bout2addr	0x20	bout1addr + (ep1 out size)/2	Start addr. of bulk 2 OUT
bout3addr	0x30		Start addr. of bulk 3 OUT
bout4addr	0x38	bout3addr + (ep3 out size)/2	Start addr. of bulk 4 OUT
binstaddr	0x20	(bulk out size)/4	Start addr. of bulk 1 IN
bin1addr	0x10	(ep0 in size)/2	Start addr. of bulk 1 IN
bin2addr	0x20	bin1addr + (ep1 in size)/2	Start addr. of bulk 2 IN

Register	value (hex)	Calculation	Comment
bin3addr	0x30	bin2addr + (ep2 in size)/2	Start addr. of bulk 3 IN
bin4addr	0x40	bin3addr + (ep3 in size)/2	Start addr. of bulk 4 IN
isostaddr	0x10	(bulk size)/16	Start addr. of iso
out8addr	0x00	0	Start addr. of iso OUT
in8addr	0x08	(ep8 out size)/4	Start addr. of iso IN
isosize	0x04	(iso size)/16	

Table 152. Configuration 2

Unused bout5addr and bin5addr shall be 0x00.

Configuration 3

Endpoint 0-3 bulk IN/OUT, each of size 16 bytes

Endpoint 4-5 bulk IN/OUT, each of size 32 bytes

Endpoint 8 iso IN/OUT, each of size 32 bytes (with double buffering)

Total buffer area: 320 bytes.

Register	Value (h)	Calculation	Comment
bout1addr	0x08	(ep0 out size)/2	Start addr. of bulk 1 OUT
bout2addr	0x10	bout1addr + (ep1 out size)/2	Start addr. of bulk 2 OUT
bout3addr	0x18	bout2addr + (ep2 out size)/2	Start addr. of bulk 3 OUT
bout4addr	0x20	bout3addr + (ep3 out size)/2	Start addr. of bulk 4 OUT
bout5addr	0x30	bout4addr + (ep4 out size)/2	Start addr. of bulk 5 OUT
binstaddr	0x20	(bulk out size)/4	Start addr. of bulk 1 IN
bin1addr	0x08	(ep0 in size)/2	Start addr. of bulk 1 IN
bin2addr	0x10	bin1addr + (ep1 in size)/2	Start addr. of bulk 2 IN
bin3addr	0x18	bin2addr + (ep2 in size)/2	Start addr. of bulk 3 IN
bin4addr	0x20	bin3addr + (ep3 in size)/2	Start addr. of bulk 4 IN
bin5addr	0x30	bin4addr + (ep4 in size)/2	Start addr. of bulk 5 IN
isostaddr	0x10	(bulk size)/16	Start addr. of iso
out8addr	0x00	0	Start addr. of iso OUT
in8addr	0x08	(ep8 out size)/4	Start addr. of iso IN
isosize	0x04	(iso size)/16	

Table 153. Configuration 3



Configuration 4

Endpoint 0-1 bulk/control IN/OUT, each of size 32 bytes

Endpoint 8 ISO IN/OUT, each of size 32 bytes (with double buffering).

Total buffer area: 192 bytes.

Register	Value (h)	Calculation	Comment
bout1addr	0x10	(ep0 out size)/2	Start addr. of bulk 1 OUT
binstaddr	0x10	(bulk out size)/4	Start addr. of bulk 1 IN
bin1addr	0x10	(ep0 in size)/2	Start addr. of bulk 1 IN
isostaddr	0x08	(bulk size)/16	Start addr. of iso
out8addr	0x00	0	Start addr. of iso OUT
in8addr	0x08	(ep8 out size)/4	Start addr. of iso IN
isosize	0x04	(iso size)/16	

Table 154. Configuration 4

Unused bout2addr to bout5addr and bin2addr to bin5addr shall be 0x00.



Appendix B - Configuration for compatibility with nRF24XX

How to set up the radio module in nRF24LU1+ OTP to receive from an nRF2401/nRF2402/nRF24E1/ nRF24E2/nRF24LE1:

- 1. Use the same CRC configuration as the nRF2401/nRF2402/nRF24E1/nRF24E2/nRF24LE1.
- 2. Set the PWR UP and PRIM RX bit to 1.
- 3. Disable auto acknowledgement on the addressed data pipe.
- 4. Use the same address width as the PTX device.
- 5. Use the same frequency channel as the PTX device.
- 6. Select data rate 1Mbps on both nRF24LU1+ OTP and nRF2401/nRF2402/nRF24E1/nRF24E2/nRF24LE1.
- 7. Set correct payload width on the addressed data pipe.
- 8. Set rfce high.

How to set up the radio module in nRF24LU1+ OTP to transmit to an nRF2401/nRF24E1/nRF24LE1:

- 1. Use the same CRC configuration as the nRF2401/nRF24E1/nRF24LE1.
- 2. Set the PRIM RX bit to 0.
- 3. Set the Auto Retransmit Count to 0 to disable the auto retransmit functionality.
- 4. Use the same address width as the nRF2401/nRF24E1/nRF24LE1.
- 5. Use the same frequency channel as the nRF2401/nRF24E1/nRF24LE1.
- 6. Select data rate 1Mbps on both nRF24LU1+ OTP and nRF2401/nRF24E1/nRF24LE1.
- 7. Set PWR UP high.
- 8. Clock in a payload that has the same length as the nRF2401/nRF24E1/nRF24LE1 is configured to receive.
- 9. Pulse rfce to transmit the packet.



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